



SuperServer[®] SYS-220GP-TNR



USER'S MANUAL

Revision 1.0b

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Preface

About this Manual

This manual is written for professional system integrators and PC technicians. It provides information for the installation and use of the server. Installation and maintenance should be performed by experienced technicians only.

Please refer to the SYS-220GP-TNR server specifications page on our website for updates on supported memory, processors and operating systems (<http://www.supermicro.com>).

Notes

For your system to work properly, please follow the links below to download all necessary drivers/utilities and the user's manual for your server.

- Supermicro product manuals: <http://www.supermicro.com/support/manuals/>
- Product drivers and utilities: <https://www.supermicro.com/wdl>
- Product safety info: http://www.supermicro.com/about/policies/safety_information.cfm

If you have any questions, please contact our support team at:
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This manual may be periodically updated without notice. Please check the Supermicro website for possible updates to the manual revision level.

Secure Data Deletion

A secure data deletion tool designed to fully erase all data from storage devices can be found on our website: https://www.supermicro.com/about/policies/disclaimer.cfm?url=/wdl/utility/Lot9_Secure_Data_Deletion_Utility/

Warnings

Special attention should be given to the following symbols used in this manual.



Warning! Indicates important information given to prevent equipment/property damage or personal injury.



Warning! Indicates high voltage may be encountered when performing a procedure.

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Chapter 1

Introduction

1.1 Overview

This chapter provides a brief outline of the functions and features of the SuperServer SYS-220GP-TNR. The SYS-220GP-TNR is a high-end graphics processing unit (GPU) system comprised of the X12DPG-AR motherboard and the CSE-218GH2TS-R0NDBP chassis.

System Overview	
Motherboard	X12DPG-AR
Chassis	CSE-218GH2TS-R0NDBP
Processor Support	Dual Intel Xeon Scalable Family 3rd Gen/4th Gen Series Processors (in Socket P+) with a thermal design power (TDP) of up to 270W, three UltraPath Interconnects (UPI), and hardware Root of Trust (RoT)
Chipset	Intel PCH C621A (LBG-R)
Memory	Supports up to 4TB 3DS LRDIMM/LRDIMM/3DS RDIMM/RDIMM DDR4 (288-pin) ECC memory with speeds of 3200/2933/2666 MHz in 16 memory slots and up to 4TB Intel Optane PMem 200 Series with speeds of up to 3200 MHz
Drive Support	Ten front hot-swap drive bays (six 2.5" SATA/SAS and four 2.5" U.2 NVMe/SATA/SAS)
Expansion Slots	Six PCIe x16 Gen4 GPU slots One PCIe x8 Gen4 low-profile slot. (Optionally, configurable to x16 with OEM SKU) One AIOM networking slot
I/O Ports	One VGA One dedicated 10G BASE-T BMC LAN Two front USB 2.0 Two rear USB 3.0
System Cooling	Five counter-rotating fans with optimal fan speed control One air shroud
Power	2600W Titanium redundant power supply
Form Factor	2U rackmount; (WxHxD) 17.3 x 3.5 x 30.1 in. (440.7 x 88.0 x 766.8mm)

Notes: A Quick Reference Guide can be found on the product page of the Supermicro website. The following safety agency or regulatory models associated with the SYS-220GP-TNR have been certified as compliant with CSA or UL: 218G-26, 218G-X12, 218G-R26X12, and 218G-GPU.

1.2 System Features

The CSE-218GH2TS-R0NDBP is a 2U chassis that supports ten 2.5" front hot-swappable hard drives.

Front View

The chassis front offers access to the storage drives, a control panel, two USB 2.0 ports, and a service tag.

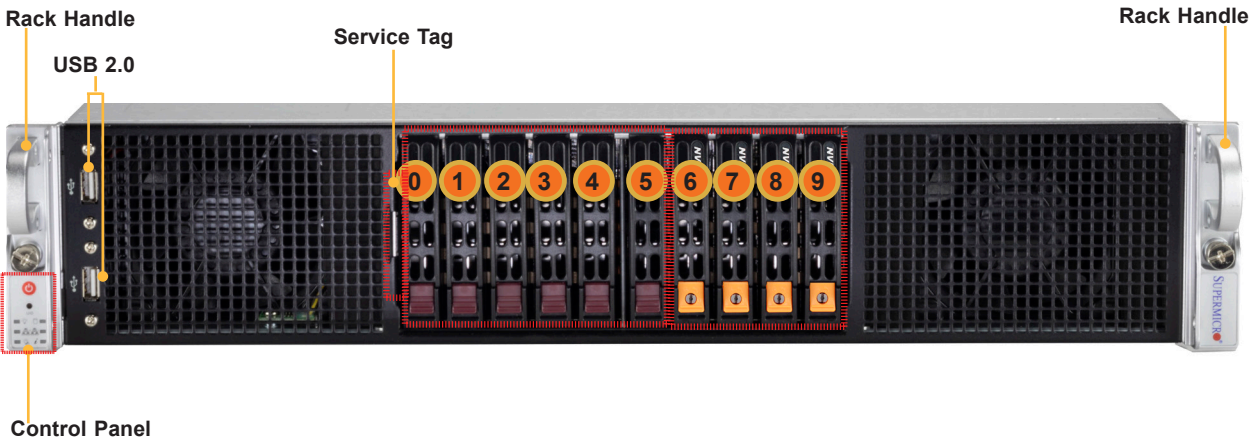


Figure 1-1. Front View

System Features: Front	
Feature	Description
Service Tag	Pull-out service tag with BMC password label.
0 , 1 , etc.	Ten drive bays for 2.5" hot-swap drive carriers. Slot 6-9 support U.2 NVMe.
Control Panel	Control panel for the server. See the Control Panel section on the next page.
USB Ports	Two USB 2.0 ports.
Rack Handles	Secures the server chassis to the rack.

Control Panel

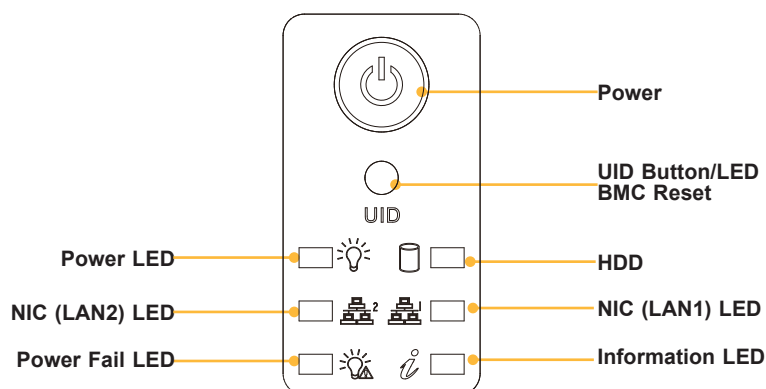


Figure 1-2. Control Panel

Control Panel Features	
Feature	Description
Power button	The main power switch applies or removes primary power from the power supply to the server but maintains standby power.
UID button/LED BMC button	The unit identification (UID) button turns on or off the blue light function of the Information LED and a blue LED on the rear of the chassis. This button can also be used to reset the BMC. See Chapter 3.
Power LED	Indicates power is being supplied to the system power supply units. This LED is illuminated when the system is operating normally.
HDD	Indicates activity on the storage drives when flashing.
NIC (LAN1) LED	Indicates network activity on LAN1 when flashing.
NIC (LAN2) LED	Indicates network activity on LAN2 when flashing.
Power Fail LED	Indicates a power supply module has failed.
Information LED	Alerts operator to several states, as noted in the table below.

Information LED	
Color, Status	Description
Red, solid	An overheat condition has occurred.
Red, blinking at 1Hz	Fan failure, check for an inoperative fan.
Red, blinking at 0.25Hz	Power failure, check for a non-operational power supply.
Red, solid, with Power LED blinking green	Fault detected
Blue and red, blinking at 10 Hz	Recovery mode
Blue, solid	UID has been activated locally to locate the server in a rack environment.
Blue, blinking at 1Hz	UID has been activated using the BMC to locate the server in a rack environment.
Blue, blinking at 2Hz	BMC is resetting
Blue, blinking at 4Hz	BMC is setting factory defaults
Blue, blinking at 10Hz with Power LED blinking green	BMC/BIOS firmware is updating

Rear View

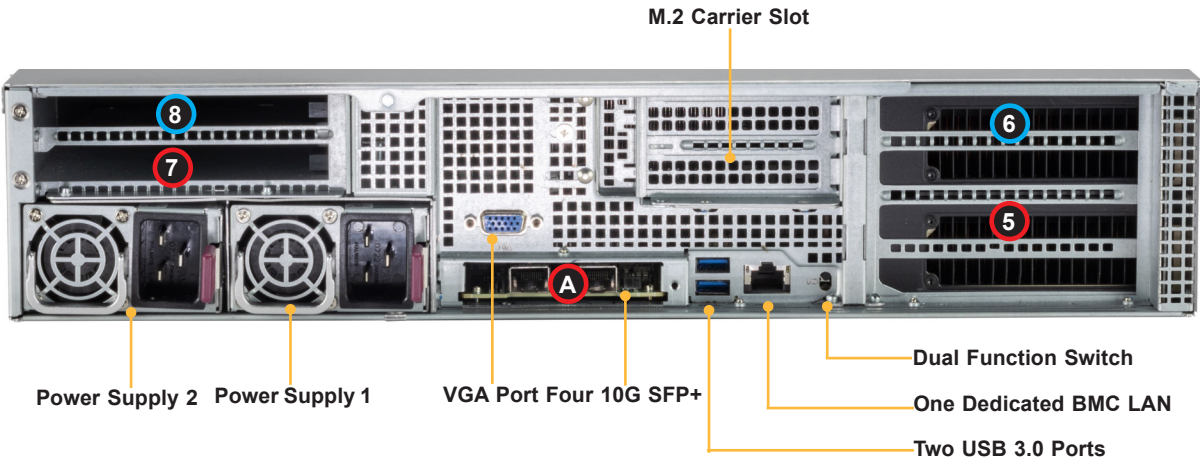


Figure 1-3. System: Rear View

System Features: Rear	
Feature	Description
Power Supplies	Two redundant 2600W power supply (PWS-2K63A-1R)
Dual Function Switch	A switch that can function as either a UID LED switch or a BMC reset switch. See Chapter 4 for a description of the dual function switch.
LAN Port	Dedicated BMC LAN port
USB Ports	Two USB 3.0 ports
VGA Port	Video port
AIOM A	Network interface through AIOM (CPU1)
Slot 5	PCIe 4.0 x16 supported by CPU1
Slot 6	PCIe 4.0 x16 supported by CPU2
Slot 7	PCIe 4.0 x8 supported by CPU1
Slot 8	PCIe 4.0 x8 supported by CPU2

CPU1 CPU2



Caution: Only Laser Class 1 optical transceivers shall be used.

1.3 System Architecture

This section covers the printed circuit board (PCB) locations and main components of the system.

Main Components

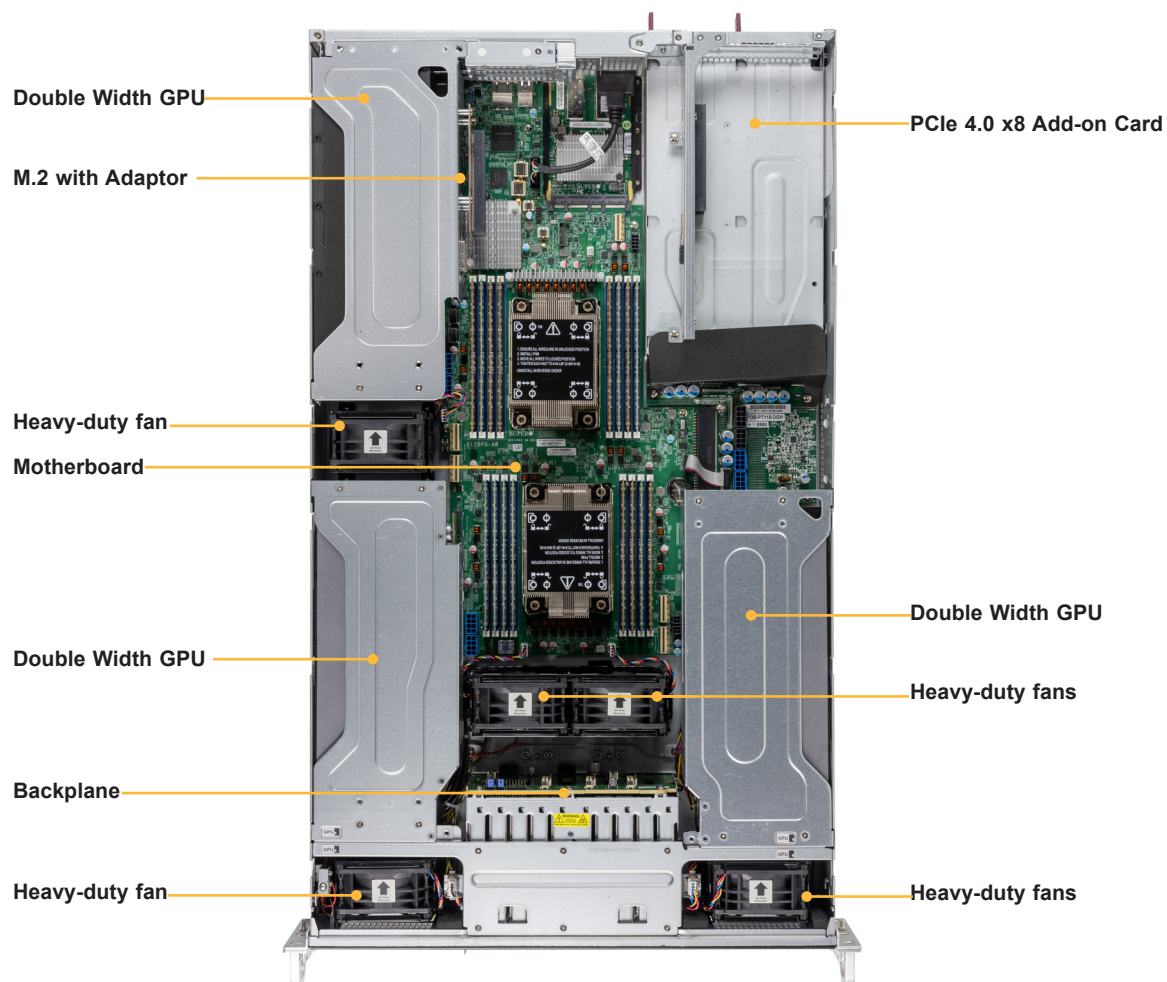


Figure 1-4. Main Components

Quick Reference Table

Jumper	Description	Default Setting
JBT1	CMOS Clear	Open (Normal)
JRU1	Front panel reset/UID switch selection	
LED	Description	Status
LE3	Power LED	LED On: Powered On
LE6	Unit Identifier LED	Solid Blue: Unit Identified
LEDM1	BMC Heartbeat LED	Blinking Green: BMC Normal (Active)
Connector	Description	
AIOM (JAIOM1)	Supermicro® Advanced I/O Module (AIOM) slot	
Battery (BT1)	Onboard CMOS battery	
FAN1/2/3/4/A/B/C/E/F	CPU/System fan headers	
COM1 (JCOM1)	Serial port header for front access	
I-SATA0~3 (JS1)	Intel® PCH I-SATA3 ports (I-SATA0/1/2/3) with RAID(0, 1, 5, 10)	
I-SATA4~7 (JS2)	Intel® PCH I-SATA3 ports (I-SATA4/5/6/7) with RAID(0, 1, 5, 10)	
JFP1	Front Control Panel header	
JGPU1/JGPU3/JGPU5	PCIe 4.0 x16 slots supported by CPU1	
JGPU2A/JGPU2B	PCIe 4.0 x8 slots supported by CPU2	
JGPU4/JGPU6	PCIe 4.0 x16 slots supported by CPU2	
JGPU1_PWR1	6-pin power connector for GPU graphic cards	
JHDD_PWR1/JHDD_PWR2	8-pin power connectors for hard drive backplane	
JIPMB1	4-pin BMC External I²C header (for an BMC card)	
JL1	Chassis Intrusion header	
JM2	PCIe 3.0 M.2 x4x4 slot supported by the PCH	
JMVME1/JNVME2	PCIe 4.0 x8 slots supported by CPU2	
JNCSI1	NC-SI (Network Controller Sideband Interface) connector (See Note below)	
JPWR_RISER1	8-pin Power connector for riser card	
JPW1/JPW2	Power supply unit connectors	
JPW3~6	8-pin power connectors	
JRIO1	PCIe 4.0 x8 slot supported by CPU1	
JSTBY1	Standby Power header	
JTPM1	Trusted Platform Module/Port 80 connector	
JUIDB1	Unit Identifier (UID) switch	
USB0/1 (JUSB1)	Rear access USB 3.0 header	
USB2/3 (J32)	Front-accessible USB 2.0 header	
VGA (JVGA1)	Front VGA header	
VROC (JRK1)	VROC RAID Key header for NVMe SSD	

Motherboard Block Diagram

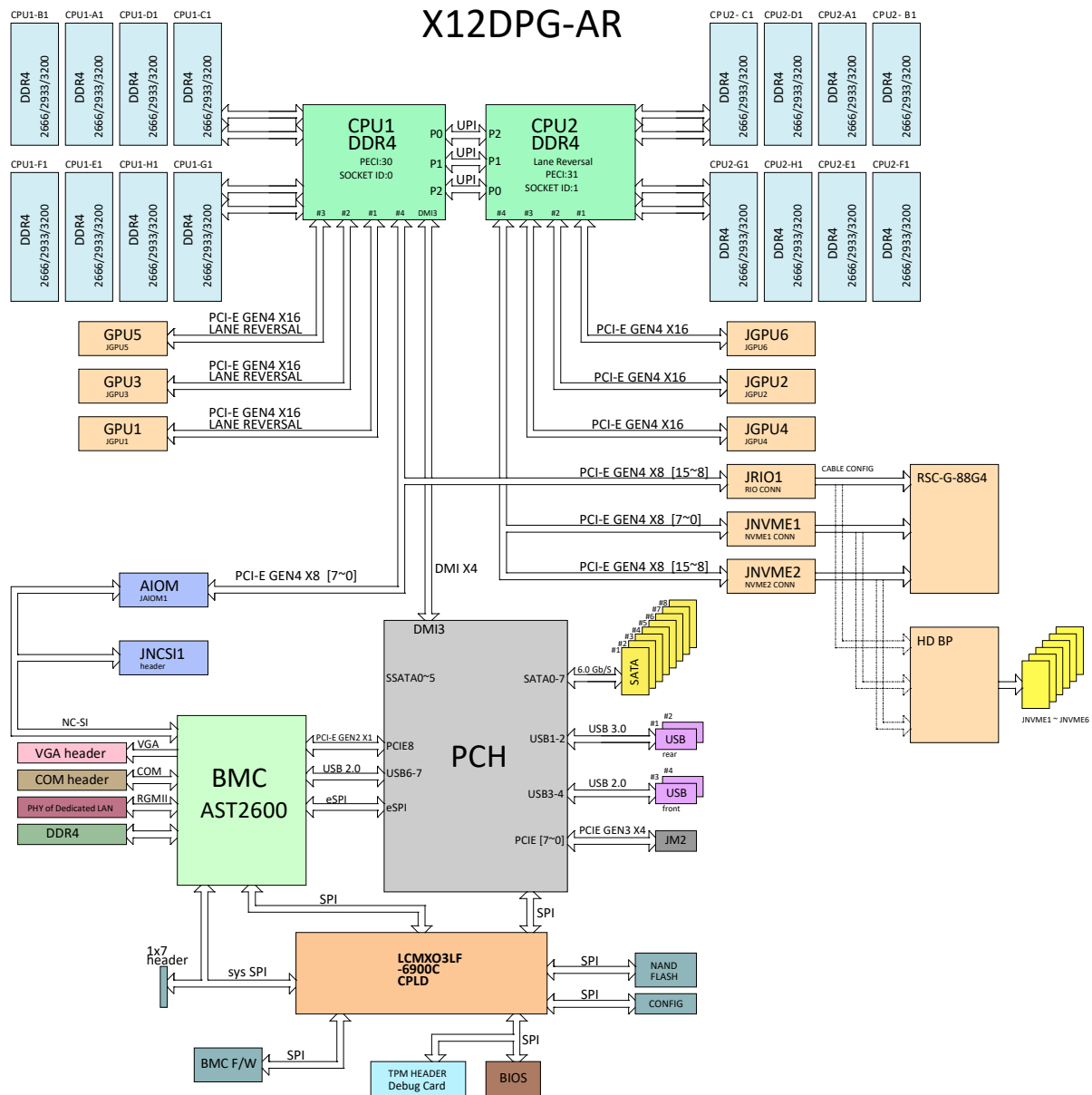


Figure 1-6. Motherboard Block Diagram

Chapter 2

Server Installation

2.1 Overview

This chapter provides advice and instructions for mounting your system in a server rack. If your system is not already fully integrated with processors, system memory etc., refer to Chapter 4 for details on installing those specific components.

Caution: Electrostatic Discharge (ESD) can damage electronic components. To prevent such damage to PCBs (printed circuit boards), it is important to use a grounded wrist strap, handle all PCBs by their edges and keep them in anti-static bags when not in use.

2.2 Preparing for Setup

The box in which the system was shipped should include the rackmount hardware needed to install it into the rack. Please read this section in its entirety before you begin the installation.

Choosing a Setup Location

- The system should be situated in a clean, dust-free area that is well ventilated. Avoid areas where heat, electrical noise and electromagnetic fields are generated.
- Leave enough clearance in front of the rack so that you can open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow sufficient space for airflow and access when servicing.
- This product should be installed only in a Restricted Access Location (dedicated equipment rooms, service closets, etc.).
- This product is not suitable for use with visual display workplace devices according to §2 of the German Ordinance for Work with Visual Display Units.

Rack Precautions

- Ensure that the leveling jacks on the bottom of the rack are extended to the floor so that the full weight of the rack rests on them.

- In single rack installations, stabilizers should be attached to the rack. In multiple rack installations, the racks should be coupled together.
- Always make sure the rack is stable before extending a server or other component from the rack.
- You should extend only one server or component at a time - extending two or more simultaneously may cause the rack to become unstable.

Server Precautions

- Review the electrical and general safety precautions in [Appendix A](#).
- Determine the placement of each component in the rack *before* you install the rails.
- Install the heaviest server components at the bottom of the rack first and then work your way up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow any drives and power supply modules to cool before touching them.
- When not servicing, always keep the front door of the rack and all covers/panels on the servers closed to maintain proper cooling.

Rack Mounting Considerations

Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the room's ambient temperature. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (TMRA).

Airflow

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

Reliable Ground

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (i.e. the use of power strips, etc.).



To prevent bodily injury when mounting or servicing this unit in a rack, you must take special precautions to ensure that the system remains stable. The following guidelines are provided to ensure your safety:

- This unit should be mounted at the bottom of the rack if it is the only unit in the rack.
- When mounting this unit in a partially filled rack, load the rack from the bottom to the top with the heaviest component at the bottom of the rack.
- If the rack is provided with stabilizing devices, install the stabilizers before mounting or servicing the unit in the rack.

2.3 Installing the Rails

This section provides information on installing the chassis into a rack unit with the rails provided. There are a variety of rack units on the market, which may mean that the assembly procedure will differ slightly from the instructions provided. You should also refer to the installation instructions that came with the rack unit you are using.

Note: This rail will fit a rack between 26.5" and 36.4" deep.

Identifying the Sections of the Rack Rails

The chassis package includes two rail assemblies. Each assembly consists of three sections: An inner rail that secures directly to the chassis, an outer rail that secures to the rack, and a middle rail which extends from the outer rail. These assemblies are specifically designed for the left and right side of the chassis.

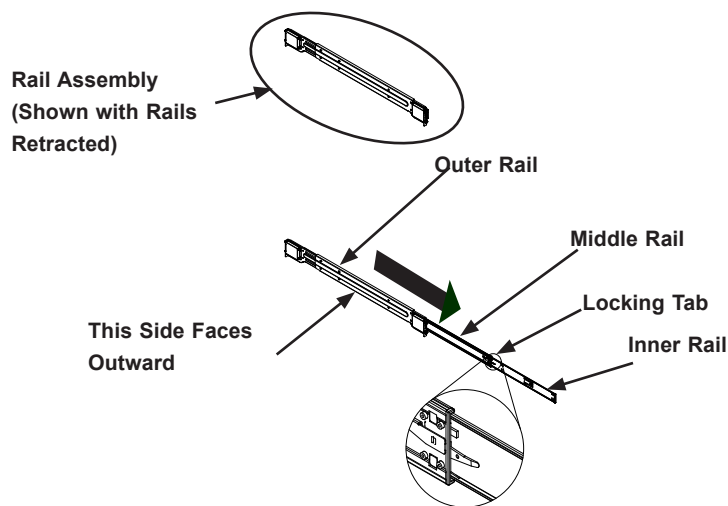


Figure 2-1. Identifying the Rail Sections

Releasing the Inner Rail

Each inner rail has a locking latch. This latch prevents the server from coming completely out of the rack when the chassis is pulled out for servicing.

To mount the rail onto the chassis, first release the inner rail from the outer rails.

Releasing Inner Rail from the Outer Rails

1. Pull the inner rail out of the outer rail until it is fully extended as illustrated below.
2. Press the locking tab down to release the inner rail.
3. Pull the inner rail all the way out.
4. Repeat for the other outer rail.

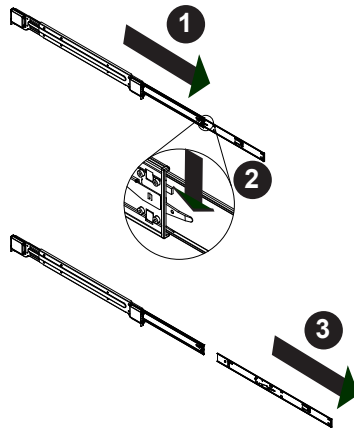


Figure 2-2. Extending the Rails and Releasing the Inner Rail

Note: Both front chassis rails and the rack rails have a locking tab, which serves two functions. First, it locks the server into place when installed and pushed fully into the rack (its normal operating position). In addition, these tabs lock the server in place when fully extended from the rack. This prevents the server from coming completely out of the rack when pulled out for servicing.



Warning: Stability hazard. The rack stabilizing mechanism must be in place, or the rack must be bolted to the floor before you slide the unit out for servicing. Failure to stabilize the rack can cause the rack to tip over.

Installing the Inner Rails on the Chassis

Installing the Inner Rails

1. Identify the left and right inner rails. They are labeled.
2. Place the inner rail firmly against the side of the chassis, aligning the hooks on the side of the chassis with the holes in the inner rail.
3. Slide the inner rail forward toward the front of the chassis until the quick release bracket snaps into place, securing the rail to the chassis.
4. Optionally, you can further secure the inner rail to the chassis with a screw.
5. Repeat for the other inner rail.

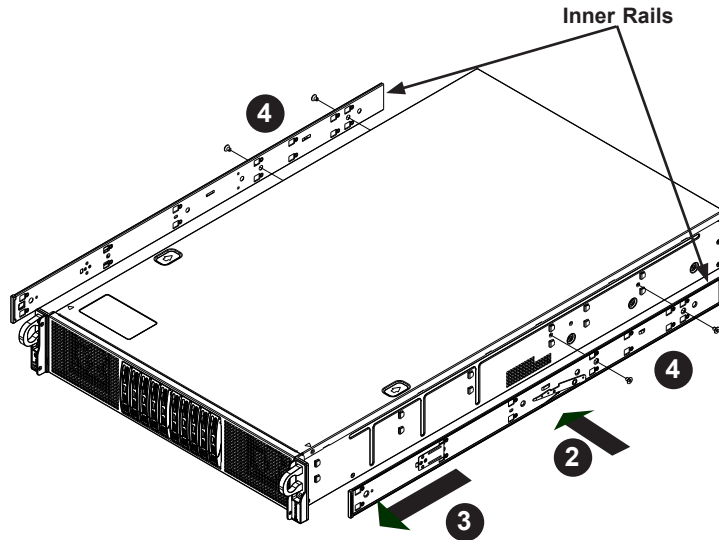


Figure 2-3. Installing the Inner Rails



Slide rail mounted equipment is not to be used as a shelf or a work space.



Warning: Do not pick up the server with the front handles. They are designed to pull the system from a rack only.

Installing the Outer Rails onto the Rack

Installing the Outer Rails

1. Press upward on the locking tab at the rear end of the middle rail.
2. Push the middle rail back into the outer rail.
3. Hang the hooks on the front of the outer rail onto the square holes on the front of the rack. If desired, use screws to secure the outer rails to the rack.
4. Pull out the rear of the outer rail, adjusting the length until it just fits within the posts of the rack.
5. Hang the hooks of the rear section of the outer rail onto the square holes on the rear of the rack. Take care that the proper holes are used so the rails are level. If desired, use screws to secure the rear of the outer rail to the rear of the rack.
6. Repeat for the other outer rail.

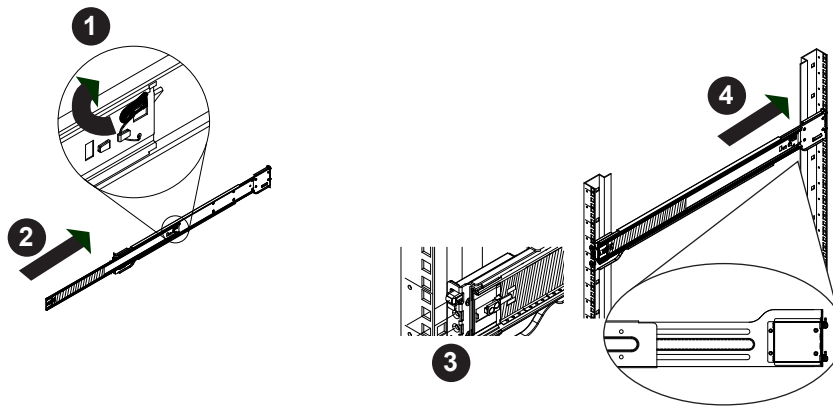


Figure 2-4. Extending and Mounting the Outer Rails

Sliding the Chassis onto the Rack Rails

Warning: Mounting the system into the rack requires at least two people to support the chassis during installation. Please follow safety recommendations printed on the rails.

Installing the Chassis into a Rack

1. Extend the outer rails as illustrated above.
2. Align the inner rails of the chassis with the outer rails on the rack.
3. Slide the inner rails into the outer rails, keeping the pressure even on both sides. When the chassis has been pushed completely into the rack, it should click into the locked position.
4. Optional screws may be used to hold the front of the chassis to the rack.

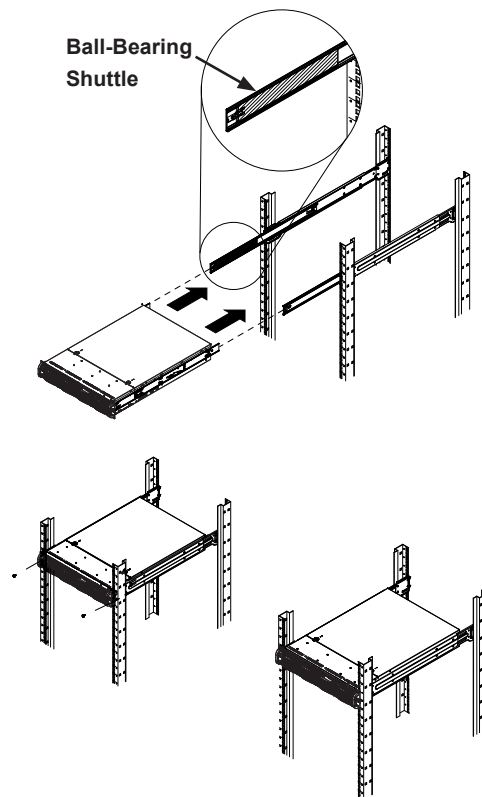


Figure 2-5. Installing the System into the Rack

Note: Figure is for illustrative purposes only. Always install servers to the bottom of a rack first.

Chapter 3

Maintenance and Component Installation

This chapter provides instructions on installing and replacing main system components. To prevent compatibility issues, only use components that match the specifications and/or part numbers given.

Installation or replacement of most components require that power first be removed from the system. Please follow the procedures given in each section.

3.1 Removing Power

Use the following procedure to ensure that power has been removed from the system. This step is necessary when removing or installing non hot-swap components or when replacing a non-redundant power supply.

1. Use the operating system to power down the system.
2. After the system has completely shut-down, disconnect the AC power cords from the power strip or outlet.
3. Disconnect the power cord from the power supply module.

3.2 Accessing the System

The CSE-218GH2TS-R0NDBP features a removable top cover, which allows easy access to the inside of the chassis.

Removing the Top Cover

1. Begin by removing power from the system as described in Section 3.1.
2. Remove the two screws securing the top cover to the chassis.
3. Press and slide the tab to unlock the top cover.
4. Slide the cover back, toward the rear of the chassis.
5. Lift the cover up and off of the chassis. See Figure 3-1.

Warning: Except for short periods of time, do not operate the server without the cover in place. The chassis cover must be in place to allow for proper airflow and to prevent overheating.

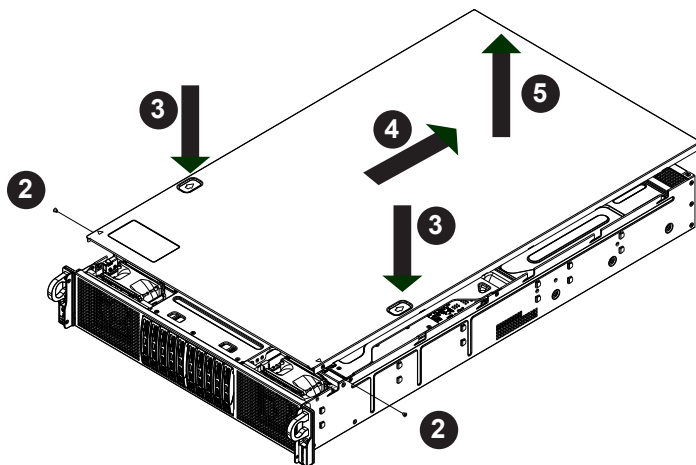


Figure 3-1. Removing the Chassis Cover

Note: Graphics in this manual are for illustration purposes only. Your components may look slightly different.

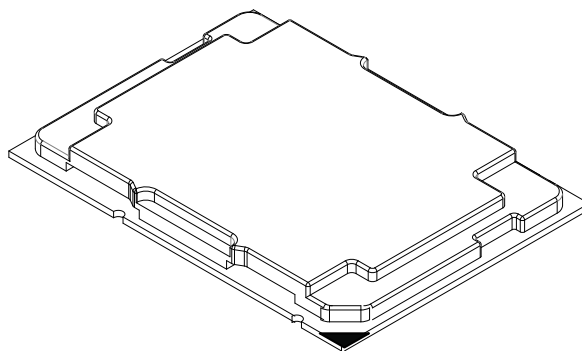
3.3 Processor and Heatsink Installation

The processor (CPU) and processor carrier should be assembled together first to form the processor carrier assembly. This will be attached to the heatsink to form the processor heatsink module (PHM) before being installed onto the CPU socket.

Notes:

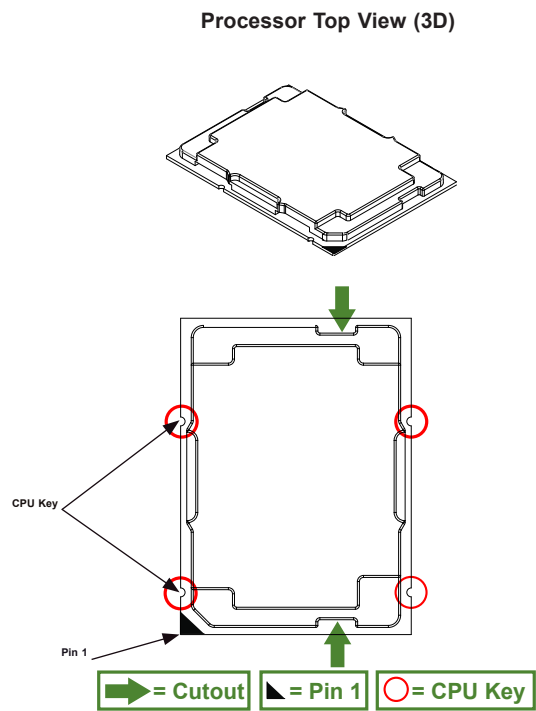
- Use ESD protection.
- Unplug the AC power cord from all power supplies.
- Check that the plastic protective cover is on the CPU socket and that none of the socket pins are bent. If they are, contact your retailer.
- When handling the processor, avoid touching or placing direct pressure on the land grid array (gold contacts).
- Improper installation or socket misalignment can cause serious damage to the processor or the socket and may require manufacturer repairs.
- Thermal grease is pre-applied on new heatsinks. No additional thermal grease is needed.
- Refer to the Supermicro website for updates on processor support.
- Graphics in this manual are for illustration only. Your components may look different.

The 3rd Gen Intel Xeon Scalable Processor



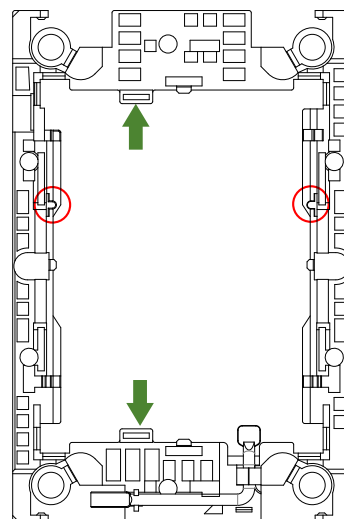
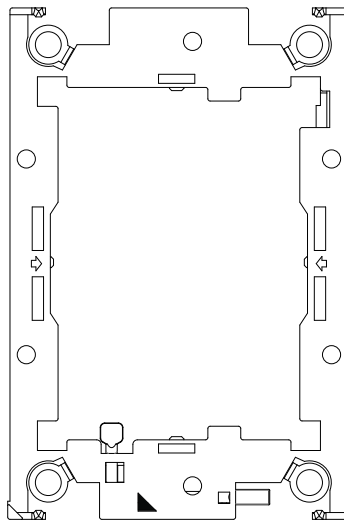
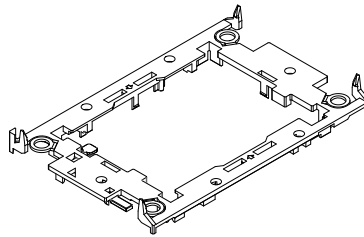
Processor Top View

1. The 3rd Gen Intel Xeon Scalable Processor



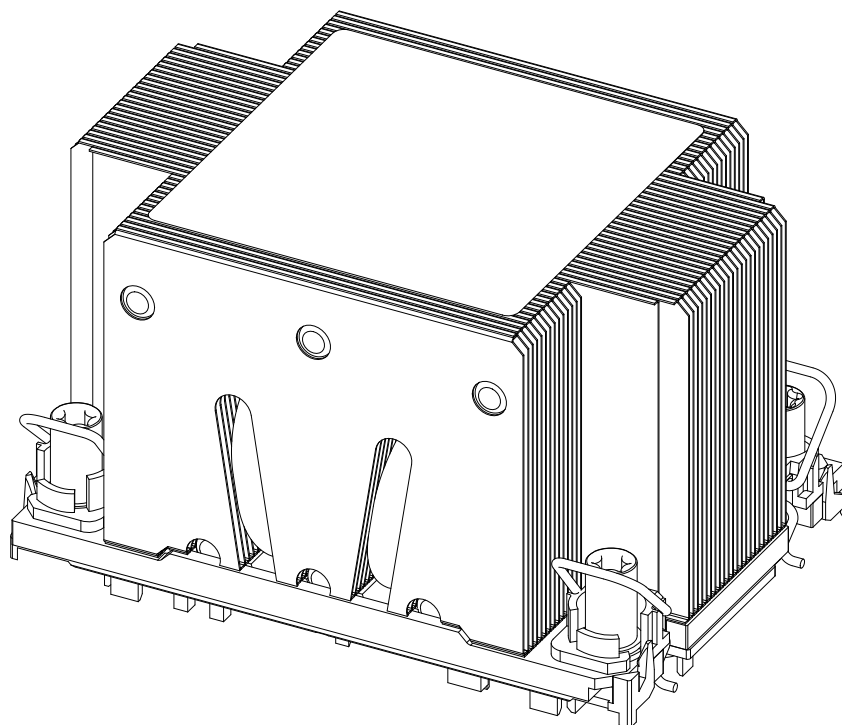
Processor Top View

2. The Processor Carrier



Carrier Bottom View

3. Heatsink

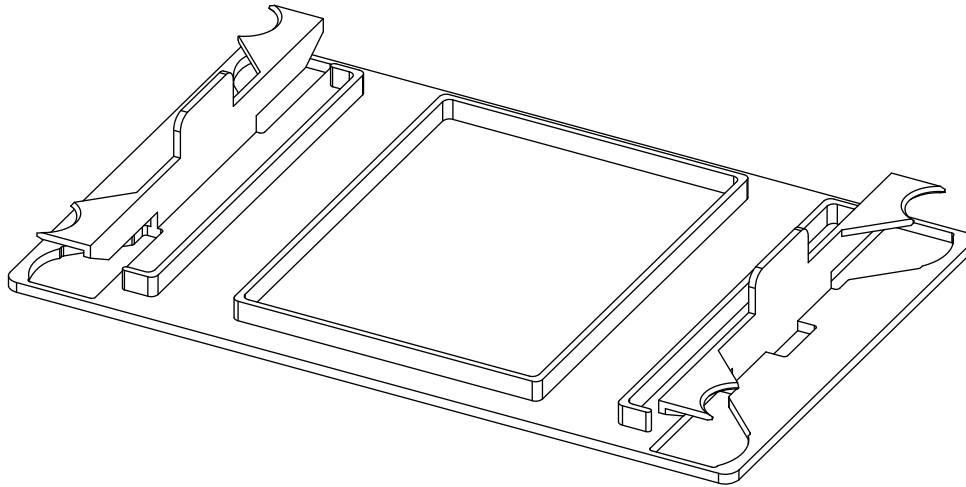


Note: Exercise extreme care when handling the heatsink. Pay attention to the edges of heatsink fins which can be sharp! To avoid damaging the heatsink, please do not apply excessive force on the fins when handling the heatsink.

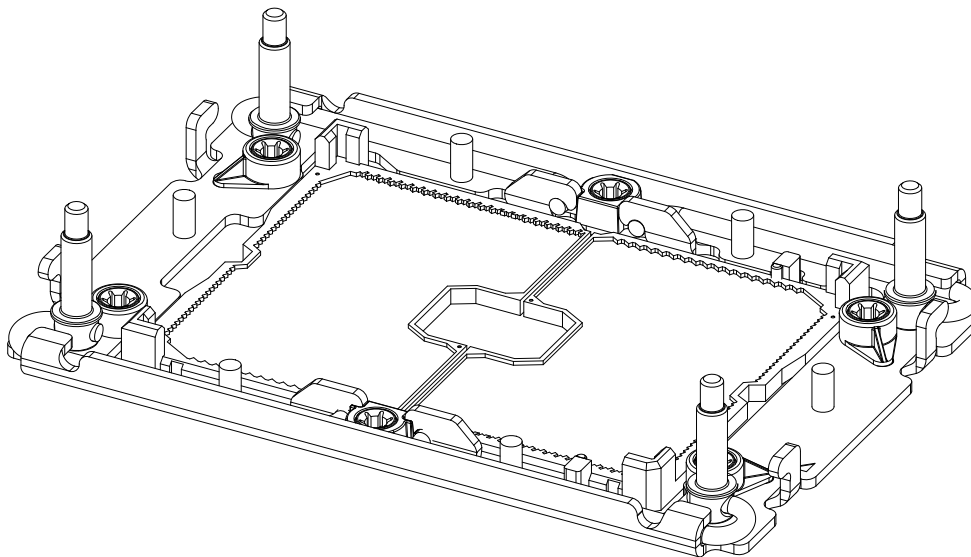
Overview of the CPU Socket

The CPU socket is protected by a plastic protective cover.

Plastic Protective Cover



CPU Socket

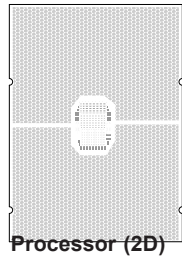


Overview of the Processor Carrier Assembly

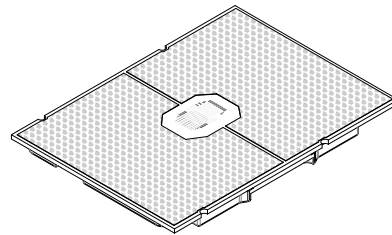
The processor carrier assembly contains a 3rd Gen Intel Xeon Scalable processor and a processor carrier. Carefully follow the instructions given in the installation section to place a processor into the carrier to create a processor carrier.

1. The 3rd Gen Intel Xeon Scalable Processor

Intel Processor (Bottom View)



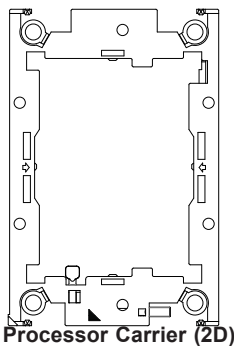
Processor (2D)



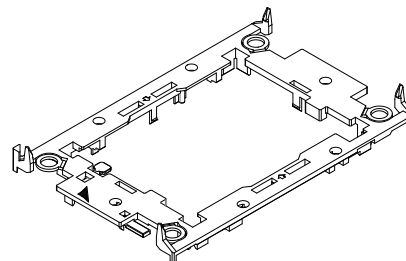
Processor (3D)

2. Processor Carrier

Intel Processor Carrier Top View)



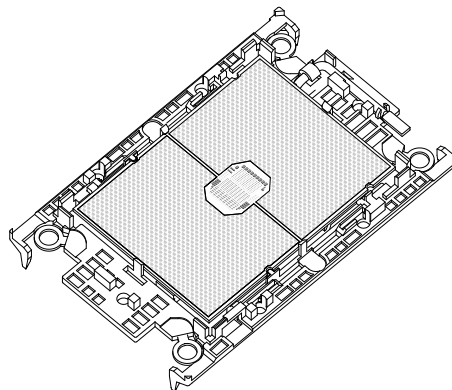
Processor Carrier (2D)



Processor Carrier (3D)



3. Processor Carrier Assembly

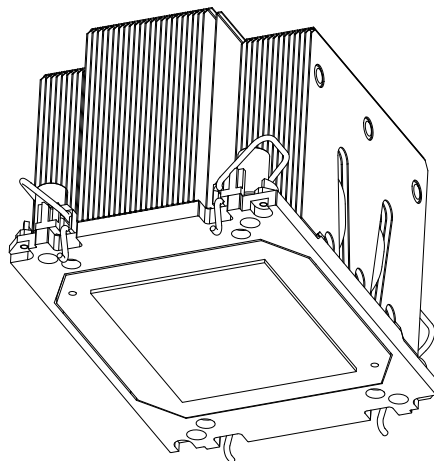


(with Processor Seated inside the Carrier)

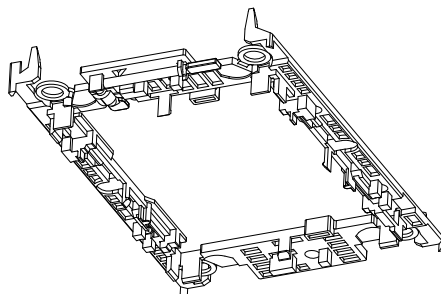
Overview of the Processor Heatsink Module

The Processor Heatsink Module (PHM) contains a heatsink, a processor carrier, and a 3rd Gen Intel Xeon Scalable processor.

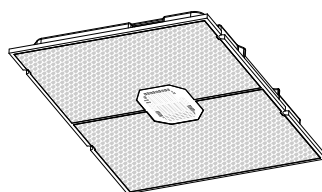
1. Heatsink (with Thermal Grease)



2. Processor Carrier



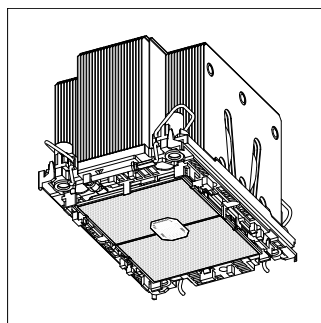
3. The 3rd Gen Intel Xeon Scalable Processor



Bottom View



4. Processor Heatsink Module (PHM)



Bottom View

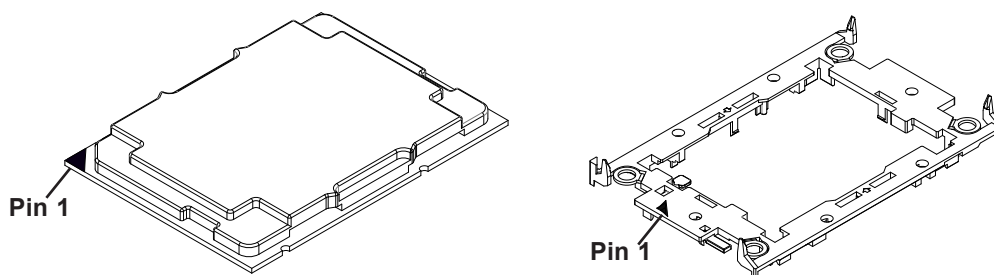
Create the Processor Carrier Assembly

The processor carrier assembly contains a 3rd Gen Intel Xeon Scalable processor and a processor carrier.

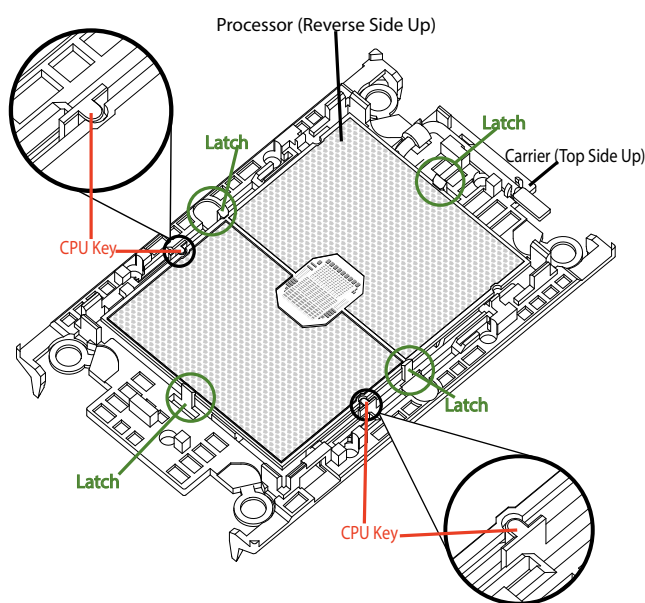
To create the processor carrier assembly, please follow the steps below:

Note: Before installation, be sure to follow the instructions given on page 27 of this chapter to properly prepare yourself for installation.

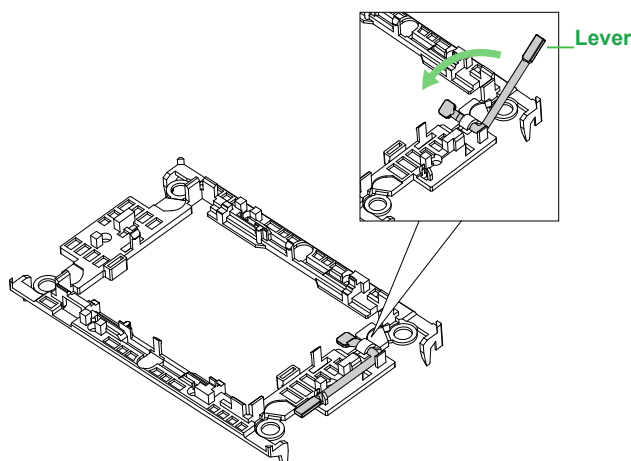
1. Hold the processor with the LGA lands (with Gold CPU contacts) facing down. Locate the small, gold triangle at the corner of the processor and the corresponding hollowed triangle on the processor carrier as shown in the graphics below. Please note that the triangle indicates Pin 1 location.



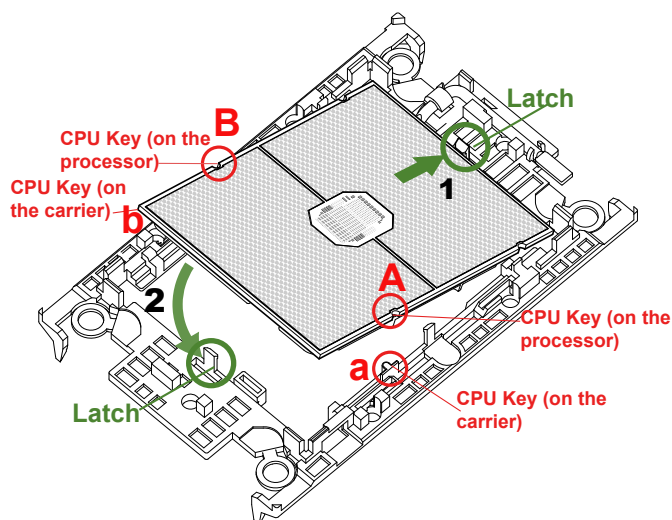
2. First, turn over the processor carrier and locate Pin 1 on the CPU and Pin 1 on the carrier. Then, turn the processor over with the processor reverse side (gold contacts) facing up and locate CPU keys on the processor. Finally, locate the CPU keys and four latches on the carrier as shown below.



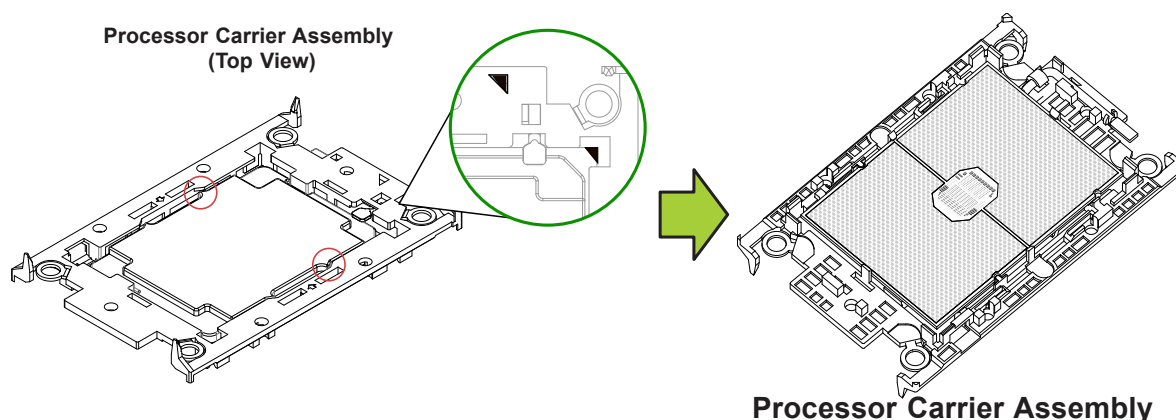
3. Locate the lever on the CPU socket and press the lever down as shown below.



4. Using Pin 1 as a guide, carefully align the CPU keys (A and B) on the processor against the CPU keys on the carrier (a and b) as shown in the drawing below.



5. Once they are properly aligned, carefully place one end of the processor into the latch marked 1 on the carrier, and place the other end of processor into the latch marked 2.
6. After the processor is placed inside the carrier, examine the four sides of the processor, making sure that the processor is properly seated on the carrier.

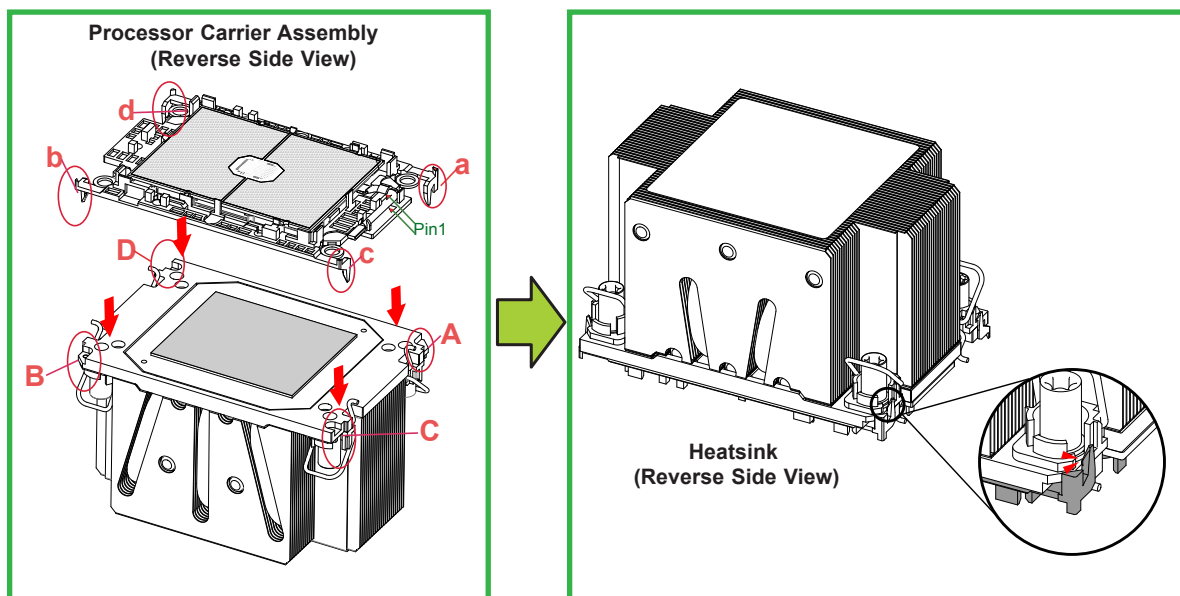


Create the Processor Heatsink Module (PHM)

After creating the processor carrier assembly, please follow the instructions below to mount the processor carrier into the heatsink to form the processor heatsink module (PHM).

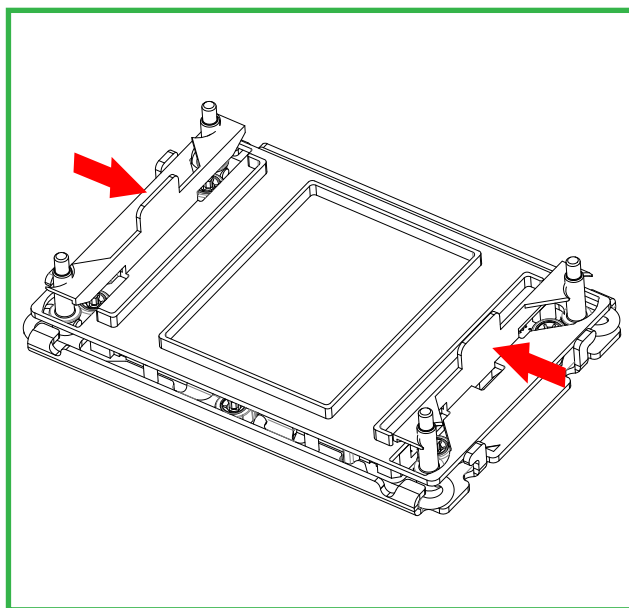
Note: If this is a new heatsink, the thermal grease has been pre-applied on the underside. Otherwise, apply the proper amount of thermal grease.

1. Turn the heatsink over with the thermal grease, which is on the reverse side of the heatsink, facing up. Pay attention to the two triangle cutouts (A and B) located at the diagonal corners of the heatsink as shown in the drawing below.
2. Hold the processor carrier assembly top side (with thermal grease) facing up, and locate the triangle on the CPU and the triangle on the carrier. (Triangle indicates Pin 1.)
3. Using Pin 1 as a guide, turn the processor carrier assembly over with the gold contacts facing up. Locate Pin 1 (A) on the processor and Pin 1 (a) on the processor carrier assembly "a".
4. Align the corner marked "a" on the processor carrier assembly against the triangle cutout "A" on the heatsink, and align the corners marked "b", "c", and "d" on processor assembly against the corners marked "B", "C", and "D" on the heatsinks
5. Once they are properly aligned, place the corner marked "a" on the processor carrier assembly into the corner of the heatsink marked "A". Repeat the same step to place the corners marked "b", "c", and "d" on the processor carrier assembly into the corners of the heatsink marked "B", "C", and "D". Make sure that all plastic clips are properly attached to the heatsink.

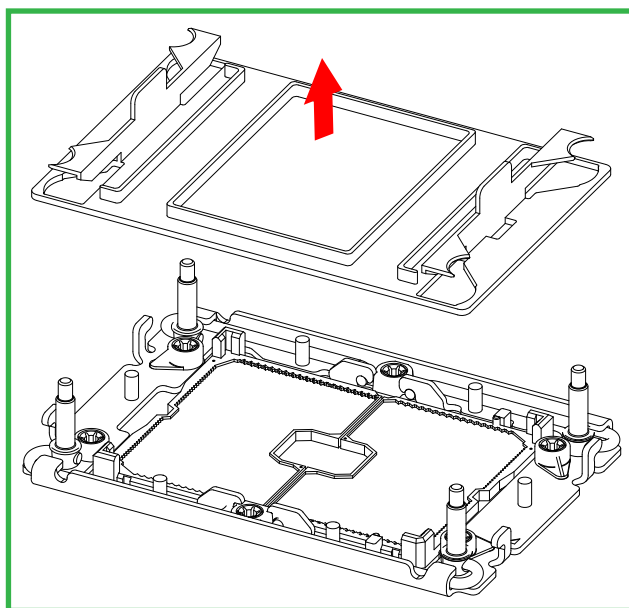


Prepare the CPU Socket

This motherboard comes with a plastic protective cover installed on the CPU socket. Remove it from the socket to install the Processor Heatsink Module (PHM). Gently pull up one corner of the plastic protective cover to remove it.



1. Press the tabs inward.

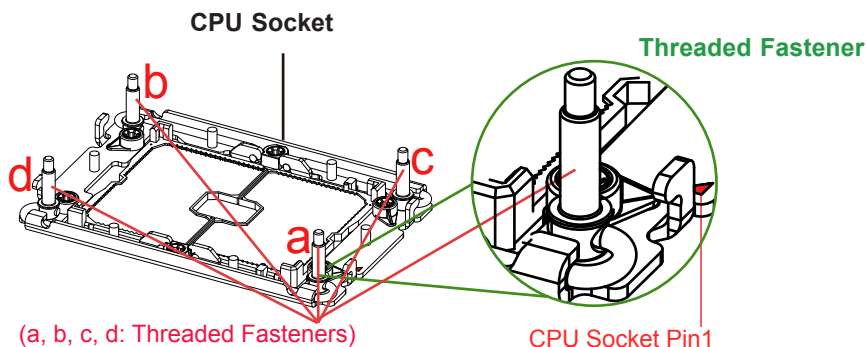


2. Pull up the protective cover from the socket.

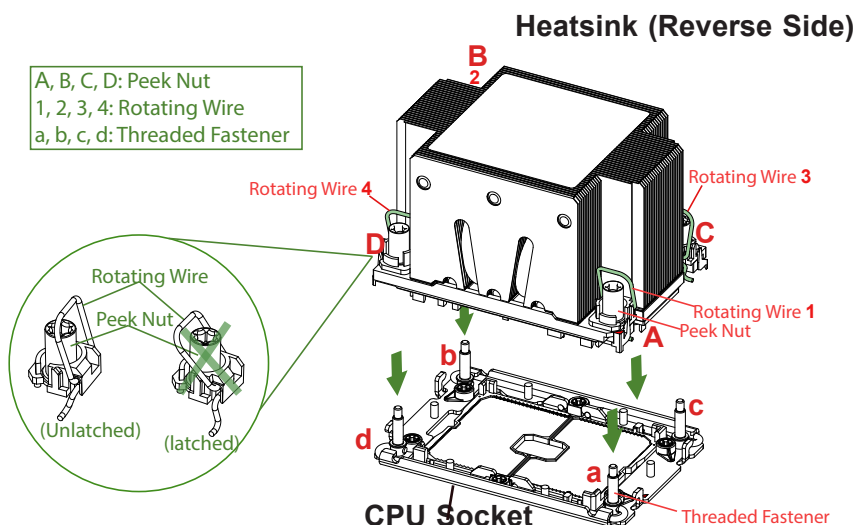
Install the Processor Heatsink Module (PHM)

After assembling the Processor Heatsink Module (PHM), you are ready to install it into the CPU socket. To ensure the proper installation, please follow the procedures below:

1. Locate four threaded fasteners (a, b, c, and d) on the CPU socket.

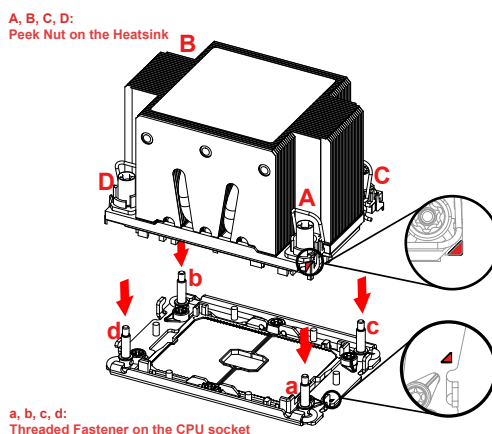


2. Locate four peek nuts (A, B, C, and D) and four rotating wires (1, 2, 3, and 4) on the heatsink as shown in the graphics below.

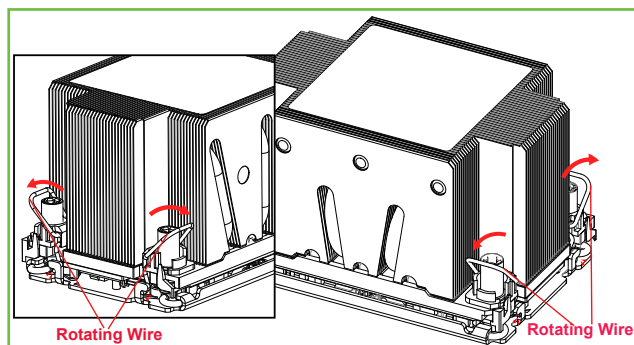


3. Check the rotating wires (1, 2, 3, and 4) to make sure that they are at unlatched positions as shown in the drawing below before installing the PHM into the CPU socket.

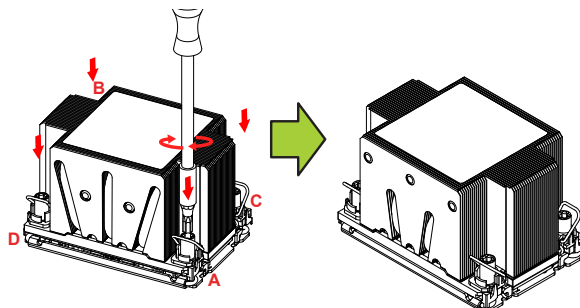
4. Align peek nut "A", which is next to the triangle (Pin 1) on the heatsink, against threaded fastener "a" on the CPU socket. Then align peek nuts "B", "C", and "D" on the heatsink against threaded fasteners "b", "c", and "d" on the CPU socket. Make sure that all peek nuts on the heatsink are properly aligned with the correspondent threaded fasteners on the CPU socket.
5. Once they are aligned, gently place the heatsink on top the CPU socket, making sure that each peek nut is properly attached to its corresponding threaded fastener.



6. Press all four rotating wires outwards and make sure that the heatsink is securely latched onto the CPU socket.



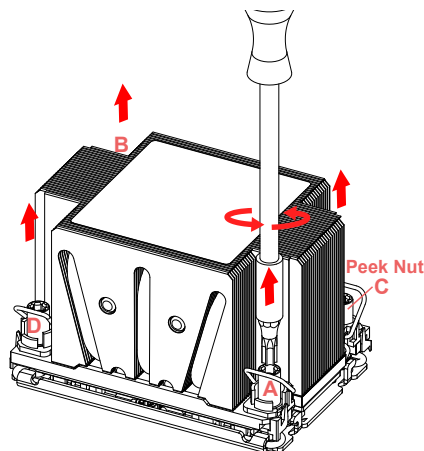
7. With a T30-bit screwdriver, tighten all peek nuts in the sequence of "A", "B", "C", and "D" with even pressure. To avoid damaging the processor or socket, do not use a force greater than 12 lbf-in when tightening the screws.
8. Examine all corners heatsink to ensure that the PHM is firmly attached to the CPU socket.



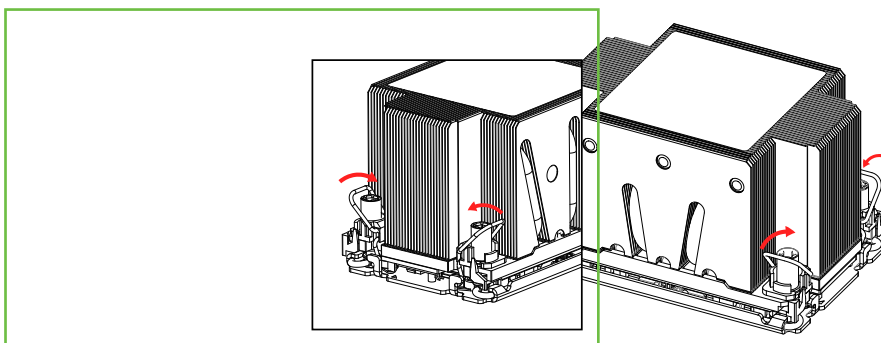
Remove the Processor Heatsink Module (PHM)

Before removing the processor heatsink module (PHM) from the motherboard, unplug the AC power cord from all power supplies after shutting down the system. Then follow the steps below:

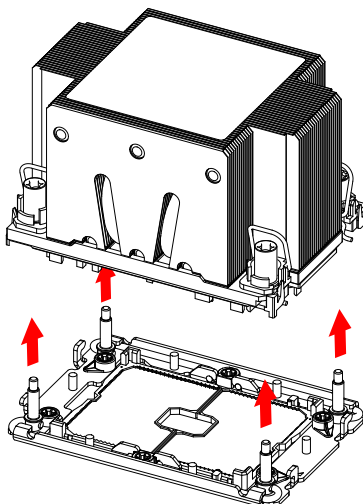
1. Use a T30-bit screwdriver to loosen the four peek nuts on the heatsink in the sequence of #A, #B, #C, and #D.



2. Once the peek nuts are loosened from the CPU socket, press the rotating wires inwards to unlatch the PHM from the socket as shown in the drawings below.



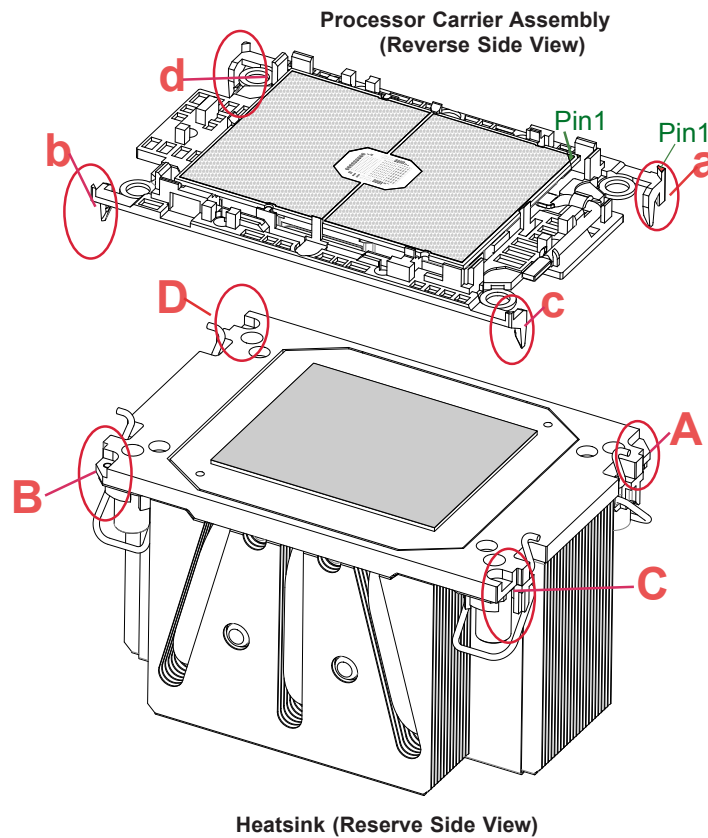
3. Gently lift the PHM upwards to remove it from the CPU socket.



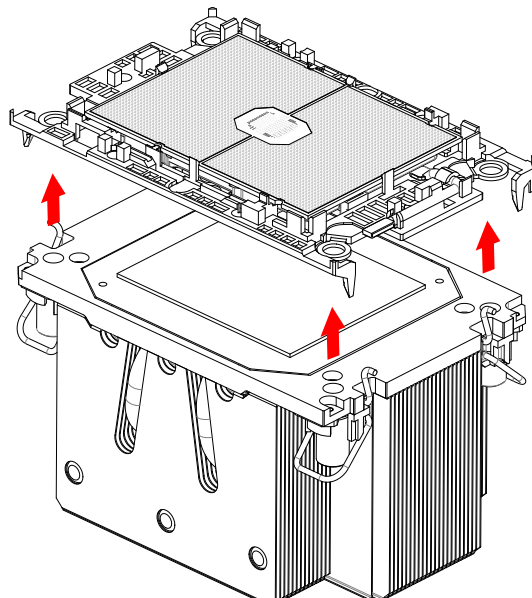
Remove the Carrier Assembly from the Heatsink

To remove the processor carrier assembly from the PHM, please follow the steps below:

1. Detach four plastic clips (marked a, b, c, and d) on the processor carrier assembly from the four corners of heatsink (marked A, B, C, and D) in the drawings below.



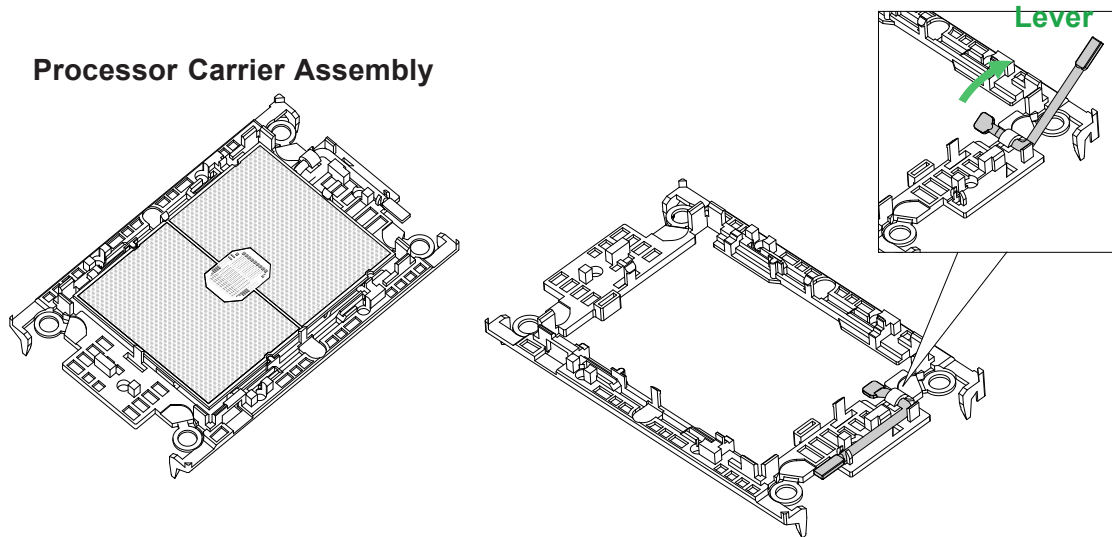
2. When all plastic clips are detached from the heatsink, remove the processor carrier assembly from the heatsink.



Remove the Processor from the Carrier Assembly

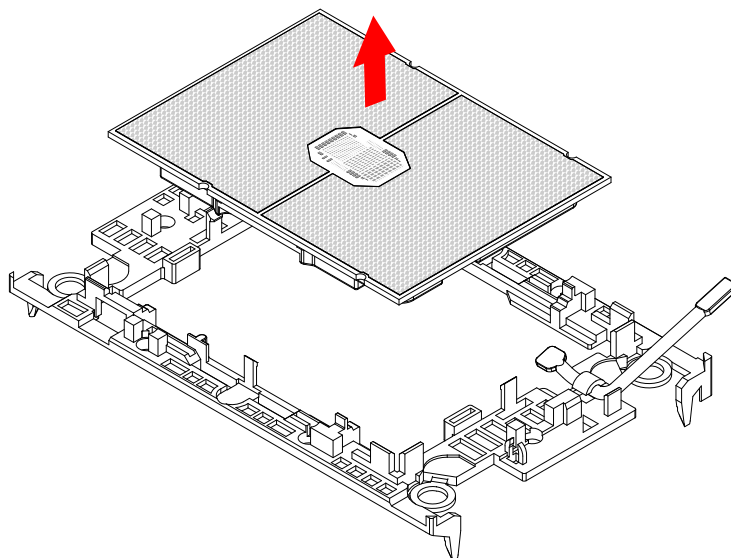
Once you have removed the processor carrier assembly from the PHM, you are ready to remove the processor from the processor carrier by following the steps below.

1. Unlock the lever from its locking position and push the lever upwards to disengage the processor from the processor carrier as shown in the right drawing below.



2. Once the processor is loosened from the carrier, carefully remove the processor from the processor carrier.

Note: To avoid damaging the processor and its pins, please handle the processor with care.



3.4 Memory

The X12DPG-AR supports up to 4TB 3DS LRDIMM/LRDIMM/3DS RDIMM/RDIMM DDR4 (288-pin) ECC memory with speeds of 3200/2933/2666 MHz in 16 memory slots and up to 4TB Intel Optane PMem 200 Series with speeds of up to 3200 MHz. (See the notes below.)

Notes: Intel® Optane™ Persistent Memory (PMem) 200 Series are supported by the 3rd Gen Intel Xeon Scalable (83xx/63xx/53xx/4314 Series) Processors. Memory speed support depends on the processors used in the system.

DDR4 Memory Support for the 3rd Gen Intel Xeon Scalable Processors

DDR4 Memory Support for the 3rd Gen Intel Xeon Scalable Processors					
Type	Ranks Per DIMM & Data Width	DIMM Capacity (GB)		Speed (MT/s); Voltage (V); Slots Per Channel (SPC) and DIMMs Per Channel (DPC)	
				1DPC (1-DIMM Per Channel)	2DPC (2-DIMM Per Channel)
		8Gb	16Gb	1.2 V	1.2 V
RDIMM	SRx8	8GB	16GB	3200	3200
	SRx4	16GB	32GB		
	DRx8	16GB	32GB		
	DRx4	32GB	64GB		
RDIMM 3Ds	(4R/8R) X4	2H- 64 GB 4H-128 GB	2H- 128 GB 4H-256 GB		
LRDIMM	QRx4	64GB	128GB	3200	3200
LRDIMM - 3Ds	(4R/8R) X4	4H-128 GB	2H- 128 GB 4H-256 GB	3200	3200

Key Parameters for DIMM Configurations	
Parameters	Possible Values
Number of Channels	8
Number of DIMMs per Channel	1DPC (1 DIMM Per Channel) or 2DPC (2 DIMMs Per Channel)
DIMM Type	RDIMM (w/ECC), 3DS RDIMM, LRDIMM, 3DS LRDIMM
DIMM Construction	non-3DS RDIMM Raw Cards: A/B (2Rx4), C (1Rx4), D (1Rx8), E (2Rx8) 3DS RDIMM Raw Cards: A/B (4Rx4) non-3DS LRDIMM Raw Cards: D/E (4Rx4) 3DS LRDIMM Raw Cards: A/B (8Rx4)

Memory Population Table for the 3rd Gen Intel Xeon Scalable Processors

Memory Population for the X12 DP Motherboard, 16 DIMM Slots	
CPU/DIMMs	Memory Population Sequence
1 CPU & 1 DIMM	A1
1 CPU & 2 DIMMs*	A1, E1
1 CPU & 4 DIMMs*	A1, E1, C1, G1
1 CPU & 6 DIMM	A1, E1, C1, G1, B1, F1
1 CPU & 8 DIMMs*	A1, E1, C1, G1, B1, F1, D1, H1
2 CPUs & 2 DIMMs*	CPU1: A1 CPU2: A1
2 CPUs & 4 DIMMs*	CPU1: A1, E1 CPU2: A1, E1
2 CPUs & 6 DIMMs	CPU1: A1, E1, C1, G1 CPU2: A1, E1
2 CPUs & 8 DIMMs*	CPU1: A1, E1, C1, G1 CPU2: A1, E1, C1, G1
2 CPUs & 10 DIMMs	CPU1: A1, E1, C1, G1, B1, F1 CPU2: A1, E1, C1, G1
2 CPUs & 12 DIMMs*	CPU1: A1, E1, C1, G1, B1, F1 CPU2: A1, E1, C1, G1, B1, F1
2 CPUs & 14 DIMMs	CPU1: A1, E1, C1, G1, B1, F1, D1, H1 CPU2: A1, E1, C1, G1, B1, F1
2 CPUs & 16 DIMMs*	CPU1: A1, E1, C1, D1, B1, F1, G1, H1 CPU2: A1, E1, C1, D1, B1, F1, G1, H1

Note: To maximize memory performance, please use the memory configurations marked with "*" above (also shaded in orange) as these configurations are recommended by Supermicro for optimal memory performance.

Intel Optane PMem 200 Series Memory Population Table

Note: Intel® Optane™ Persistent Memory (PMem) 200 Series are supported by the 3rd Gen Intel Xeon Scalable (83xx/63xx/53xx/4314 Series) Processors.

PMem 200 Series Population Table for X12DP 16-DIMM Motherboards (within 1 CPU socket)										
DDR4+PMem	Mode	AD Interleave	P1-DIMMF1	P1-DIMME1	P1-DIMMH1	P1-DIMMG1	P1-DIMMC1	P1-DIMMD1	P1-DIMMA1	P1-DIMMB1
4+4	AD MM	One - x4	PMem	DDR4	PMem	DDR4	DDR4	PMem	DDR4	PMem
		One - x4	DDR4	PMem	DDR4	PMem	PMem	DDR4	PMem	DDR4
6+1	AD	One - x1	DDR4	DDR4	-	DDR4	DDR4	PMem	DDR4	DDR4
			-	DDR4	DDR4	DDR4	DDR4	DDR4	DDR4	PMem
			DDR4	DDR4	PMem	DDR4	DDR4	-	DDR4	DDR4
			PMem	DDR4	DDR4	DDR4	DDR4	DDR4	DDR4	-
			DDR4	DDR4	DDR4	-	PMem	DDR4	DDR4	DDR4
			DDR4	-	DDR4	DDR4	DDR4	DDR4	PMem	DDR4
			DDR4	DDR4	DDR4	PMem	-	DDR4	DDR4	DDR4
			DDR4	PMem	DDR4	DDR4	DDR4	DDR4	-	DDR4

Legend (for the table above)	
DDR4 Type and Capacity	
DDR4	See Validation Matrix (DDR4 DIMMs validated with PMem)
Capacity	
PMem	Any Capacity (Uniformly for all channels for a given configuration)

- Mode definitions: AD = App Direct Mode, MM = Memory Mode.
- No mixing of PMem and NVDIMMs within the platform.
- For MM, NM/FM ratio is between 1:4 and 1:16. (NM = Near Memory (DRAM); FM = Far Memory (PMem)).
- Matrix targets configs for optimized PMem to DRAM cache ratio in MM mode.
- For each individual population, different PMem rearrangements among channels are permitted so long as the configuration doesn't break X12DP Memory population rules.
- Ensure the same DDR4 DIMM type and capacity are used for each DDR4 + PMem population.
- If the system detects an unvalidated configuration, then the system issues a BIOS warning. The CLI functionality is limited in non-POR configurations, and select commands will not be supported.

Validation Matrix (DDR4 DIMMS with PMem 200 Series)			
DIMM Type	Ranks Per DIMM & Data Width (Stack)	DIMM Capacity (GB)	
		DRAM Density	
		8Gb	16Gb
RDIMM (up to 3200)	1Rx8	N/A	N/A
	1Rx4	16GB	32GB
	1Rx8	16GB	32GB
	1Rx4	32GB	64GB
RDIMM 3DS (up to 3200)	4Rx4 (2H)	N/A	128GB
	8Rx4 (4H)	NA	256GB
LRDIMM (up to 3200)	4Rx4	64GB	128GB
LRDIMM 3DS (up to 3200)	4Rx4 (2H)	N/A	N/A
	8Rx4 (4H)	128GB	256GB

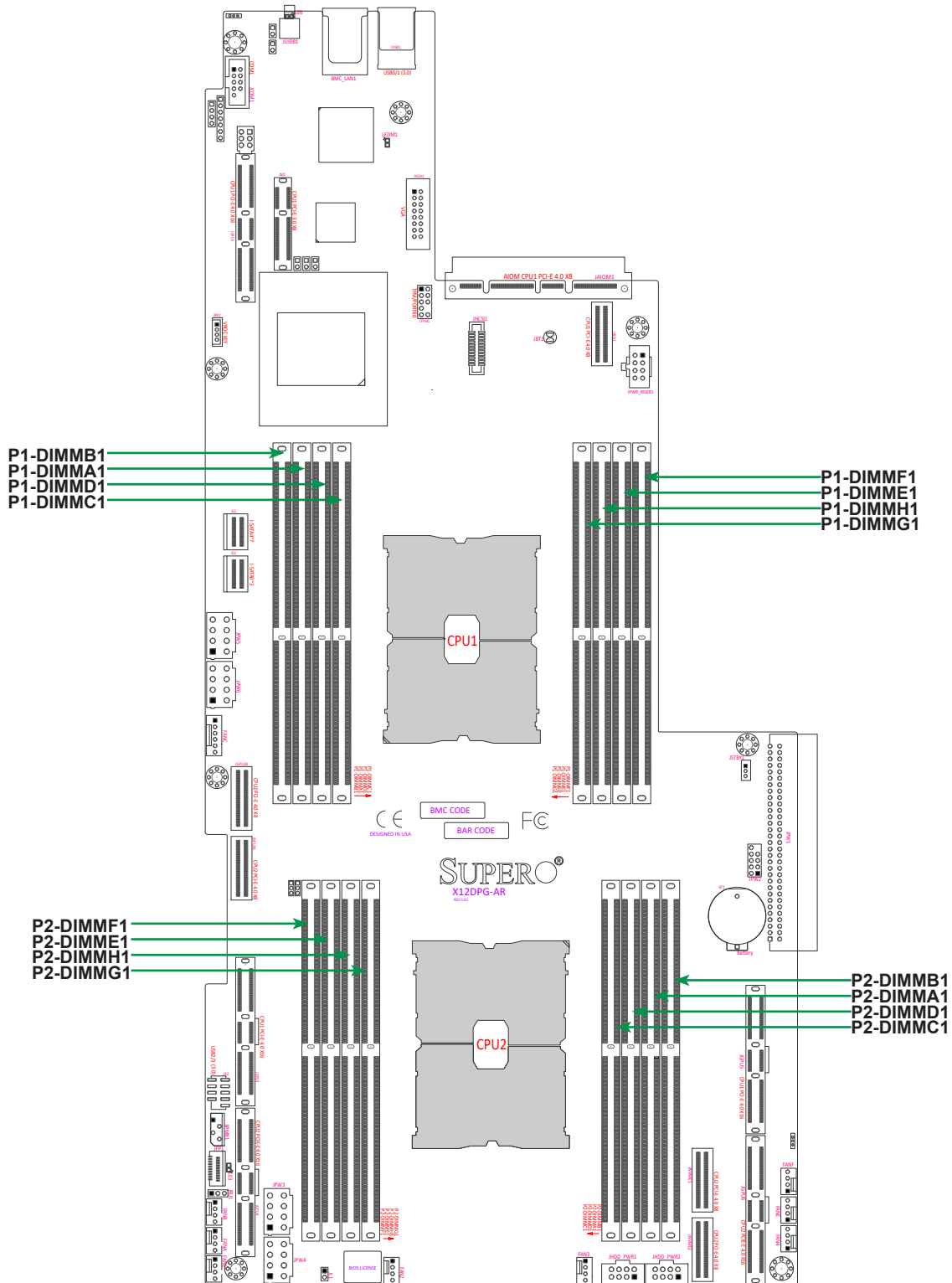
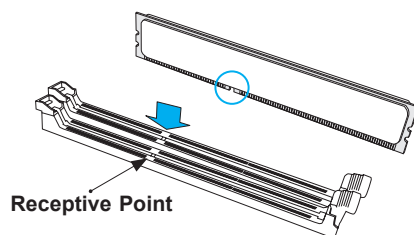


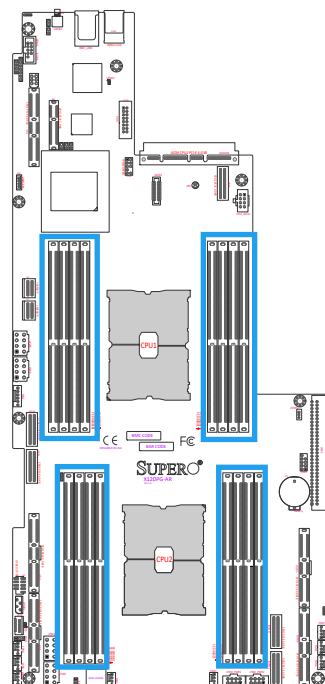
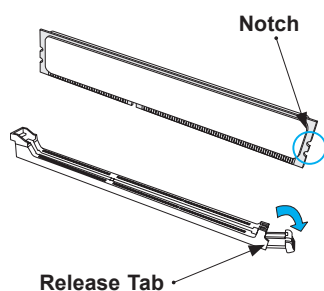
Figure 3-2. DIMM Slots

DIMM Installation

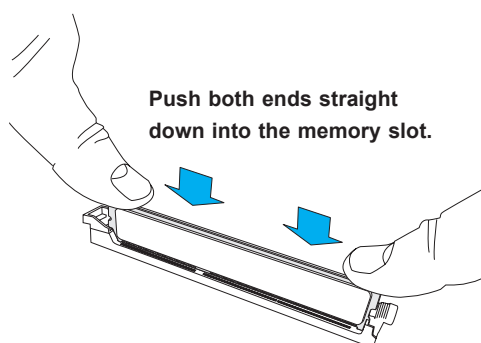
1. Insert the desired number of DIMM modules based on the recommended DIMM population table on page 44.
2. Align the DIMM module key with the receptive point on the single-latch DIMM slot.



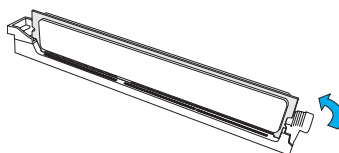
3. Push the release tab outwards to unlock the slot.



4. Press both ends of the module straight down into the slot until the module snaps into place.



5. Push the release tab to the lock position to secure the module into the slot.



DIMM Removal

Reverse the steps above to remove the DIMM modules from the motherboard.

3.5 Motherboard Battery

The motherboard uses non-volatile memory to retain system information when system power is removed. This memory is powered by a lithium battery residing on the motherboard.

Replacing the Battery

Begin by [removing the top cover](#).

1. Push aside the small clamp that covers the edge of the battery. When the battery is released, lift it out of the holder.
2. To insert a new battery, slide one edge under the lip of the holder with the positive (+) side facing up. Then push the other side down until the clamp snaps over it.

Note: Handle used batteries carefully. Do not damage the battery in any way; a damaged battery may release hazardous materials into the environment. Do not discard a used battery in the garbage or a public landfill. Please comply with the regulations set up by your local hazardous waste management agency to dispose of your used battery properly.

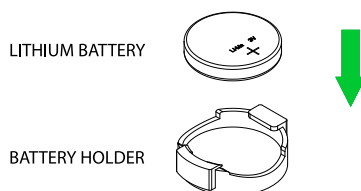


Figure 3-3. Installing the Onboard Battery

Warning: There is a danger of explosion if the onboard battery is installed upside down (which reverses its polarities). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer (CR2032).

3.6 Storage Drives

Hard Drives

The SYS-220GP-TNR has ten 2.5" drive bays located at the front of the chassis. All ten slots support orderly hot-swap and hot-plug. A drive can be removed or inserted without removing power. However, before physically removing a drive from a live system, follow the necessary steps to remove the logical drive from the operating system. To maintain proper airflow, re-install the drive carrier, even if no physical drives are installed.

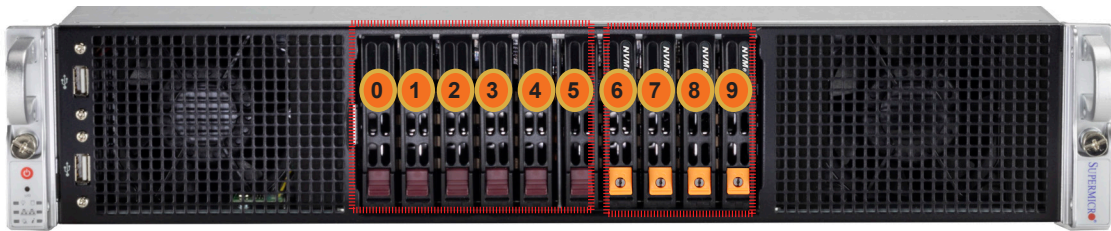


Figure 3-4. Physical Drives

Removing a Hot-Swap Drive Carrier

1. Push the release button on the carrier. This extends the carrier handle. If pressing the button on slots 6-9 does not extend the carrier handle, the handle may be locked: using a flat-head screwdriver, rotate the screw counterclockwise 45 degrees to unlock the handle.

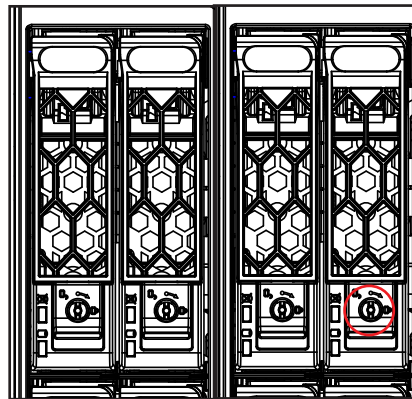


Figure 3-5. Unlocking Handle (Slots 6-9)

2. Swing the handle fully out.
3. Grasp the handle and use it to pull the drive carrier out of its bay.

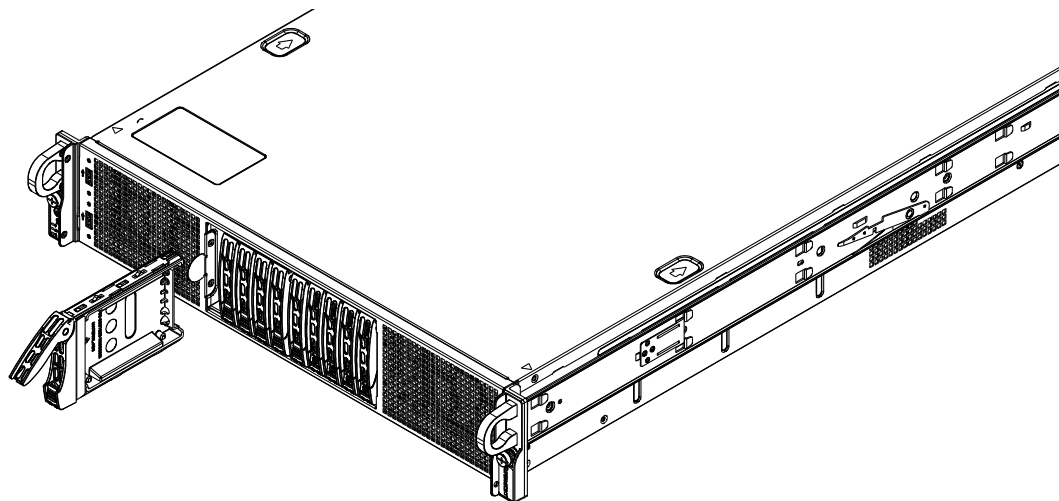


Figure 3-6. Removing Drive Carrier

Mounting a Drive in a Drive Carrier

1. To add a new drive, install it into the carrier with the printed circuit board side facing down so that the mounting holes align with those in the carrier.
2. Secure the drive to the carrier with the screws provided, then push the carrier completely into the drive bay. You should hear a *click* when the drive is fully inserted. This indicates that the carrier has been fully seated and connected to the backplane, which automatically makes the power and logic connections to the hard drive.

Removing a Drive from a Drive Carrier

1. Remove the screws that secure the hard drive to the carrier and separate the hard drive from the carrier.
2. Replace the carrier back into the drive bay.

Graphics Processing Units

The SYS-220GP-TNR supports up to six double-width GPU cards, which are mounted in brackets to fit into the PCIe slots at the front and rear of the chassis. NVIDIA A10/A16/A30*/A40/A100-40/A100-80/A6000 GPUs are supported. The GPU cards may be pre-installed, see the procedure below for installing a GPU card. See <https://ftpw.supermicro.com.tw/support/resources/GPU/> for a list of supported GPUs and the NVIDIA website for more details on the GPU specifications.

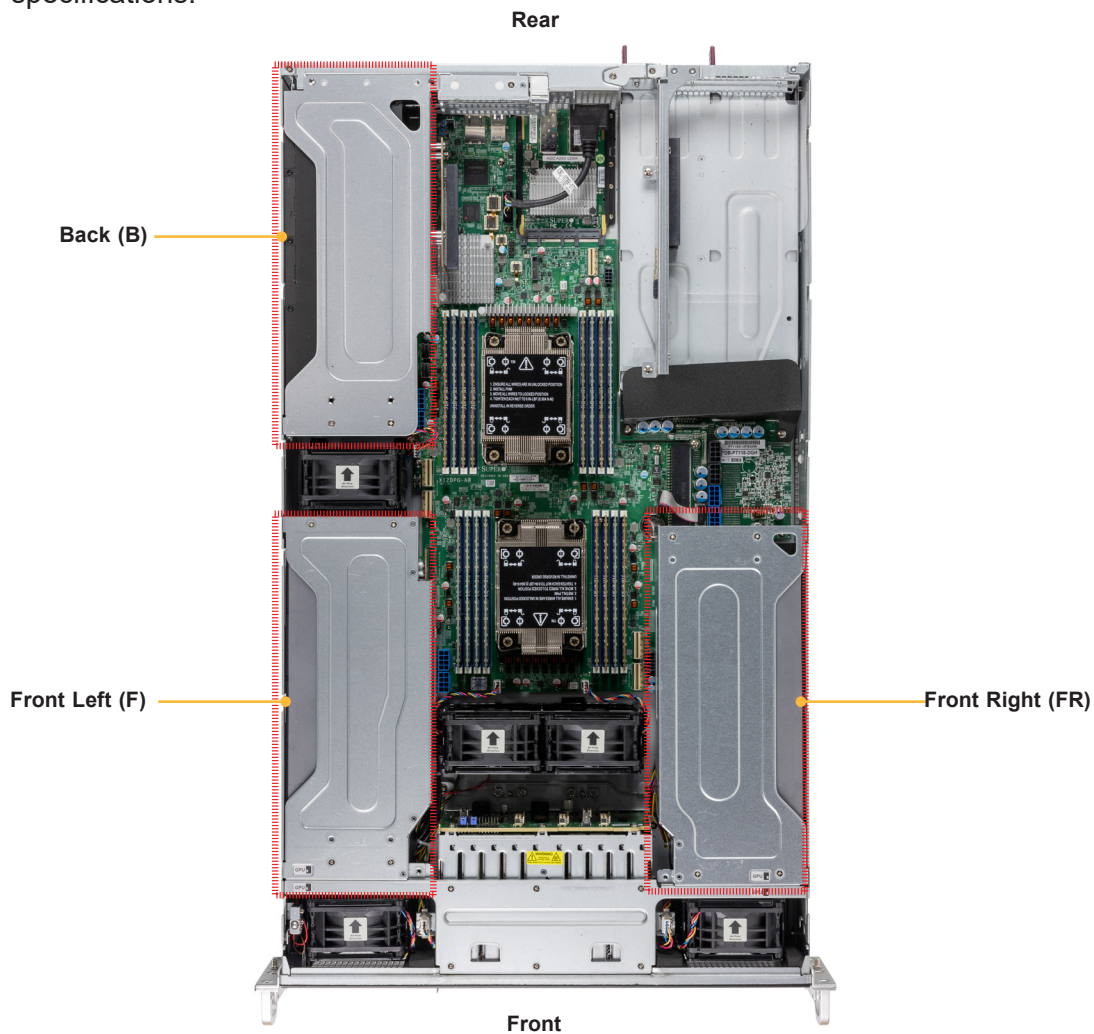


Figure 3-7. GPU Bracket Locations

GPU Brackets	
Location	Riser Card Part Number
Front Left (F)	RSC-G2F-66G4
Front Right (FR)	RSC-G2FR-66G4
Back (B)	RSC-G2B-66G4

Installing Front Left GPUs

1. Begin by removing power from the system. Next remove the top cover.
2. Identify the front left bracket and graphics cards as illustrated.
3. Remove the pre-installed tabs on the GPU cards.
4. Insert the GPU cards into the PCIe slot on the riser card.
5. Secure each card to the bracket using the screws that are included for this purpose. Make sure the screws do not fall through the vent holes on the GPU cards.
6. Connect one 8-pin power cable to each GPU card. Zip-tie the power cables.
7. Carefully position each bracket in the chassis as illustrated, aligning the four mounting holes in the top and side of each bracket with the corresponding mounting holes in the chassis. Pay attention to the airflow arrows to install each card into the correct side of the chassis.
8. As you are positioning the GPU bracket, route the power cables towards the motherboard power connector by tucking the cables between the bracket and the fan.



Caution: Watch out for interference from the power cables as you are seating the GPU bracket. Watch out for the fan, USB, and front panel cables as you are connecting the GPU power cable.

9. Press the area on bracket above the PCIe slot firmly to ensure a good connection between the GPU card and the motherboard.
10. Secure the bracket to the chassis by using the screws provided.
11. After the GPU card is installed, you must connect it to one of the following power headers on the motherboard: JPW3 and JPW4.

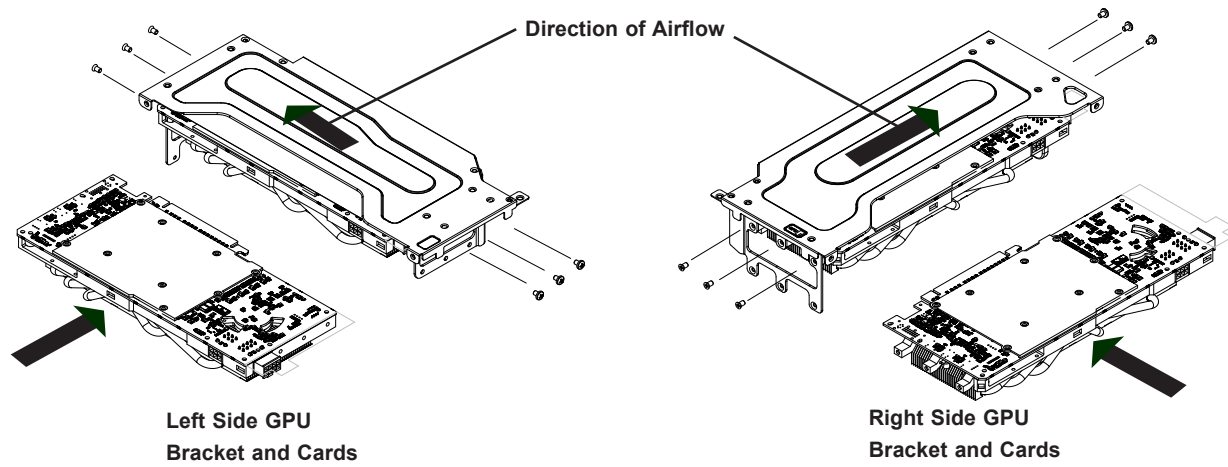


Figure 3-8. Installing GPUs

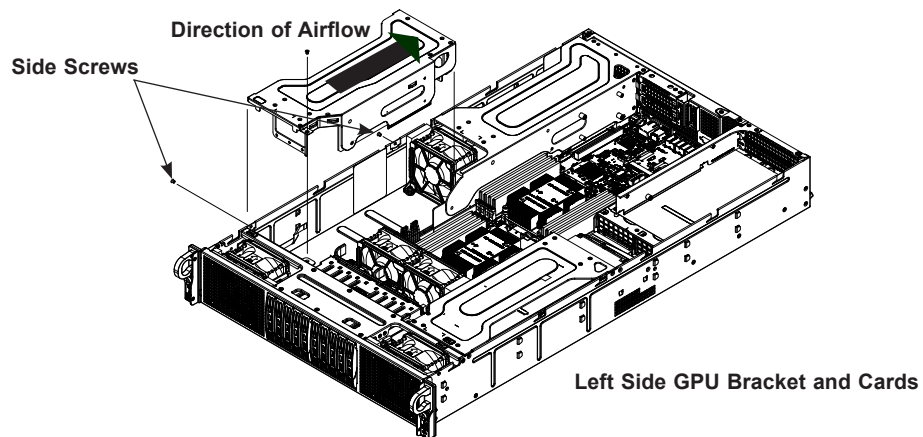


Figure 3-9. Installing GPUs

Installing Front Right GPUs

1. Begin by removing power from the system. Next remove the top cover.
2. Identify the front right bracket and graphics cards as illustrated.
3. Remove the pre-installed tabs on the GPU cards.
4. Insert the GPU cards into the PCIe slot on the riser card.
5. Secure each card to the bracket using the screws that are included for this purpose. Make sure the screws do not fall through the vent holes on the GPU cards.
6. Connect one 8-pin power cable to each GPU card. Zip-tie the power cables.
7. Carefully position each bracket in the chassis as illustrated, aligning the four mounting holes in the top and side of each bracket with the corresponding mounting holes in the chassis. Pay attention to the airflow arrows to install each card into the correct side of the chassis
8. As you are positioning the GPU bracket, route the power cables towards the power distribution board.



Caution: Watch out for interference between the GPU power cables and the power distribution board as you are connecting the GPU power cables.

9. Press the area on bracket above the PCIe slot firmly to ensure a good connection between the GPU card and the motherboard.
10. Secure the bracket to the chassis by using the screws provided.
11. After the GPU card is installed, connect the GPU power cable to the blue connectors (CON555 and CON556) on the power distribution board.

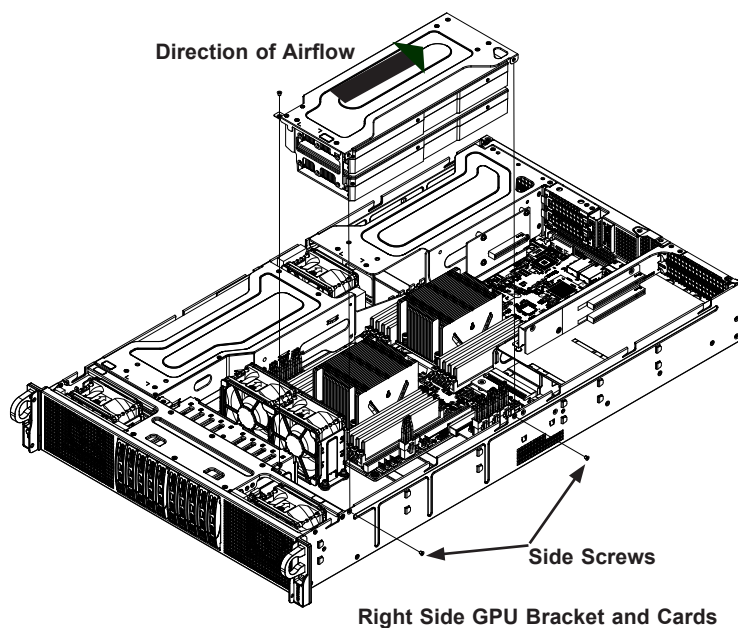


Figure 3-10. Installing Front Right GPU Bracket

Installing Rear GPUs

1. Begin by removing power from the system. Next remove the top cover.
2. Identify the rear bracket and graphics cards as illustrated.
3. Keep the pre-installed tabs on the GPU cards.
4. Insert the GPU cards into the PCIe slot on the riser card.
5. Secure each card to the bracket using the screws that are included for this purpose. Make sure the screws do not fall through the vent holes on the GPU cards.
6. Carefully position each bracket in the chassis as illustrated, aligning the four mounting holes in the top and side of each bracket with the corresponding mounting holes in the chassis. Pay attention to the airflow arrows to install each card into the correct side of the chassis
7. Secure the bracket to the chassis by using the screws provided.
8. After a GPU card is installed, you must connect it to one of the following power headers on the serverboard: JPW5 and JPW6.

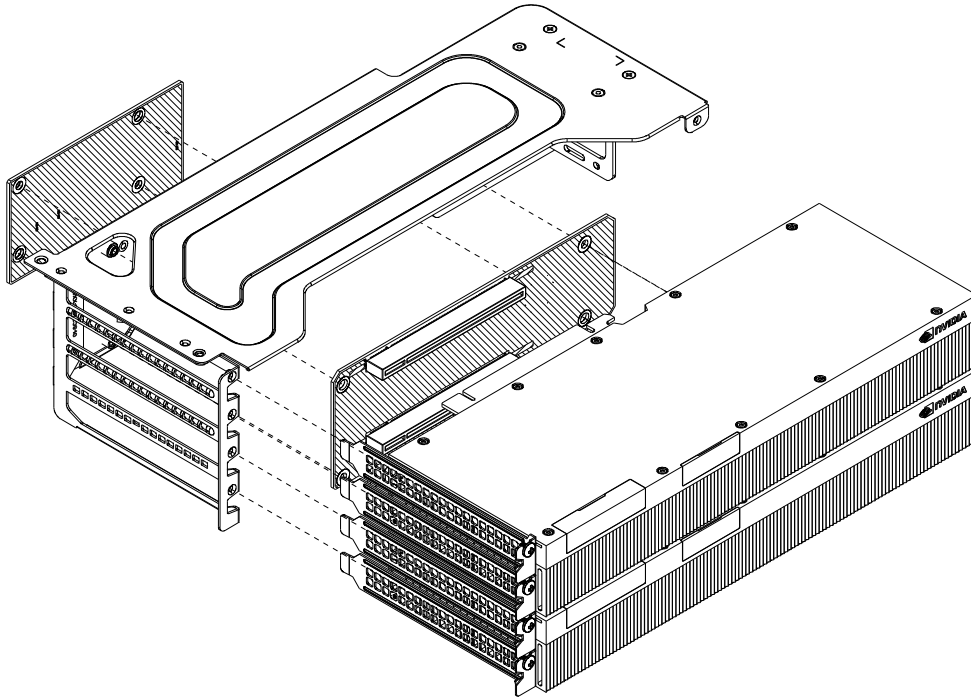


Figure 3-11. Rear GPUs and Bracket

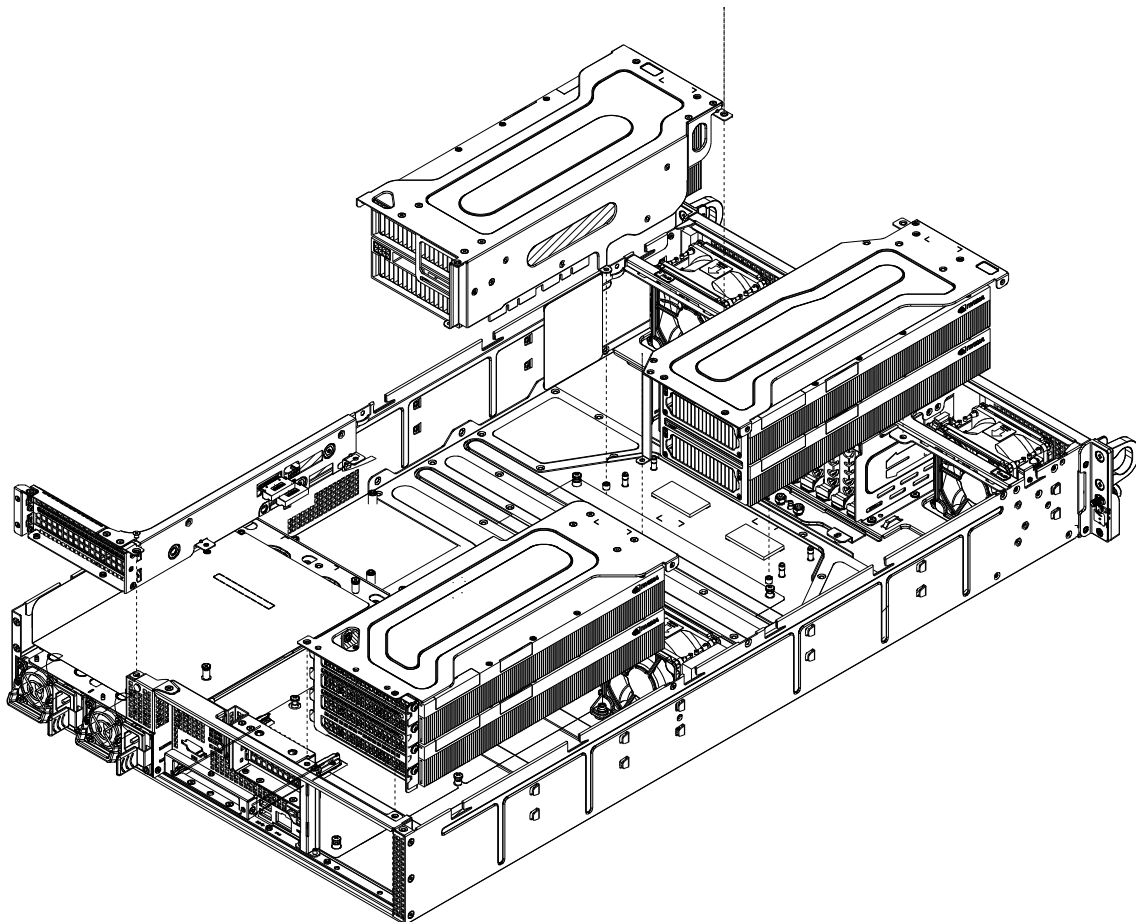


Figure 3-12. Installing GPUs

3.7 System Cooling

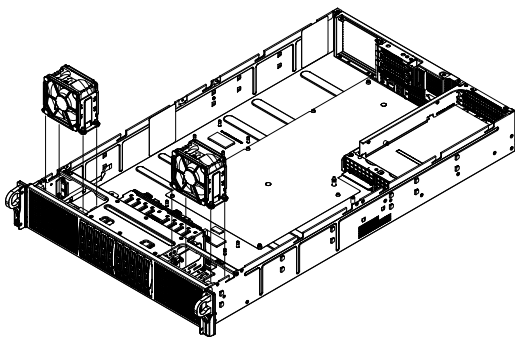
Five 8-cm fans provide the cooling for the system. It is very important that the chassis top cover is properly installed and making a good seal in order for the cooling air to circulate properly through the chassis and cool the components.

System Fan Failure

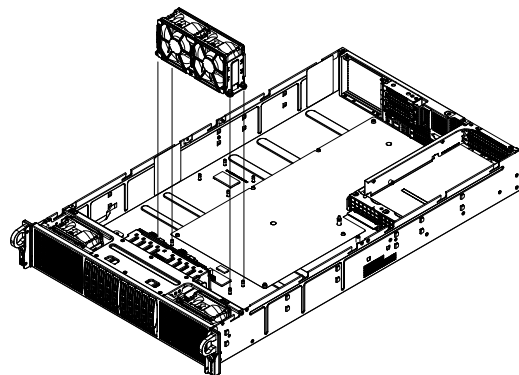
Fan speed is controlled by system temperature by means of an IPMI setting. If a fan fails, the remaining fans will ramp up to full speed. The system can continue to run with a failed fan. Replace any failed fan at your earliest convenience with the same type and model.

Replacing a System Fan

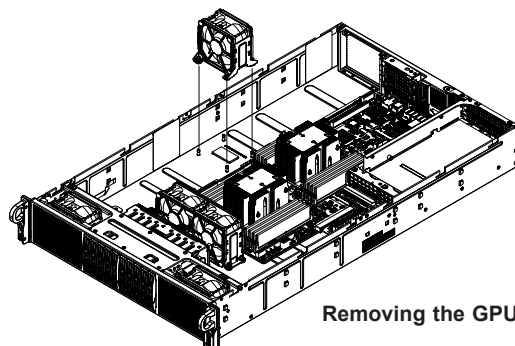
1. Use BMC GUI interface to check which fan has failed.
2. After determining the failed fan, remove power from the system as described in Section 3.1 and remove the cover as described in Section 3.2.
3. Remove the screws securing the fan housing to the floor of the chassis. See the illustrations below to determine the location of the screws for the fan that is being removed. Set these screws aside for later use.



Removing the Front Fans



Removing the Mid Fans



Removing the GPU Fan

Figure 3-13. Removing the Front, Mid and GPU Fans

1. Lift the fan housing up and out of the chassis.
2. Disconnect the fan cable.
3. Examine the drawings below, then disassemble the fan housing by removing the front and rear fan guards (A).
4. Reassemble the fan housing around the replacement fan as follows:

Front and GPU Fans

1. Clip the front and rear fan guards (A) into the left and right side clips (B)

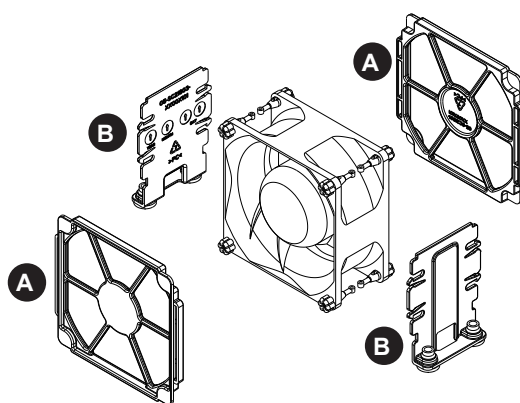


Figure 3-14. Reassembling a Front or GPU Fan Housing

Mid Fans

2. Slide the center clip (C) between the two fans. Clip the front and rear fan guards (A) to the left and right side clips (B)

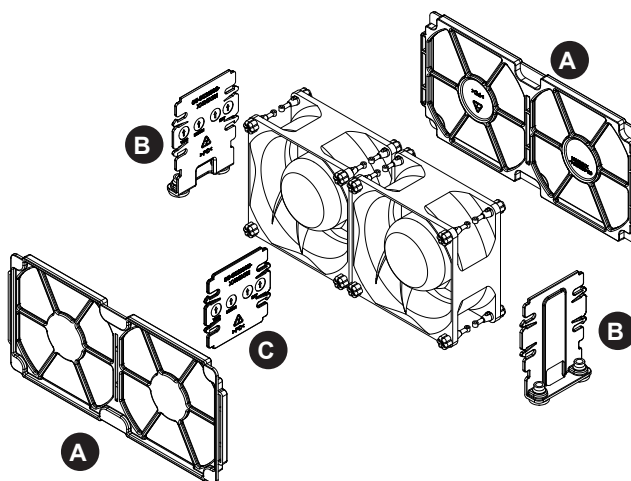


Figure 3-15. Reassembling the Mid Fan Housing

3. Reconnect the cable to the replacement fan.
4. Replace the chassis cover and power cord, then power the system back on.

Air Shroud

Air shrouds concentrate airflow to maximize fan efficiency. The serverboard air shroud does not require screws for installation.

Installing the Serverboard Air Shroud

1. Remove power from the system as described in Section 3.1 and remove the cover as described in Section 3.2.
2. Ensure that the motherboard, CPU, heatsink and memory are all properly installed.
3. If necessary, move any cables that interfere with the air shroud placement.
4. Place the air shroud in the chassis. The air shroud fits just behind the fans in the fan rack. Slide the air shroud into the grooves just behind the fan rack. Note that some serverboards may require the air shroud to be modified to fit over the serverboard.

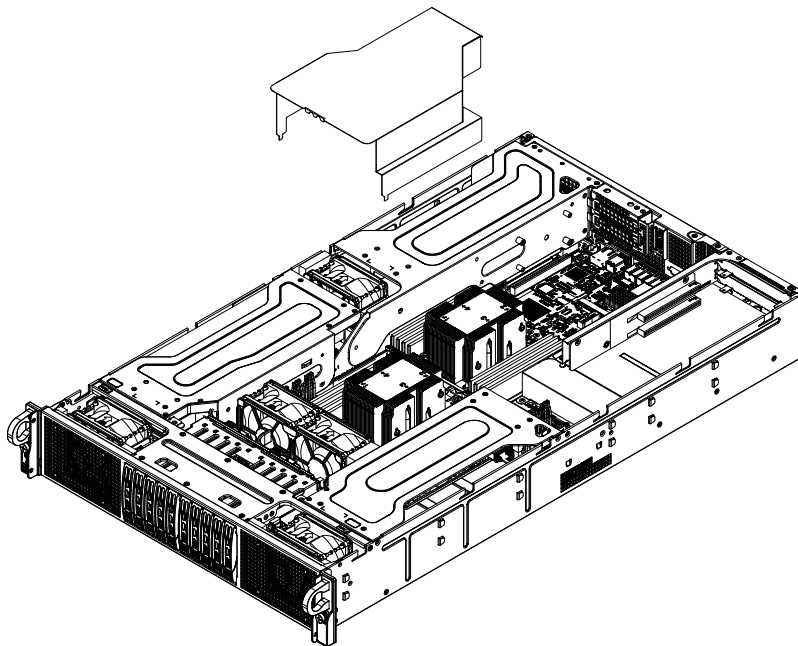


Figure 3-16. Installing the Air Shroud

3.8 Power Supply

The system includes dual 2600 Watt power modules. They automatically sense the input voltage between 200V to 240V, and operate at that voltage. Note that different input voltages will result in different maximum power output levels.

In the event of a power supply failure, the remaining power supply will automatically take over.* The failed power module can then be replaced without powering-down the system with the same model. Replacement modules can be ordered directly from Supermicro.

An amber light on the power supply is illuminated when the power is switched off. A green light indicates that the power supply is operating.

Replacing the Power Supply

1. Push the release tab on the front of the failed power supply.
2. Grasp the handle of the power supply and pull it out of the power supply bay.
3. Push the new power supply module into the power bay until it clicks into the locked position.

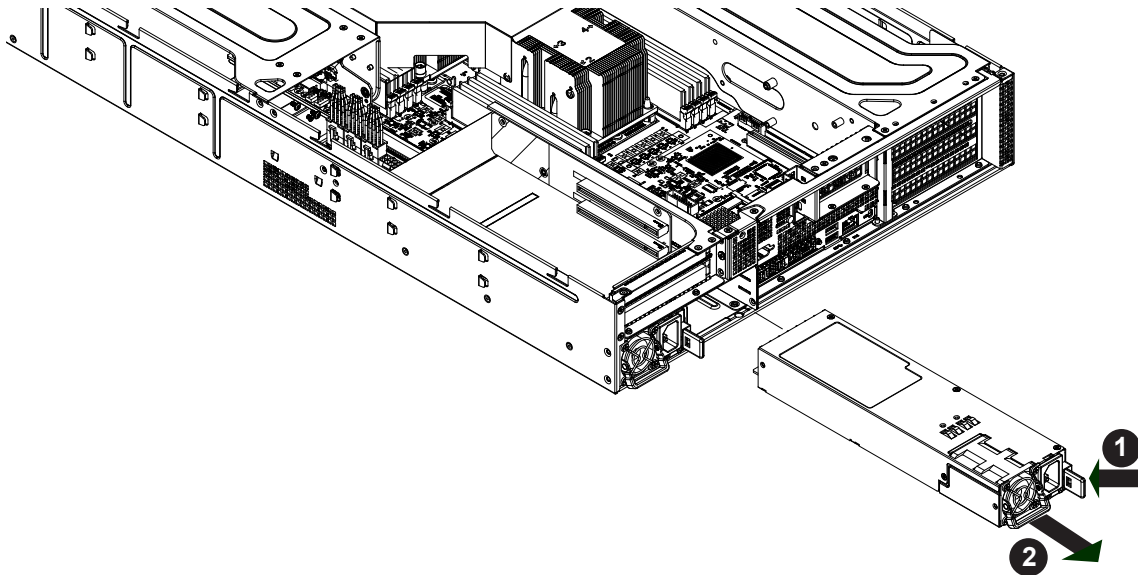


Figure 3-17. Removing/Replacing a Power Supply



Warning: Each power cord shall be connected to a socket outlet with earthing connection.

3.9 Rear GPU Cable Routing Diagram

The system supports the installation or removal of the rear GPU cage. Below is the cable routing diagram showing the SlimSAS cables. See the next page for the location of connectors 7 and 8.

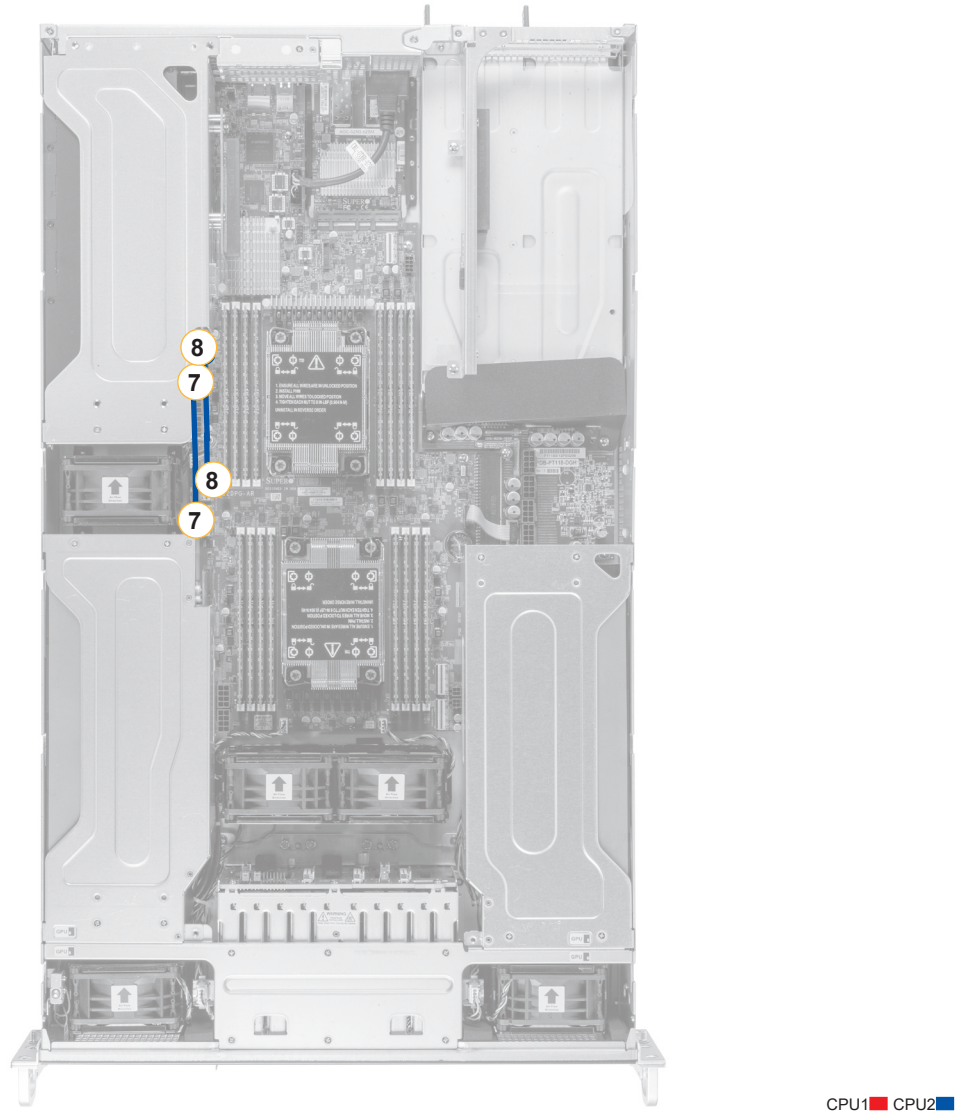
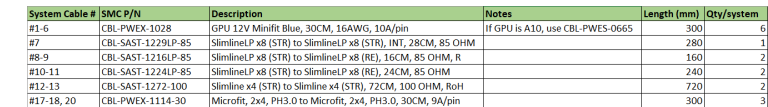


Figure 3-18. Cable Routing Diagram



3.10 BMC Reset

The BMC can be reset using the UID button.

- Reset – Press and hold the button. After six seconds, the LED blinks at 2Hz. The BMC resets and the reset duration is ~250 ms. Then the BMC starts to boot.
- Restore factory default configuration – Hold the button for twelve seconds. The LED blinks at 4Hz while the defaults are configured. **Note:** All BMC settings including username and password will be removed except the FRU and network settings.

Firmware update – When the BMC firmware is being updated, the UID LED blinks at 10Hz.

BMC Reset Options	
Event	UID LED
Reset	Blue, Blinks at 2Hz
Restore Defaults	Blue, Blinks at 4Hz
Update	Blue, Blinks at 10Hz

Chapter 4

Motherboard Connections

This section describes the connections on the motherboard and provides pinout definitions. Note that depending on how the system is configured, not all connections are required. The LEDs on the motherboard are also described here. A motherboard layout indicating component locations may be found in [Chapter 1](#). More detail can be found in the [Motherboard Manual](#).

Please review the Safety Precautions in [Appendix A](#) before installing or removing components.

4.1 Power Connections

Power Supply Connectors

This motherboard utilizes two power supply connectors (JPW1/JPW2) to provide main power to the system. Four 8-pin 12V DC power connectors (JPW3~6) are used to provide additional power to GPU devices. Another two 8-pin power connectors (JHDD_PWR1, JHDD_PWR2) are for NVMe storage devices. Please connect all these power connectors to your power supplies to provide adequate power to your system.

8-Pin GPU Power Connectors

Four 8-pin 12V power connectors are located at (JPW3-6) on the motherboard to provide power to GPU devices. Refer to the table below for pin definitions.

12V 8-pin Power Pin Definitions	
Pin#	Definition
1 - 4	Ground
5 - 8	+12V

8-Pin Riser Card Power Connectors

A 8-pin 12V power connector are located at (JPWR_RISER1) on the motherboard to provide power to riser cards. Refer to the table below for pin definitions.

12V 8-pin Power Pin Definitions	
Pin#	Definition
1 - 4	Ground
5 - 6	+12V
7	+3.3V
8	+3.3V_STBY

8-Pin HDD Power Connectors

Two 8-pin power connectors are located at JHDD_PWR1 and JHDD_PWR2. These two connectors are for NVMe storage devices. Refer to the motherboard in Chapter 1 for the location.

8-pin Backplane Power Pin Definitions	
Pin#	Definition
1 - 4	Ground
5 - 6	+12V
7 - 8	+5V

4.2 Headers and Connectors

Fan Headers

There is one 6-pin fan header (FANC) and eight 4-pin fan headers (FAN1/2/3/4/A/B/E/F) on the motherboard. All these fan headers are backwards compatible with the traditional 4-pin fans. However, fan speed control is available by Thermal Management via the BMC interface. Refer to the table below for pin definitions.

6-pin Fan Header Pin Definitions	
Pin#	Definition
1	Ground
2	3A/+12V
3	Tachometer
4	PWM_Control
5	3A/+12V
6	Ground

4-pin Fan Header Pin Definitions	
Pin#	Definition
1	Ground
2	2.5A/+12V
3	Tachometer
4	PWM_Control

VGA Port

A VGA header is located at JVGA1 on the motherboard. Refer to the motherboard layout below for the location.

BMC External I²C Header

A System Management Bus header for BMC (Baseboard Management Controller) is located at JIPMB1. Connect the appropriate cable here to use the IPMB I²C connection on your system. Refer to the table below for pin definitions.

External I ² C Header Pin Definitions	
Pin#	Definition
1	Data
2	Ground
3	Clock
4	P3V3_STBY

NCSI Connector

A NCSI header is located at JNSCI1 on the motherboard. The NCSI header is used to connect a Network Interface Card (NIC) to the motherboard which will allow the onboard BMC (Baseboard Management Controller) to communicate with a network.

NVMe Connectors

Two NVMe connectors (JNVME1, JNVME2) provide onboard NVMe connections. Use these NVMe connectors to attach high-speed PCIe storage devices.

Note: When installing an NVMe device on a motherboard, please be sure to connect the first NVMe port first (JNVME1) for your system to work properly.

Universal Serial Bus (USB) Ports

The motherboard has a USB 2.0 header J32 (USB2/3). This header supports two USB connections. J32 can be used to provide front-side USB access with a cable (not included).

Front Panel USB 3/4 (2.0) Pin Definitions			
Pin#	Definition	Pin#	Definition
1	+5V	2	+5V
3	USB_N	4	USB_N
5	USB_P	6	USB_P
7	Ground	8	Ground
9	Key	10	NC

TPM/Port 80 Header

A Trusted Platform Module (TPM)/Port 80 header is located at JTPM1 to provide TPM support and Port 80 connection. Use this header to enhance system performance and data security. Refer to the table below for pin definitions. Please go to the following link for more information on the TPM: <http://www.supermicro.com/manuals/other/TPM.pdf>.

Trusted Platform Module Header Pin Definitions			
Pin#	Definition	Pin#	Definition
1	+3.3V	2	SPI_CS#
3	RESET#	4	SPI_MISO
5	SPI_CLK	6	GND
7	SPI_MOSI	8	Key
9	+3.3V Stdbby	10	SPI_IRQ#

Standby Power Header

The Standby Power header is located at JSTBY1 on the motherboard. You must have a card with a Standby Power connector and a cable to use this feature. Refer to the table below for pin definitions.

Standby Power Pin Definitions	
Pin#	Definition
1	+5V Standby
2	Ground
3	NC

Chassis Intrusion Header

A Chassis Intrusion header is located at JL1 on the motherboard. Attach the appropriate cable from the chassis to inform you of a chassis intrusion when the chassis is opened. Refer to the table below for pin definitions.

Chassis Intrusion Pin Definitions	
Pin#	Definition
1	Intrusion Input
2	Ground

SATA Ports

This motherboard has two I-SATA 3.0 headers (JS1/JS2) onboard. These headers support eight SATA connections (I-SATA 0-3, I-SATA 4-7).

Note: For more information on the SATA HostRAID configuration, please refer to the Intel SATA HostRAID user's guide posted on our website at <http://www.supermicro.com>.

M.2 Slot

The X12DPG-AR motherboard has PCIe M.2 support located at JM2. M.2 was formerly known as Next Generation Form Factor (NGFF) and serves to replace mini PCIe. M.2 allows for a variety of card sizes, increased functionality, and spatial efficiency. The M.2 socket from the AOC supports PCIe 3.0 x4x4 SSD cards in the 2280 and 22110 form factors.

Control Panel

JF1 contains header pins for various buttons and indicators that are normally located on a control panel at the front of the chassis. These connectors are designed specifically for use with Supermicro chassis. See the figure below for the descriptions of the front control panel buttons and LED indicators.

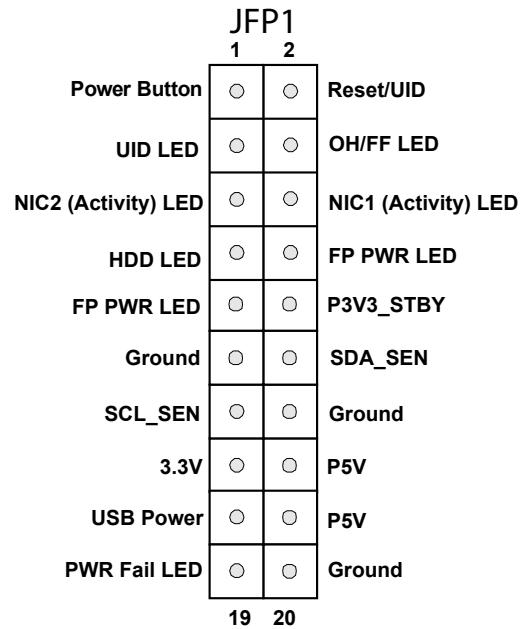


Figure 4-1. JF1 Control Panel Pins

Front Control Panel LEDs

Front Control Panel (JFP1) LED Indicators						
Event	Power (LED1)	HDD (LED2)	LAN (LED3/4)	UID (LED5)	Information (LED5)	Power Fail (LED6)
Power On	Solid On					
HDD Activity		Blinking				
NIC Activity			Blinking			
Overheat					Solid On	
Fan Fail					Blinking @1Hz	
Power Fail					Blinking @1/4Hz	Solid On
Local UID On				Solid On		
Remote UID On				Blinking 1Hz		
Checking	BMC/BIOS Blinking @4Hz					
Recovering/Updating	BMC Blinking @4Hz BMC 2 Blinks @4Hz, 1 Pause @2Hz (on-on-off-off)			BIOS/BMC Blinking @10Hz		
Flash Not Detected or Golden Image Check Failed	BMC/BIOS Blinking @1Hz					
CPLD Recovery Mode				Blinking @10Hz (MB UID LED)	Blinking @10Hz (FP Red LED)	

Power On and BMC/BIOS Status LED Button

The Power On and BMC/BIOS Status LED button is located on pins 1 of JFP1.

Power Button LED States	
Status	Event
Green: solid on	System power on
BMC/BIOS blinking green @ 4Hz	BMC/BIOS checking
BIOS blinking green @ 4Hz	BIOS recovery/update in progress
BMC blinking green x2 (2 blinks green) @ 4Hz, 1 pause @ 2Hz (on-on-off-off)	BMC recovery/update in progress
BMC/BIOS blinking green @ 1Hz	Flash not detected or golden image checking failure

Power Fail LED

The Power Fail LED connection is located on pins 19 of JFP1. When this LED turns solid red, it indicates a power failure. Refer to the table below for pin definitions.

UID LED

The unit identifier LED connection is located on pins 3 of JFP1.

Information LED (OH/Fan Fail/PWR Fail)

The Information LED (OH/Fan Fail/PWR Fail/UID LED) connection is located on pins 4 of JFP1. The LED on pin 4 provides warnings of overheat, power failure, or fan failure. Refer to the tables below for more information.

Information LED (OH/Fan Fail) LED States	
Status	Description
Solid red (on)	An overheat condition has occurred.
Blinking red (1Hz)	Fan failure: check for an inoperative fan.
Blinking red (0.25Hz)	Power failure: check for a non-operational power supply
Blinking red (10Hz) (FP red LED)	CPLD recovery mode error(s)
Solid blue	Local UID is activated. Use this function to locate a unit in a rack mount environment that might be in need of service.
Blinking blue (1Hz)	Remote UID is on. Use this function to identify a unit from a remote location that might be in need of service.
BIOS/BMC blinking blue (10Hz)	BIOS/BMC: recovery and/or update in progress
Red Info LED blinking (10Hz) and MB UID LED blue blinking (10Hz)	CPLD: recovery and/or update in progress

NIC1/NIC2 (LAN1/LAN2)

The NIC (Network Interface Controller) LED connection for LAN port 1 is located on pins 6 of JFP1, and LAN port 2 is on pins 5.

UID Switch

The UID Switch connection is located on pins 2 of JFP1. The UID switch in conjunction with JRU1 is used for a chassis that supports a front UID switch. The front UID switch functions in the same way as the rear UID switch; both are for input only and cannot be used for output. When this LED is blinking, it indicates HDD is active.

FP Power LED

The Front Panel Power LED connection is located on pins 9 of JFP1.

4.3 Input/Output Ports

See the figure below for the locations and descriptions of the I/O ports on the rear of the motherboard.

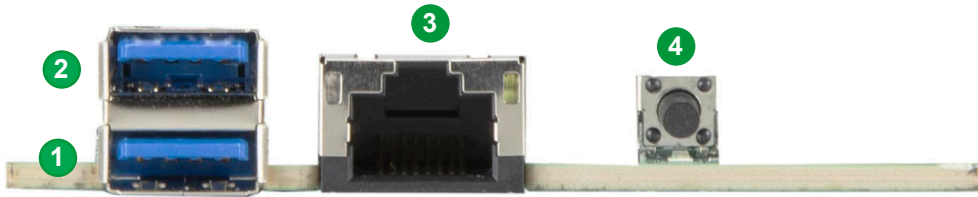


Figure 4-2. I/O Port Locations and Definitions

Rear I/O Ports			
#	Description	#	Description
1	USB0 (USB 3.0)	3	Dedicated BMC_LAN
2	USB1 (USB 3.0)	4	Unit Identifier Switch

Ethernet Ports

A dedicated BMC LAN port (BMC_LAN) is located on the rear I/O panel. The dedicated BMC LAN provides LAN support for the BMC (Baseboard Management Controller). All of these LAN ports accept RJ45 cables. Please refer to the LED Indicator section for LAN LED information.

Universal Serial Bus (USB) Ports

There are two USB 3.0 ports (USB0/1) located on the I/O back panel. The motherboard also has a front-accessible USB 3.0 headers located at J32 (USB2/3). J32 supports two USB connections.

Unit Identifier Switch (UID-SW)/BMC Reset: One button with two functions

A Unit Identifier (UID) switch and two LED Indicators are located on the motherboard. The UID switch, UID-SW, is located next to the VGA port on the back panel.

Function	User Input	Behavior	LED Activity
UID LED Indicator	Push Once	Turns on the UID LED	UID LED turns solid blue
	Push Again	Turns off the UID LED	UID LED turns off
BMC Reset	Push and hold for 6 seconds	BMC will do a cold boot	BMC Hearbeat LED turns solid green
	Push and hold for 12 seconds	BMC will reset to factory default	BMC Hearbeat LED turns solid green

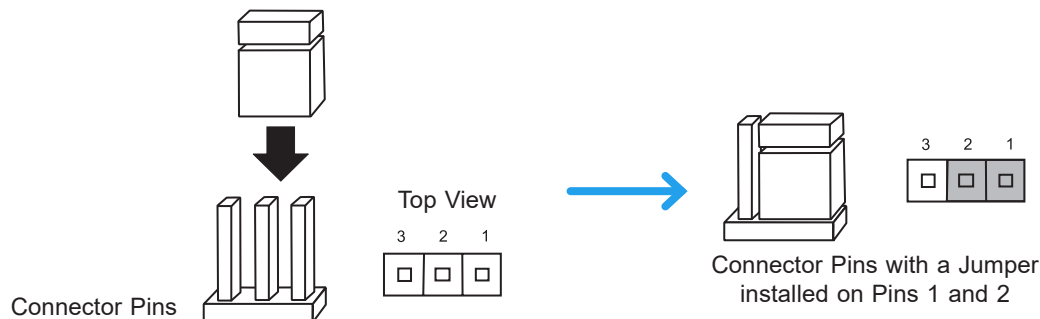
Note: After pushing and holding the UID-SW for 12 seconds, all IPMI settings including username and password will revert back to the factory default. Only the network settings and FRU are retained.

4.4 Jumpers

How Jumpers Work

To modify the operation of the motherboard, jumpers can be used to choose between optional settings. Jumpers create shorts between two pins to change the function of the connector. Pin 1 is identified with a square solder pad on the printed circuit board. Refer to the diagram below for an example of jumping pins 1 and 2. Refer to the motherboard layout page for jumper locations.

Note: On two-pin jumpers, "Closed" means the jumper is on, and "Open" means the jumper is off the pins.



CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

1. First power down the system and unplug the power cord(s).
2. Remove the cover of the chassis to access the motherboard and remove the battery from the motherboard.
3. Short the CMOS pads with a metal object such as a small screwdriver for at least four seconds.
4. Remove the screwdriver (or shorting device).
5. Re-install the motherboard battery.
6. Replace the cover, reconnect the power cord(s), and power on the system.



Note 1: Clearing CMOS will also clear all passwords.

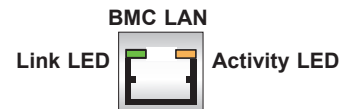
Note 2: Do not use the PW_ON connector to clear CMOS.

4.5 LED Indicators

BMC_LAN LEDs

An BMC_LAN is located on the rear I/O panel. The LED on the right indicates activity, and the LED on the left indicates the speed of the connection. Refer to the table below for more information.

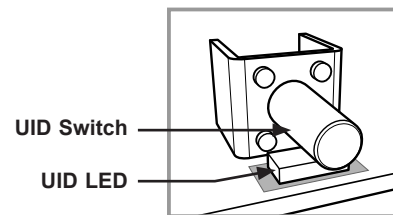
BMC_LAN LEDs		
	Color/State	Definition
Link (left)	Green: Solid	100 Mbps
	Amber: Solid	1Gbps
Activity (Right)	Amber: Blinking	Active



Unit Identifier LED

A unit identifier LED is located at LE6 on the motherboard. This UID indicator provides easy identification of a system unit that may need service.

UID LED LED State	
LED Color	Definition
Blue: On	Unit Identified



Onboard Power LED

The Onboard Power LED is located at LE3 on the motherboard. When this LED is on, the system power is on. Be sure to turn off the system power and unplug the power cord before removing or installing components. Refer to the table below for more information.

Onboard Power LED Indicator	
LED Color	Definition
Off	System Power Off (power cable not connected)
Green	System Power On

BMC Heartbeat LED

A BMC Heartbeat LED is located at LEDM1 on the motherboard. When LEDM1 is blinking, the BMC is functioning normally. Refer to the table below for more information.

BMC Heartbeat LED Indicator	
LED Color	Definition
Green: Blinking	BMC Normal

Chapter 5

Software

After the hardware has been installed, you can install the Operating System (OS), configure RAID settings and install the drivers.

5.1 Microsoft Windows OS Installation

If you will be using RAID, you must configure RAID settings before installing the Windows OS and the RAID driver. Refer to the RAID Configuration User Guides posted on our website at www.supermicro.com/support/manuals.

Installing the OS

1. Create a method to access the MS Windows installation ISO file. That can be a USB flash or media drive.
2. Retrieve the proper RST/RSTe driver. Go to the Supermicro web page for your motherboard and click on "Download the Latest Drivers and Utilities", select the proper driver, and copy it to a USB flash drive.
3. Boot from a bootable device with Windows OS installation. You can see a bootable device list by pressing **F11** during the system startup.

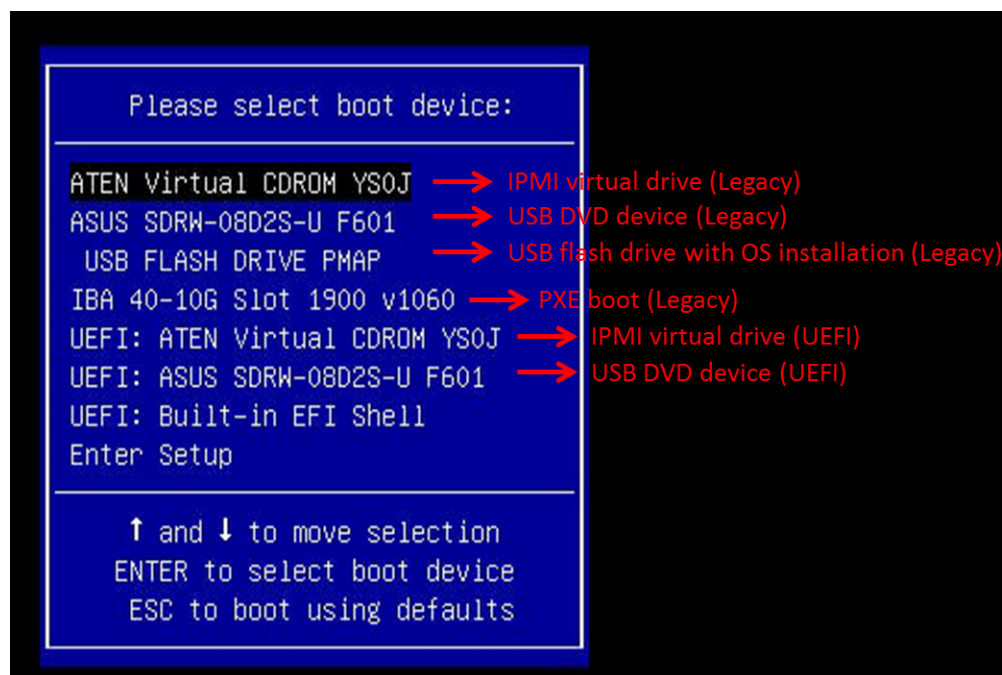


Figure 5-1. Select Boot Device

4. During Windows Setup, continue to the dialog where you select the drives on which to install Windows. If the disk you want to use is not listed, click on “Load driver” link at the bottom left corner.

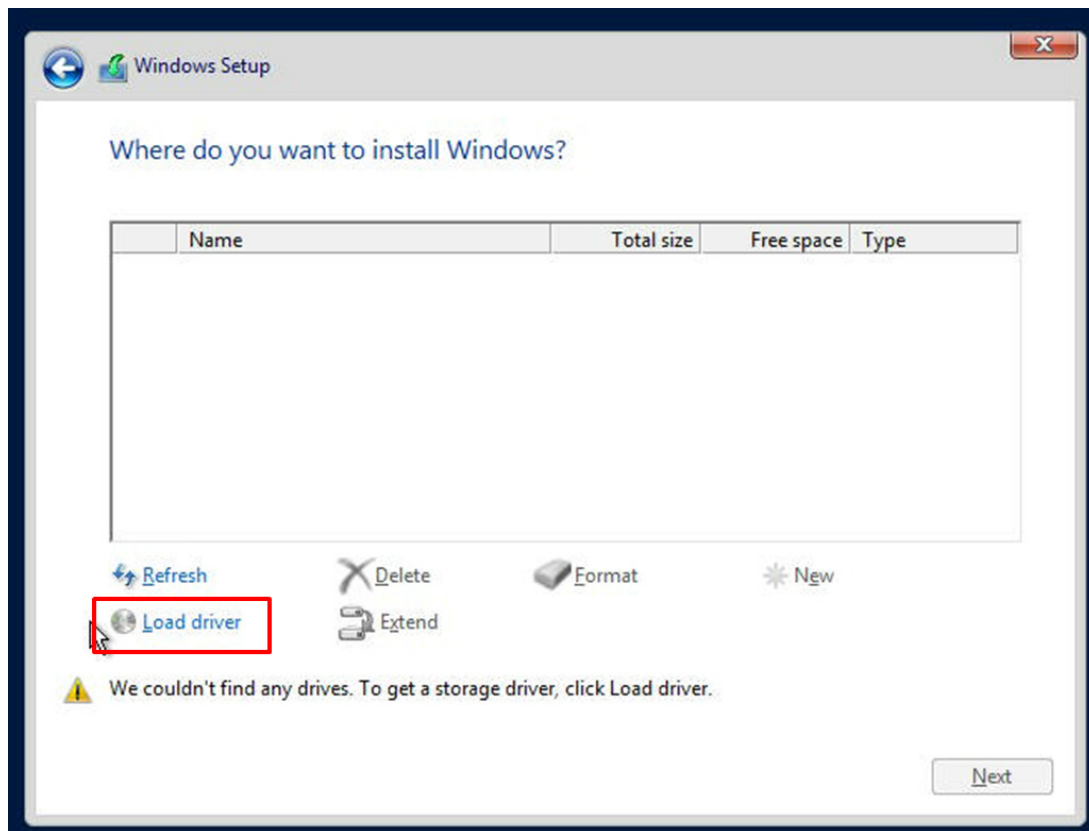


Figure 5-2. Load Driver Link

To load the driver, browse the USB flash drive for the proper driver files.

- For RAID, choose the SATA/sSATA RAID driver indicated then choose the storage drive on which you want to install it.
 - For non-RAID, choose the SATA/sSATA AHCI driver indicated then choose the storage drive on which you want to install it.
5. Once all devices are specified, continue with the installation.
 6. After the Windows OS installation has completed, the system will automatically reboot multiple times.

5.2 Driver Installation

The Supermicro website contains drivers and utilities for your system at <https://www.supermicro.com/wdl/driver>. Some of these must be installed, such as the chipset driver.

After accessing the website, go into the CDR_Images (in the parent directory of the above link) and locate the ISO file for your motherboard. Download this file to a USB flash or media drive. (You may also use a utility to extract the ISO file if preferred.)

Another option is to go to the Supermicro website at <http://www.supermicro.com/products/>. Find the product page for your motherboard, and "Download the Latest Drivers and Utilities".

Insert the flash drive or disk and the screenshot shown below should appear.

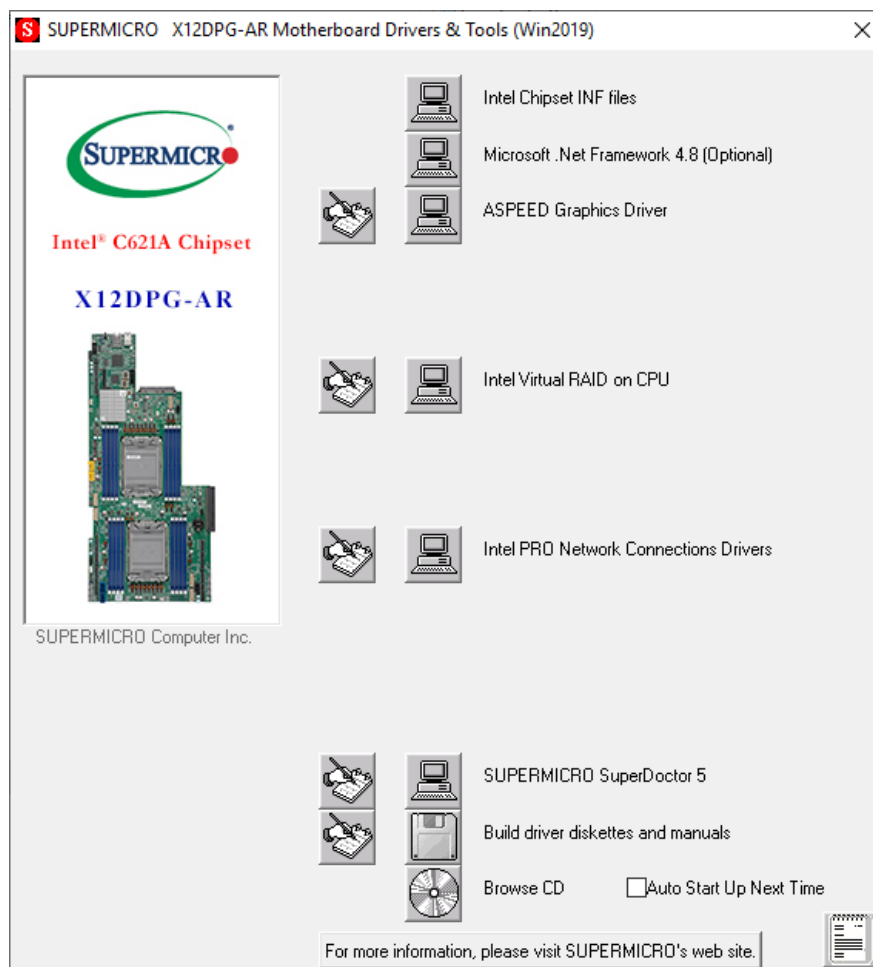


Figure 5-3. Driver & Tool Installation Screen

Note: Click the icons showing a hand writing on paper to view the readme files for each item. Click the computer icons to the right of these items to install each item (from top to the bottom) one at a time. **After installing each item, you must re-boot the system before moving on to the next item on the list.** The bottom icon with a CD on it allows you to view the entire contents.

5.3 SuperDoctor® 5

The Supermicro SuperDoctor 5 is a program that functions in a command-line or web-based interface for Windows and Linux operating systems. The program monitors such system health information as CPU temperature, system voltages, system power consumption, fan speed, and provides alerts via email or Simple Network Management Protocol (SNMP).

SuperDoctor 5 comes in local and remote management versions and can be used with Nagios to maximize your system monitoring needs. With SuperDoctor 5 Management Server (SSM Server), you can remotely control power on/off and reset chassis intrusion for multiple systems with SuperDoctor 5 or IPMI. SuperDoctor 5 Management Server monitors HTTP, FTP, and SMTP services to optimize the efficiency of your operation.

SuperDoctor® Manual and Resources

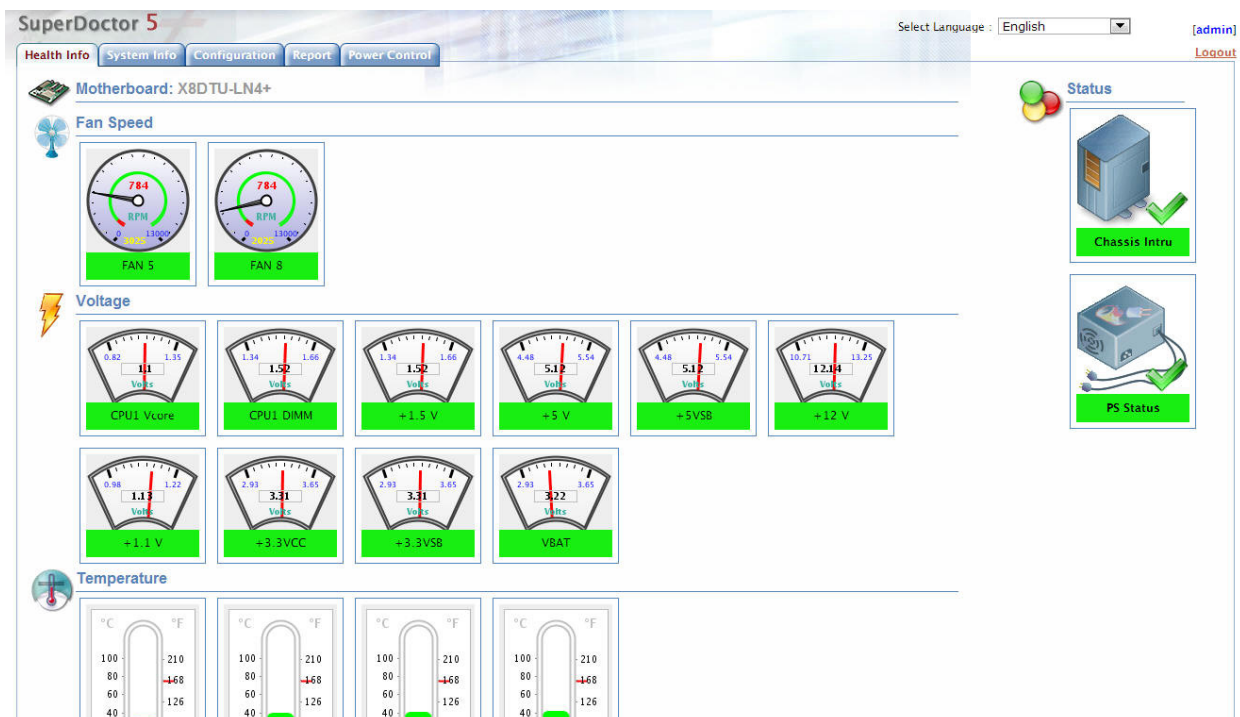


Figure 5-4. SuperDoctor 5 Interface Display Screen (Health Information)

5.4 BMC

The motherboard provides remote access, monitoring and management through the baseboard management controller (BMC) and other management controllers distributed among different system modules. There are several BIOS settings that are related to BMC. For general documentation and information on BMC, visit our website at:

www.supermicro.com/en/solutions/management-software/bmc-resources

BMC ADMIN User Password

For security, each system is assigned a unique default BMC password for the ADMIN user. This can be found on a sticker on the chassis and a sticker on the motherboard. The sticker also displays the BMC MAC address.



Figure 5-5. BMC Password Label

See the motherboard layout in Chapter 1 for the location of the label.

Chapter 6

Optional Components

This chapter describes optional system components.

Optional Parts List	
Description	Part Number
SlimlineLP x8 (STR) to SlimlineLP x8 (STR), 40cm, 85ohm	CBL-SAST-1240LP-85
SlimlineLP x8 (STR) to Slimline x8 (STR), 60cm, 85ohm	CBL-SAST-1262LP-85
SlimlineLP x8 (STR) to SlimlineLP x8 (STR), 40cm, 85ohm	CBL-SAST-1240LP-85

6.1 Storage Drive Options

The storage drive bays can support SATA, SAS, and NVMe in the following configurations.

- 4 NVMe and 6 SATA/SAS (default)
- 2 NVMe and 8 SATA/SAS
- 6 NVMe and 4 SATA/SAS

To enable SAS, SATA, and NVMe, additional hardware is required. Once the supporting hardware is installed for a selection of bays, drives of any storage protocol type can be inserted.

SATA – The system can support up to eight SATA drives from the onboard Intel PCH SATA controller.

SAS – The system can support up to eight SAS drives with an optional add-on storage controller card.

NVMe – The system can support up to four NVMe drives via the two NVMe connectors on the motherboard.

Chapter 7

Troubleshooting and Support

7.1 Information Resources

Website

A great deal of information is available on the Supermicro website, supermicro.com.

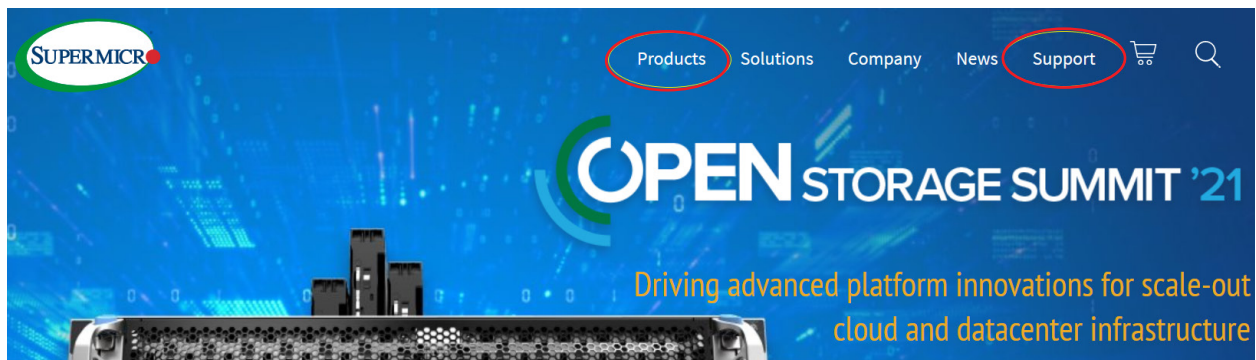


Figure 7-1. Supermicro Website

- Specifications for servers and other hardware are available by clicking the menu icon, then selecting the **Products** option.
- The **Support** option offers downloads (manuals, BIOS/BMC, drivers, etc.), FAQs, RMA, warranty, and other service extensions.

Direct Links for the SYS-220GP-TNR System

[SYS-220GP-TNR](#) specifications page

X12DPG-AR [motherboard page](#) for links to the Quick Reference Guide, [User Manual](#), validated storage drives, etc.

[BPN-SAS3-218GH2A-N6 Backplane Manual](#)

Direct Links for General Support and Information

[Frequently Asked Questions](#)

[Add-on card descriptions](#)

[TPM User Guide](#)

General Memory Configuration Guide: [X12](#)

Direct Links (continued)

[BMC User Guide](#)

[SuperDoctor5 Large Deployment Guide](#)

For validated memory, use our [Product Resources page](#)

[Product Matrices](#) page for links to tables summarizing specs for systems, motherboards, power supplies, riser cards, add-on cards, etc.

[Security Center](#) for recent security notices

[Supermicro Phone and Addresses](#)

7.2 Baseboard Management Controller (BMC)

The system supports the Baseboard Management Controller (BMC). BMC is used to provide remote access, monitoring and management. There are several BIOS settings that are related to BMC.

For general documentation and information on BMC, please visit our website at: https://www.supermicro.com/manuals/other/BMC_Users_Guide_X12_H12.pdf.

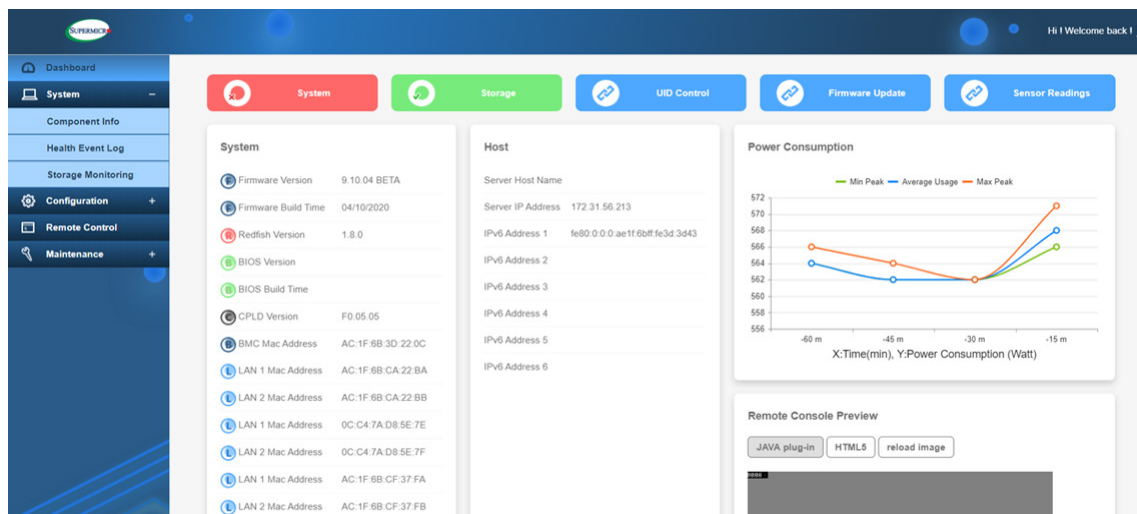


Figure 7-2. BMC Dashboard

7.3 Troubleshooting Procedures

Use the following procedures to troubleshoot your system. If you have followed all of the procedures below and still need assistance, refer to the [Technical Support Procedures](#) or [Returning Merchandise for Service](#) sections in this chapter. [Power down](#) the system before changing any non hot-swap hardware components.

General Technique

If you experience unstable operation or get no boot response, try:

1. With power off, remove all but one DIMM and other added components, such as add-on cards, from the motherboard. Make sure the motherboard is not shorted to the chassis.
2. Set all jumpers to their default positions.
3. Power up. If the system boots, check for memory errors and add-on card problems.

No Power

- Check that the power LED on the motherboard is on.

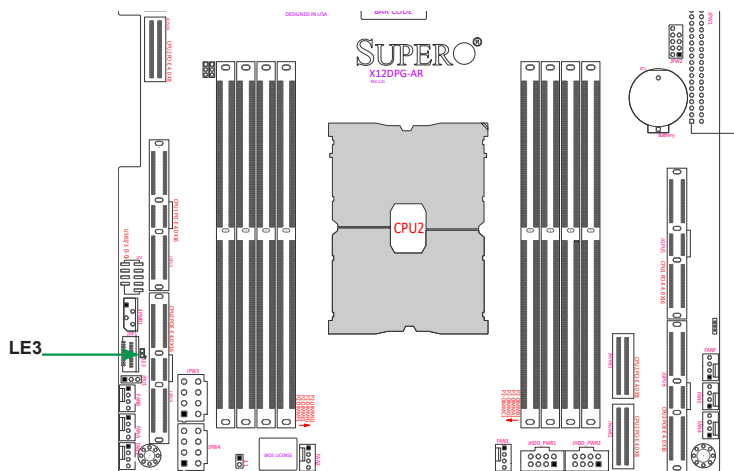


Figure 7-3. Location of the MB Power LED

- Make sure that the power connector is connected to the power supply.
- Check that the motherboard battery still supplies approximately 3VDC. If it does not, replace it.
- Check that the system input voltage is 100-120v or 180-240v.
- Turn the power switch on and off to test the system

No Video

If the power is on but you have no video, remove all add-on cards and cables.

System Boot Failure

If the system does not display Power-On-Self-Test (POST) or does not respond after the power is turned on, try the following:

- Turn on the system with only one DIMM module installed. If the system boots, check for bad DIMM modules or slots by following the Memory Errors Troubleshooting procedure below.

Memory Errors

- Make sure that the DIMM modules are properly and fully installed.
- Confirm that you are using the correct memory. Also, it is recommended that you use the same memory type and speed for all DIMMs in the system. See Section 3.3 for memory details.
- Check for bad DIMM modules or slots by swapping modules between slots and noting the results.

Losing the System Setup Configuration

- Use a high quality power supply. A poor quality power supply may cause the system to lose the CMOS setup information.
- Check that the motherboard battery still supplies approximately 3VDC. If it does not, replace it.

If the above steps do not fix the setup configuration problem, contact your vendor for repairs.

When the System Becomes Unstable

If the system becomes unstable during or after OS installation, check the following:

- CPU/BIOS support: Make sure that your CPU is supported and that you have the latest BIOS installed in your system.
- Memory: Make sure that the memory modules are supported. Refer to the product page on our website at www.supermicro.com. Test the modules using **memtest86** or a similar utility.
- Storage drives: Make sure that all drives work properly. Replace if necessary.

- System cooling: Check that all heatsink fans and system fans work properly. Check the hardware monitoring settings in the BMC to make sure that the CPU and system temperatures are within the normal range. Also check the Control panel Overheat LED.
- Adequate power supply: Make sure that the power supply provides adequate power to the system. Make sure that all power connectors are connected. Refer to the Supermicro website for the minimum power requirements.
- Proper software support: Make sure that the correct drivers are used.

If the system becomes unstable before or during OS installation, check the following:

- Source of installation: Make sure that the devices used for installation are working properly, including boot devices.
- Cable connection: Check to make sure that all cables are connected and working properly.
- Use the minimum configuration for troubleshooting: Remove all unnecessary components (starting with add-on cards first), and use the minimum configuration (but with a CPU and a memory module installed) to identify the trouble areas.
- Identify a bad component by isolating it. Check and change one component at a time.
 - Remove a component in question from the chassis, and test it in isolation. Replace it if necessary.
 - Or swap in a new component for the suspect one.
 - Or install the possibly defective component into a known good system. If the new system works, the component is likely not the cause or the problem.

7.4 Crash Dump Using BMC

In the event of a processor internal error (IERR) that crashes your system, you may want to provide information to support staff. You can download a crash dump of status information using BMC. The BMC manual is available at <https://www.supermicro.com/en/solutions/management-software/bmc-resources>.

Check BMC Error Log

1. Access the BMC web interface.

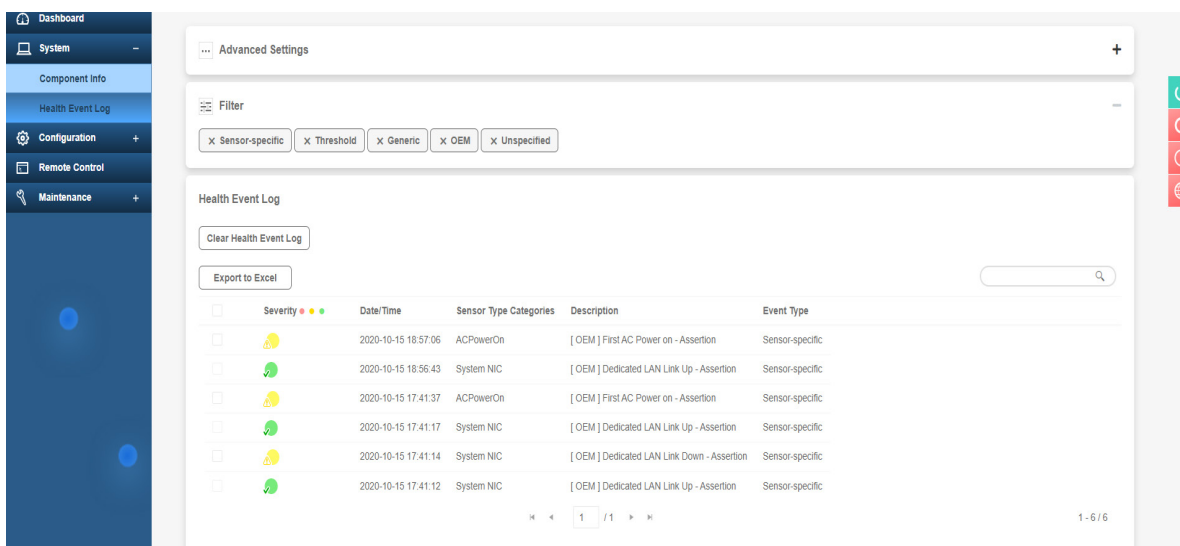


Figure 7-4. BMC Event Log

2. Click the **Server Health** tab, then **Event Log** to verify an IERR error.

In the event of an IERR, the BMC executes a crash dump. You must download the crash dump and save it.

7.5 UEFI BIOS Recovery

Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall Supermicro be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you do update the BIOS, do not shut down or reset the system while the BIOS is updating to avoid possible boot failure.

Overview

The Unified Extensible Firmware Interface (UEFI) provides a software-based interface between the operating system and the platform firmware in the pre-boot environment. The UEFI specification supports an architecture-independent mechanism that will allow the UEFI OS loader stored in an add-on card to boot the system. The UEFI offers clean, hands-off management to a computer during system boot.

Recovering the UEFI BIOS Image

A UEFI BIOS flash chip consists of a recovery BIOS block and a main BIOS block (a main BIOS image). The recovery block contains critical BIOS codes, including memory detection and recovery codes for the user to flash a healthy BIOS image if the original main BIOS image is corrupted. When the system power is turned on, the recovery block codes execute first. Once this process is complete, the main BIOS code will continue with system initialization and the remaining POST (Power-On Self-Test) routines.

Note 1: Follow the BIOS recovery instructions below for BIOS recovery when the main BIOS block crashes.

Note 2: When the BIOS recovery block crashes, you will need to follow the procedures to make a Returned Merchandise Authorization (RMA) request. Also, you may use the Supermicro Update Manager (SUM) Out-of-Band (https://www.supermicro.com.tw/products/nfo/SMS_SUM.cfm) to reflash the BIOS.

Recovering the Main BIOS Block with a USB Device

This feature allows the user to recover the main BIOS image using a USB-attached device without additional utilities used. A USB flash or media drive can be used for this purpose. However, a USB Hard Disk drive cannot be used for BIOS recovery at this time.

The file system supported by the recovery block is FAT (including FAT12, FAT16, and FAT32) which is installed on a bootable or non-bootable USB-attached device. However, the BIOS might need several minutes to locate the SUPER.ROM file if the media size becomes too large due to the huge volumes of folders and files stored in the device.

To perform UEFI BIOS recovery using a USB-attached device, follow the instructions below.

1. Using a different machine, copy the "Super.ROM" binary image file into the Root "\\" directory of a USB flash or media drive.

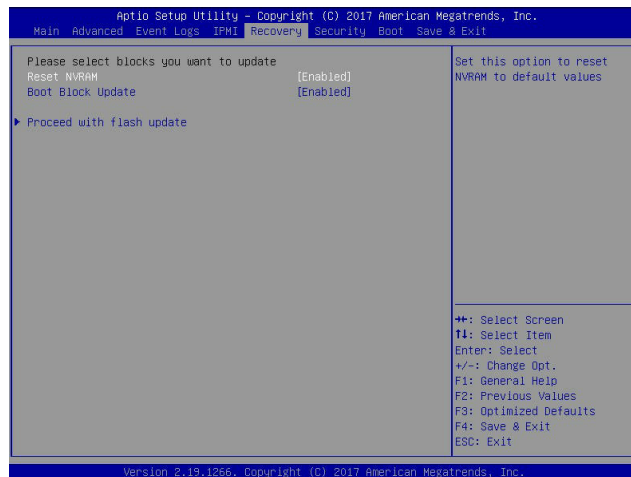
Note 1: If you cannot locate the "Super.ROM" file in your drive disk, visit our website at www.supermicro.com to download the BIOS package. Extract the BIOS binary image into a USB flash device and rename it "Super.ROM" for the BIOS recovery use.

Note 2: Before recovering the main BIOS image, confirm that the "Super.ROM" binary image file you download is the same version or a close version meant for your motherboard.

2. Insert the USB device that contains the new BIOS image ("Super.ROM") into your USB drive and reset the system when the following screen appears.
3. After locating the healthy BIOS binary image, the system will enter the BIOS Recovery menu as shown below.



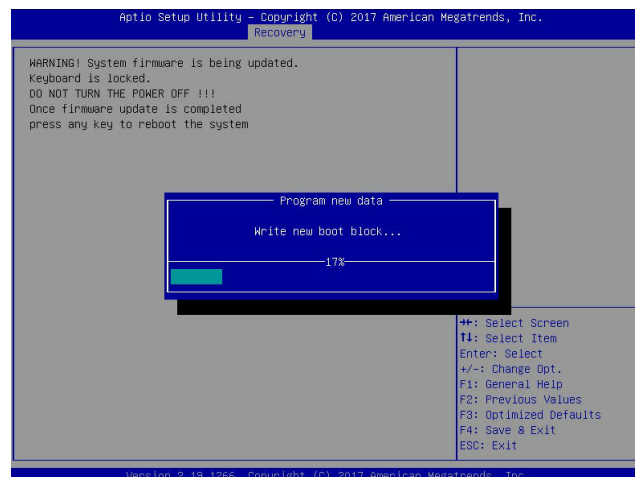
Note: At this point, you may decide if you want to start the BIOS recovery. If you decide to proceed with BIOS recovery, follow the procedures below.



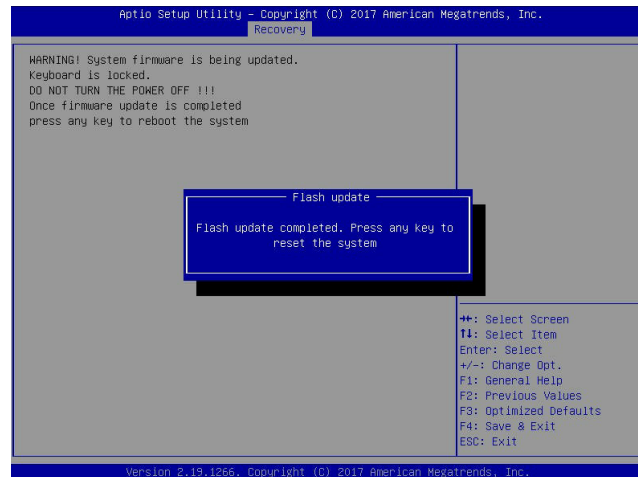
4. When the screen as shown above displays, use the arrow keys to select the item "Proceed with flash update" and press the <Enter> key. You will see the BIOS recovery progress as shown in the screen below.

Note: Do not interrupt the BIOS flashing process until it has completed.

5. After the BIOS recovery process is complete, press any key to reboot the system.
6. Using a different system, extract the BIOS package into a USB flash drive.

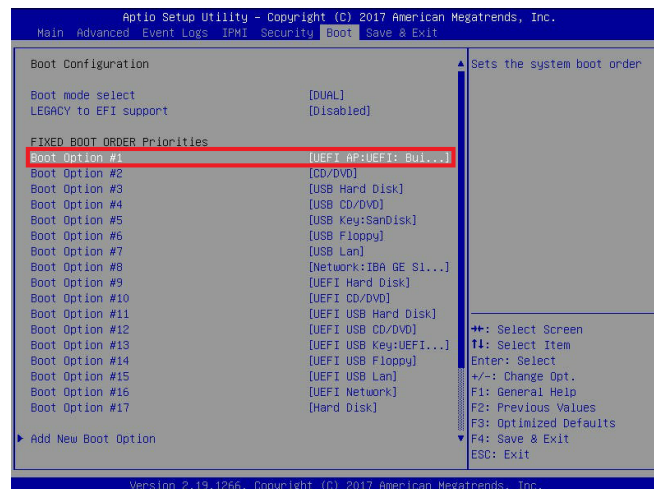


7. Press continuously during system boot to enter the BIOS Setup utility. From the top of the tool bar, select Boot to enter the submenu. From the submenu list, select Boot



Option #1 as shown below. Then, set Boot Option #1 to [UEFI AP:UEFI: Built-in EFI Shell]. Press <F4> to save the settings and exit the BIOS Setup utility.

8. When the UEFI Shell prompt appears, type fs# to change the device directory path. Go to the directory that contains the BIOS package you extracted earlier from Step 6. Enter flash.nsh BIOSname.### at the prompt to start the BIOS update process.



Note: Do not interrupt this process until the BIOS flashing is complete.

```

UEFI Interactive Shell v2.1
EDK II
UEFI v2.50 (American Megatrends, 0x0005000C)
Mapping table
  FSD: Alias(s):HD(0)B:BLK1:
    PciRoot(0x0)/Pci(0x14,0x0)/USB(0x11,0x0)/HD(1,MBR,0x37901D72,0x800,0x1
CR3592)
  BLK0: Alias(s):
    PciRoot(0x0)/Pci(0x14,0x0)/USB(0x11,0x0)
Press F10 in 1 seconds to skip startup.nsh or any other key to continue.
Shell> fs0:
FS0:\> cd AFUDOS
FS0:\AFUDOS> cd SKJPM2_03162017
FS0:\AFUDOS\SKJPM2_03162017> flash.nsh X110PU7.314

```

9. The screen above indicates that the BIOS update process is complete. When you see the screen above, unplug the AC power cable from the power supply, clear CMOS, and plug

```

Done.
[ Access Cmos Port Ex ]
<Read>
Index 0x51: 0x10

Done.
*****
*
* Program BIOS and ME (including FDT) regions...
*
*****
| AMT Firmware Update Utility v5.09.01.1317 |
| Copyright (C)2017 American Megatrends Inc. All Rights Reserved. |
*****
CPUID = 50652

Reading flash ..... done
- ME Data Size checking - ok
- FFS checksums ..... ok
- Check RomLayout ..... OK
Erasing Boot Block ..... done
Updating Boot Block ..... done
Verifying Boot Block ..... done
Erasing Main Block ..... 0x00132000 (0%)

```

the AC power cable in the power supply again to power on the system.

10. Press continuously to enter the BIOS Setup utility.

```

Verifying NDB Block ..... done
- Update success for FDR
- Update success for IEV
- Successful Update Recovery Loader to OPRx!!
- Successful Update MFSB!!
- Successful Update FPR!!
- Successful Update WFS, IVB1 and IVB2!!
- Successful Update FLOG and UTDK!!
- ME Entire Image update success !!
WARNING : System must power-off to have the changes take effect!
Moving FS0:\AFUDOS\SKJPM2_03162017\rdtx64.efi -> FS0:\AFUDOS\SKJPM2_03162017\
dt.smc
- [ok]
Moving FS0:\AFUDOS\SKJPM2_03162017\afuef1x64.efi -> FS0:\AFUDOS\SKJPM2_0316201
7\afuef1.smc
- [ok]
*****
* Please ignore this 'Shell: Cannot read from file - Device Error'
* warning message due to it does not impact flashing process.
*
*****
Deleting 'afuef1.smc'
Delete successful.
FS0:\>

```

11. Press <F3> to load the default settings.
12. After loading the default settings, press <F4> to save the settings and exit the BIOS Setup utility.

7.6 CMOS Clear

JBT1 is used to clear CMOS, which will also clear any passwords. Instead of pins, this jumper consists of contact pads to prevent accidentally clearing the contents of CMOS.

To Clear CMOS

1. First [power down](#) the system completely.
2. [Remove](#) cover from the chassis to access the motherboard.
3. [Remove](#) the battery from the motherboard.
4. Short the CMOS pads with a metal object such as a small screwdriver for at least four seconds.
5. Remove the screwdriver or shorting device.
6. Re-install the motherboard battery.
7. Replace the cover, reconnect the power cords and power on the system.

Notes: Clearing CMOS will also clear all passwords.

Do not use the PW_ON connector to clear CMOS.



JBT1 contact pads

7.7 Where to Get Replacement Components

If you need replacement parts for your system, to ensure the highest level of professional service and technical support, purchase exclusively from our Supermicro Authorized Distributors/System Integrators/Resellers. A list can be found at: <http://www.supermicro.com>. Click the "Where to Buy" tab.

7.8 Reporting an Issue

Technical Support Procedures

Before contacting Technical Support, please take the following steps. If your system was purchased through a distributor or reseller, please contact them for troubleshooting services. They have the best knowledge of your specific system configuration.

1. Please review the [Troubleshooting Procedures](#) in this manual and [Frequently Asked Questions](#) on our website before contacting Technical Support.
2. BIOS upgrades can be downloaded from our website. **Note:** Not all BIOS can be flashed depending on the modifications to the boot block code.
3. If you still cannot resolve the problem, include the following information when contacting us for technical support:
 - System, motherboard, and chassis model numbers and PCB revision number
 - BIOS release date/version (this can be seen on the initial display when your system first boots up)
 - System configuration

An example of a Technical Support form is posted on our [website](#). Distributors: For immediate assistance, please have your account number ready when contacting our technical support department by email.

Returning Merchandise for Service

A receipt or copy of your invoice marked with the date of purchase is required before any warranty service will be rendered. You can obtain service by calling your vendor for a Returned Merchandise Authorization (RMA) number. When returning to the manufacturer, the RMA number should be prominently displayed on the outside of the shipping carton, and mailed prepaid or hand-carried. Shipping and handling charges will be applied for all orders that must be mailed when service is complete.

For faster service, RMA authorizations may be requested online (<http://www.supermicro.com/support/rma/>).

Whenever possible, repack the chassis in the original Supermicro carton, using the original packaging material. If these are no longer available, be sure to pack the chassis securely, using packaging material to surround the chassis so that it does not shift within the carton and become damaged during shipping.

This warranty only covers normal consumer use and does not cover damages incurred in shipping or from failure due to the alteration, misuse, abuse or improper maintenance of products.

During the warranty period, contact your distributor first for any product problems.

Vendor Support Filing System

For issues related to Intel, use the Intel IPS filing system:

<https://www.intel.com/content/www/us/en/design/support/ips/training/welcome.html>

For issues related to Red Hat Enterprise Linux, since it is a subscription based OS, contact your account representative.

7.9 Feedback

Supermicro values your feedback as we strive to improve our customer experience in all facets of our business. Please email us at techwriterteam@supermicro.com to provide feedback on our manuals.

Appendix A

Standardized Warning Statements for AC Systems

About Standardized Warning Statements

The following statements are industry standard warnings, provided to warn the user of situations which have the potential for bodily injury. Should you have questions or experience difficulty, contact Supermicro's Technical Support department for assistance. Only certified technicians should attempt to install or configure components.

Read this appendix in its entirety before installing or configuring components in the Supermicro chassis.

These warnings may also be found on our website at http://www.supermicro.com/about/policies/safety_information.cfm.

Warning Definition



Warning! This warning symbol means danger. You are in a situation that could cause bodily injury. Before you work on any equipment, be aware of the hazards involved with electrical circuitry and be familiar with standard practices for preventing accidents.

警告の定義

この警告サインは危険を意味します。

人身事故につながる可能性がありますので、いずれの機器でも動作させる前に、電気回路に含まれる危険性に注意して、標準的な事故防止策に精通して下さい。

此警告符号代表危險。

您正处于可能受到严重伤害的工作环境中。在您使用设备开始工作之前，必须充分意识到触电的危险，并熟练掌握防止事故发生的标准工作程序。请根据每项警告结尾的声明号码找到此设备的安全性警告说明的翻译文本。

此警告符號代表危險。

您正處於可能身體可能會受損傷的工作環境中。在您使用任何設備之前，請注意觸電的危險，並且要熟悉預防事故發生的標準工作程序。請依照每一注意事項後的號碼找到相關的翻譯說明內容。

Warnung

WICHTIGE SICHERHEITSHINWEISE

Dieses Warnsymbol bedeutet Gefahr. Sie befinden sich in einer Situation, die zu Verletzungen führen kann. Machen Sie sich vor der Arbeit mit Geräten mit den Gefahren elektrischer Schaltungen und den üblichen Verfahren zur Vorbeugung vor Unfällen vertraut. Suchen Sie mit der am Ende jeder Warnung angegebenen Anweisungsnummer nach der jeweiligen Übersetzung in den übersetzten Sicherheitshinweisen, die zusammen mit diesem Gerät ausgeliefert wurden.

BEWAHREN SIE DIESE HINWEISE GUT AUF.

INSTRUCCIONES IMPORTANTES DE SEGURIDAD

Este símbolo de aviso indica peligro. Existe riesgo para su integridad física. Antes de manipular cualquier equipo, considere los riesgos de la corriente eléctrica y familiarícese con los procedimientos estándar de prevención de accidentes. Al final de cada advertencia encontrará el número que le ayudará a encontrar el texto traducido en el apartado de traducciones que acompaña a este dispositivo.

GUARDE ESTAS INSTRUCCIONES.

IMPORTANTES INFORMATIONS DE SÉCURITÉ

Ce symbole d'avertissement indique un danger. Vous vous trouvez dans une situation pouvant entraîner des blessures ou des dommages corporels. Avant de travailler sur un équipement, soyez conscient des dangers liés aux circuits électriques et familiarisez-vous avec les procédures couramment utilisées pour éviter les accidents. Pour prendre connaissance des traductions des avertissements figurant dans les consignes de sécurité traduites qui accompagnent cet appareil, référez-vous au numéro de l'instruction situé à la fin de chaque avertissement.

CONSERVEZ CES INFORMATIONS.

תקנון הזהרות אזהרה

הזהרות הבאות הן אזהרות על פי תקני התעשייה, על מנת להזהיר את המשתמש מפני חבלה פיזית אפשרית. במידה ויש שאלות או היתקלות בבעיה כלשהי, יש ליצור קשר עם מחלקת תמיכה טכנית של סופרמיקרו. טכנאים מוסמכים בלבד רשאים להתקין או להגדיר את הרכיבים. יש לקרוא את הנספח במלואו לפני התקנת או הגדרת הרכיבים במארזי סופרמיקרו.

اَكْ ف حالة وُكِي اَي تتسبب ف اصابة جسدهُ هذا الزهر ع خطر! تحذُر .
 قبل اَي تعول على اَي هعدات، كي على علن بالوخاظر ال اُجوة عي الذوائر
 الكهزبائِة
 وكي على دراهُ بالووارسات البقائِة لو ع وقع اَي حادث
 استخدم رقن الب اَي الو صص ف هاهُ كل تحذُر للعشر تزجوتها

안전을 위한 주의사항

경고!

이 경고 기호는 위험이 있음을 알려 줍니다. 작업자의 신체에 부상을 야기 할 수 있는
 상태에 있게 됩니다. 모든 장비에 대한 작업을 수행하기 전에 전기회로와 관련된
 위험요소들을 확인하시고 사전에 사고를 방지할 수 있도록 표준 작업절차를 준수해 주시기
 바랍니다.

해당 번역문을 찾기 위해 각 경고의 마지막 부분에 제공된 경고문 번호를 참조하십시오

BELANGRIJKE VEILIGHEIDSINSTRUCTIES

Dit waarschuwings symbool betekent gevaar. U verkeert in een situatie die lichamelijk letsel kan veroorzaken. Voordat u aan enige apparatuur gaat werken, dient u zich bewust te zijn van de bij een elektrische installatie betrokken risico's en dient u op de hoogte te zijn van de standaard procedures om ongelukken te voorkomen. Gebruik de nummers aan het eind van elke waarschuwing om deze te herleiden naar de desbetreffende locatie.

BEWAAR DEZE INSTRUCTIES

Installation Instructions



Warning! Read the installation instructions before connecting the system to the power source.

設置手順書

システムを電源に接続する前に、設置手順書をお読み下さい。

警告

将此系统连接电源前,请先阅读安装说明。

警告

將系統與電源連接前，請先閱讀安裝說明。

Warnung

Vor dem Anschließen des Systems an die Stromquelle die Installationsanweisungen lesen.

¡Advertencia!

Lea las instrucciones de instalación antes de conectar el sistema a la red de alimentación.

Attention

Avant de brancher le système sur la source d'alimentation, consulter les directives d'installation.

יש לקרוא את הוראות התקנה לפני חיבור המערכת למקור מתח.

اقر إرشادات التركيب قبل توصيل النظام إلى مصدر للطاقة

시스템을 전원에 연결하기 전에 설치 안내를 읽어주십시오.

Waarschuwing

Raadpleeg de installatie-instructies voordat u het systeem op de voedingsbron aansluit.

Circuit Breaker

Warning! This product relies on the building's installation for short-circuit (overcurrent) protection. Ensure that the protective device is rated not greater than: 250 V, 20 A.

サーキット・ブレーカー

この製品は、短絡(過電流)保護装置がある建物での設置を前提としています。

保護装置の定格が250 V、20 Aを超えないことを確認下さい。

警告

此产品的短路(过载电流)保护由建筑物的供电系统提供,确保短路保护设备的额定电流不大于250V,20A。

警告

此產品的短路(過載電流)保護由建築物的供電系統提供,確保短路保護設備的額定電流不大於250V,20A。

Warnung

Dieses Produkt ist darauf angewiesen, dass im Gebäude ein Kurzschluss- bzw. Überstromschutz installiert ist. Stellen Sie sicher, dass der Nennwert der Schutzvorrichtung nicht mehr als: 250 V, 20 A beträgt.

¡Advertencia!

Este equipo utiliza el sistema de protección contra cortocircuitos (o sobrecorrientes) del edificio. Asegúrese de que el dispositivo de protección no sea superior a: 250 V, 20 A.

Attention

Pour ce qui est de la protection contre les courts-circuits (surtension), ce produit dépend de l'installation électrique du local. Vérifiez que le courant nominal du dispositif de protection n'est pas supérieur à :250 V, 20 A.

מוצר זה מסתמך על הגנה המותקנת במבנים למניעת קצר חשמלי. יש לוודא כי המכשיר המגן מפני הקצר החשמלי הוא לא יותר מ-250VDC, 20A

هذا المنتج يعتمد على معدات الحماية مه الدوائر القصيرة التي تم تثبيتها في المبنى
تأكد من أن تقييم الجهاز الوقائي ليس أكثر من : 250V, 20A

경고!

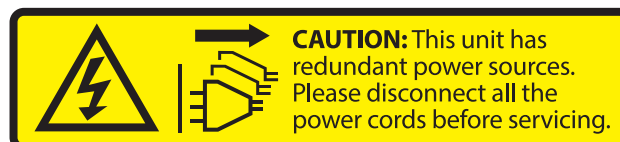
이 제품은 전원의 단락(과전류)방지에 대해서 전적으로 건물의 관련 설비에 의존합니다. 보호장치의 정격이 반드시 250V(볼트), 20A(암페어)를 초과하지 않도록 해야 합니다.

Waarschuwing

Dit product is afhankelijk van de kortsluitbeveiliging (overspanning) van uw elektrische installatie. Controleer of het beveiligde apparaat niet groter gedimensioneerd is dan 250V, 20A.

Power Disconnection Warning

Warning! The system must be disconnected from all sources of power and the power cord removed from the power supply module(s) before accessing the chassis interior to install or remove system components.



電源切断の警告

システムコンポーネントの取り付けまたは取り外しのために、シャーシー内部にアクセスするには、システムの電源はすべてのソースから切断され、電源コードは電源モジュールから取り外す必要があります。

警告

在你打开机箱并安装或移除内部器件前,必须将系统完全断电,并移除电源线。

警告

在您打開機殼安裝或移除內部元件前，必須將系統完全斷電，並移除電源線。

Warnung

Das System muss von allen Quellen der Energie und vom Netzanschlusskabel getrennt sein, das von den Spg.Versorgungsteilmodulen entfernt wird, bevor es auf den Chassisinnenraum zurückgreift, um Systemsbestandteile anzubringen oder zu entfernen.

¡Advertencia!

El sistema debe ser disconnected de todas las fuentes de energía y del cable eléctrico quitado de los módulos de fuente de alimentación antes de tener acceso el interior del chasis para instalar o para quitar componentes de sistema.

Attention

Le système doit être débranché de toutes les sources de puissance ainsi que de son cordon d'alimentation secteur avant d'accéder à l'intérieur du chassis pour installer ou enlever des composants de système.

אזהרה מפני ניתוק חשמלי

אזהרה!

יש לנתק את המערכת מכל מקורות החשמל ויש להסיר את כבל החשמלי מהספק לפני גישה לחלק הפנימי של המארז לצורך התקנת או הסרת רכיבים.

يجب فصل انظاؤ من جميع مصادر انطاقت وإزانت سهك انكهرباء من وحدة امداد
انطاقت قېم
انصل إلى امناطق انداخھيت نهھيكم نتشيج أو إزانت مكنناث الجهاز

경고!

시스템에 부품들을 장착하거나 제거하기 위해서는 새시 내부에 접근하기 전에 반드시 전원 공급장치로부터 연결되어있는 모든 전원과 전기코드를 분리해주어야 합니다.

Waarschuwing

Voordat u toegang neemt tot het binnenwerk van de behuizing voor het installeren of verwijderen van systeem onderdelen, dient u alle spanningsbronnen en alle stroomkabels aangesloten op de voeding(en) van de behuizing te verwijderen

Equipment Installation



Warning! Only trained and qualified personnel should be allowed to install, replace, or service this equipment.

機器の設置

トレーニングを受け認定された人だけがこの装置の設置、交換、またはサービスを許可されています。

警告

只有经过培训且具有资格的人员才能进行此设备的安装、更换和维修。

警告

只有經過受訓且具資格人員才可安裝、更換與維修此設備。

Warnung

Das Installieren, Ersetzen oder Bedienen dieser Ausrüstung sollte nur geschultem, qualifiziertem Personal gestattet werden.

¡Advertencia!

Solamente el personal calificado debe instalar, reemplazar o utilizar este equipo.

Attention

Il est vivement recommandé de confier l'installation, le remplacement et la maintenance de ces équipements à des personnels qualifiés et expérimentés.

אזהרה!

צוות מוסמך בלבד רשאי להתקין, להחליף את הציוד או לתת שירות עבור הציוד.

والمدربيه لتزكيب واستبدال أو خدمة هذا الجهاز يجب أن يسمح فقط للموظفيه المؤهليه

경고!

훈련을 받고 공인된 기술자만이 이 장비의 설치, 교체 또는 서비스를 수행할 수 있습니다.

Waarschuwing

Deze apparatuur mag alleen worden geïnstalleerd, vervangen of hersteld door geschoold en gekwalificeerd personeel.

Restricted Area

Warning! This unit is intended for installation in restricted access areas. A restricted access area can be accessed only through the use of a special tool, lock and key, or other means of security. (This warning does not apply to workstations).

アクセス制限区域

このユニットは、アクセス制限区域に設置されることを想定しています。

アクセス制限区域は、特別なツール、鍵と錠前、その他のセキュリティの手段を用いてのみ出入りが可能です。

警告

此部件应安装在限制进出的场所，限制进出的场所指只能通过使用特殊工具、锁和钥匙或其它安全手段进出的场所。

警告

此裝置僅限安裝於進出管制區域，進出管制區域係指僅能以特殊工具、鎖頭及鑰匙或其他安全方式才能進入的區域。

Warnung

Diese Einheit ist zur Installation in Bereichen mit beschränktem Zutritt vorgesehen. Der Zutritt zu derartigen Bereichen ist nur mit einem Spezialwerkzeug, Schloss und Schlüssel oder einer sonstigen Sicherheitsvorkehrung möglich.

¡Advertencia!

Esta unidad ha sido diseñada para instalación en áreas de acceso restringido. Sólo puede obtenerse acceso a una de estas áreas mediante la utilización de una herramienta especial, cerradura con llave u otro medio de seguridad.

Attention

Cet appareil doit être installé dans des zones d'accès réservés. L'accès à une zone d'accès réservé n'est possible qu'en utilisant un outil spécial, un mécanisme de verrouillage et une clé, ou tout autre moyen de sécurité.

אזור עם גישה מוגבלת

אזהרה!

יש להתקין את היחידה באזורים שיש בהם הגבלת גישה. הגישה ניתנת בעזרת 'כלי אבטחה בלבד' (מפתח, מנעול וכד.).

تخصيص هذه انحدزة نترك بُها ف مناطق محظورة تم .
ممكن انصلل إن منطقت محظورة فقط من خلال استخداو أداة خاصت
أو أ وس هُت أخري نلاأمما ققم ومفتاح

경고!

이 장치는 접근이 제한된 구역에 설치하도록 되어있습니다. 특수도구, 잠금 장치 및 키, 또는 기타 보안 수단을 통해서만 접근 제한 구역에 들어갈 수 있습니다.

Waarschuwing

Dit apparaat is bedoeld voor installatie in gebieden met een beperkte toegang. Toegang tot dergelijke gebieden kunnen alleen verkregen worden door gebruik te maken van speciaal gereedschap, slot en sleutel of andere veiligheidsmaatregelen.

Battery Handling



Warning! There is the danger of explosion if the battery is replaced incorrectly. Replace the battery only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions

電池の取り扱い

電池交換が正しく行われなかった場合、破裂の危険性があります。交換する電池はメーカーが推奨する型、または同等のものを使用下さい。使用済電池は製造元の指示に従って処分して下さい。

警告

電池更换不当会有爆炸危险。请只使用同类电池或制造商推荐的功能相当的电池更换原有电池。请按制造商的说明处理废旧电池。

警告

電池更換不當會有爆炸危險。請使用製造商建議之相同或功能相當的電池更換原有電池。請按照製造商的說明指示處理廢棄舊電池。

Warnung

Bei Einsetzen einer falschen Batterie besteht Explosionsgefahr. Ersetzen Sie die Batterie nur durch den gleichen oder vom Hersteller empfohlenen Batterietyp. Entsorgen Sie die benutzten Batterien nach den Anweisungen des Herstellers.

Attention

Danger d'explosion si la pile n'est pas remplacée correctement. Ne la remplacer que par une pile de type semblable ou équivalent, recommandée par le fabricant. Jeter les piles usagées conformément aux instructions du fabricant.

¡Advertencia!

Existe peligro de explosión si la batería se reemplaza de manera incorrecta. Reemplazar la batería exclusivamente con el mismo tipo o el equivalente recomendado por el fabricante. Desechar las baterías gastadas según las instrucciones del fabricante.

אזהרה!

קיימת סכנת פיצוץ של הסוללה במידה והוחלפה בדרך לא תקינה. יש להחליף את הסוללה בסוג התואם מחברת יצרן מומלצת. סילוק הסוללות המשומשות יש לבצע לפי הוראות היצרן.

هناك خطر من انفجار في حالة اسحبذال البطارية بطريقة غير صحيحة فعلى
 اسحبذال البطارية
 فقط بنفس النوع أو ما يعادلها مما أوصت به الشركة المصنعة
 جخلص من البطاريات المسحمة وفقاً لتعليمات الشركة الصانعة

경고!

배터리가 올바르게 교체되지 않으면 폭발의 위험이 있습니다. 기존 배터리와 동일하거나 제조사에서 권장하는 동등한 종류의 배터리로만 교체해야 합니다. 제조사의 안내에 따라 사용된 배터리를 처리하여 주십시오.

Waarschuwing

Er is ontplofingsgevaar indien de batterij verkeerd vervangen wordt. Vervang de batterij slechts met hetzelfde of een equivalent type die door de fabrikant aanbevolen wordt. Gebruikte batterijen dienen overeenkomstig fabrieksvoorschriften afgevoerd te worden.

Redundant Power Supplies



Warning! This unit might have more than one power supply connection. All connections must be removed to de-energize the unit.

冗長電源装置

このユニットは複数の電源装置が接続されている場合があります。

ユニットの電源を切るためには、すべての接続を取り外さなければなりません。

警告

此部件连接的电源可能不止一个，必须将所有电源断开才能停止给该部件供电。

警告

此裝置連接的電源可能不只一個，必須切斷所有電源才能停止對該裝置的供電。

Warnung

Dieses Gerät kann mehr als eine Stromzufuhr haben. Um sicherzustellen, dass der Einheit kein Strom zugeführt wird, müssen alle Verbindungen entfernt werden.

¡Advertencia!

Puede que esta unidad tenga más de una conexión para fuentes de alimentación. Para cortar por completo el suministro de energía, deben desconectarse todas las conexiones.

Attention

Cette unité peut avoir plus d'une connexion d'alimentation. Pour supprimer toute tension et tout courant électrique de l'unité, toutes les connexions d'alimentation doivent être débranchées.

אם קיים יותר מספק אחד

אזהרה!

ליחידה יש יותר מחיבור אחד של ספק. יש להסיר את כל החיבורים על מנת לרוקן את היחידה.

قد يكون لهذا الجهاز عدة اتصالات بوحدات امداد الطاقة .

يجب إزالة كافة الاتصالات لعسل الوحدة عن الكهرباء

경고!

이 장치에는 한 개 이상의 전원 공급 단자가 연결되어 있을 수 있습니다. 이 장치에 전원을 차단하기 위해서는 모든 연결 단자를 제거해야만 합니다.

Waarschuwing

Deze eenheid kan meer dan één stroomtoevoeraansluiting bevatten. Alle aansluitingen dienen verwijderd te worden om het apparaat stroomloos te maken.

Backplane Voltage



Warning! Hazardous voltage or energy is present on the backplane when the system is operating. Use caution when servicing.

バックプレーンの電圧

システムの稼働中は危険な電圧または電力が、バックプレーン上にかかっています。

修理する際にはご注意ください。

警告

当システム正在进行时，背板上有很危险的电压或能量，进行维修时务必小心。

警告

當系統正在進行時，背板上有危險的電壓或能量，進行維修時務必小心。

Warnung

Wenn das System in Betrieb ist, treten auf der Rückwandplatine gefährliche Spannungen oder Energien auf. Vorsicht bei der Wartung.

¡Advertencia!

Cuando el sistema está en funcionamiento, el voltaje del plano trasero es peligroso. Tenga cuidado cuando lo revise.

Attention

Lorsque le système est en fonctionnement, des tensions électriques circulent sur le fond de panier. Prendre des précautions lors de la maintenance.

מתח בפנל האחורי

אזהרה!

קיימת סכנת מתח בפנל האחורי בזמן תפעול המערכת. יש להיזהר במהלך העבודה.

هناك خطر من التيار الكهربائي أو الطاقة المبددة على الساحة
عندما يكون النظام يعمل كه حذرا عند خدمة هذا الجهاز

경고!

시스템이 동작 중일 때 후면판 (Backplane)에는 위험한 전압이나 에너지가 발생 합니다.
서비스 작업 시 주의하십시오.

Waarschuwing

Een gevaarlijke spanning of energie is aanwezig op de backplane wanneer het systeem in gebruik is. Voorzichtigheid is geboden tijdens het onderhoud.

Comply with Local and National Electrical Codes



Warning! Installation of the equipment must comply with local and national electrical codes.

地方および国の電気規格に準拠

機器の取り付けはその地方および国の電気規格に準拠する必要があります。

警告

设备安装必须符合本地与本国电气法规。

警告

設備安裝必須符合本地與本國電氣法規。

Warnung

Die Installation der Geräte muss den Sicherheitsstandards entsprechen.

¡Advertencia!

La instalacion del equipo debe cumplir con las normas de electricidad locales y nacionales.

Attention

L'équipement doit être installé conformément aux normes électriques nationales et locales.

תיאום חוקי החשמל הארצי

אזהרה!

התקנת הציוד חייבת להיות תואמת לחוקי החשמל המקומיים והארציים.

تركيب المعدات الكهربائية يجب أن يمتثل للقوايه المحلية والبطية المتعلقة
بالكهرباء

경고!

현 지역 및 국가의 전기 규정에 따라 장비를 설치해야 합니다.

Waarschuwing

Bij installatie van de apparatuur moet worden voldaan aan de lokale en nationale elektriciteitsvoorschriften.

Product Disposal



Warning! Ultimate disposal of this product should be handled according to all national laws and regulations.

製品の廃棄

この製品を廃棄処分する場合、国の関係する全ての法律・条例に従い処理する必要があります。

警告

本产品的废弃处理应根据所有国家的法律和规章进行。

警告

本產品的廢棄處理應根據所有國家的法律和規章進行。

Warnung

Die Entsorgung dieses Produkts sollte gemäß allen Bestimmungen und Gesetzen des Landes erfolgen.

¡Advertencia!

Al deshacerse por completo de este producto debe seguir todas las leyes y reglamentos nacionales.

Attention

La mise au rebut ou le recyclage de ce produit sont généralement soumis à des lois et/ou directives de respect de l'environnement. Renseignez-vous auprès de l'organisme compétent.

סילוק המוצר

אזהרה!

סילוק סופי של מוצר זה חייב להיות בהתאם להנחיות וחוקי המדינה.

التخلص النهائي من هذا المنتج ينبغي التعامل معه وفقا لجميع القوانين واللوائح الوطنية عند

경고!

이 제품은 해당 국가의 관련 법규 및 규정에 따라 폐기되어야 합니다.

Waarschuwing

De uiteindelijke verwijdering van dit product dient te geschieden in overeenstemming met alle nationale wetten en reglementen.

Hot Swap Fan Warning



Warning! Hazardous moving parts. Keep away from moving fan blades. The fans might still be turning when you remove the fan assembly from the chassis. Keep fingers, screwdrivers, and other objects away from the openings in the fan assembly's housing.

ファン・ホットスワップの警告

警告!回転部品に注意。運転中は回転部(羽根)に触れないでください。シャーシから冷却ファン装置を取り外した際、ファンがまだ回転している可能性があります。ファンの開口部に、指、ドライバー、およびその他のものを近づけないで下さい。

警告!

警告! 危险的可移动性零件。请务必与转动的风扇叶片保持距离。当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇

警告

危险的可移动性零件。请务必与转动的风扇叶片保持距离。当您从机架移除风扇装置，风扇可能仍在转动。小心不要将手指、螺丝起子和其他物品太靠近风扇。

Warnung

Gefährlich Bewegende Teile. Von den bewegenden Lüfterblätter fern halten. Die Lüfter drehen sich u. U. noch, wenn die Lüfterbaugruppe aus dem Chassis genommen wird. Halten Sie Finger, Schraubendreher und andere Gegenstände von den Öffnungen des Lüftergehäuses entfernt.

¡Advertencia!

Riesgo de piezas móviles. Mantener alejado de las aspas del ventilador. Los ventiladores podran dar vuelta cuando usted quite el montaje del ventilador del chasis. Mantenga los dedos, los destornilladores y todos los objetos lejos de las aberturas del ventilador

Attention

Pieces mobiles dangereuses. Se tenir a l'écart des lames du ventilateur Il est possible que les ventilateurs soient toujours en rotation lorsque vous retirerez le bloc ventilateur du châssis. Prenez garde à ce que doigts, tournevis et autres objets soient éloignés du logement du bloc ventilateur.

אזהרה!

חלקים נעים מסוכנים. התרחק מלהבי המאוורר בפעולה כאשר מסירים את חלקי המאוורר מהמארז, יתכן והמאווררים עדיין עובדים. יש להרחיק למרחק בטוח את האצבעות וכלי עבודה שונים מהפתחים בתוך המאוורר

تحذير! أجزاء متحركة خطيرة. ابتعد عن شفرات المروحة المتحركة. من الممكن أن المراوح لا تزال تدور عند إزالة كتلة المروحة من الهيكل يجب إبقاء الأصابع ومفكات البراغي وغيرها من الأشياء بعيدا عن الفتحات في كتلة المروحة

경고!

움직이는 위험한 부품. 회전하는 송풍 날개에 접근하지 마세요. 새시로부터 팬 조립품을 제거할 때 팬은 여전히 회전하고 있을 수 있습니다. 팬 조립품 외관의 열려있는 부분들로부터 손가락 및 스크류드라이버, 다른 물체들이 가까이 하지 않도록 배치해 주십시오.

Waarschuwing

Gevaarlijk bewegende onderdelen. Houd voldoende afstand tot de bewegende ventilatorbladen. Het is mogelijk dat de ventilator nog draait tijdens het verwijderen van het ventilatorsamenstel uit het chassis. Houd uw vingers, schroevendraaiers en eventuele andere voorwerpen uit de buurt van de openingen in de ventilatorbehuizing.

Power Cable and AC Adapter



Warning! When installing the product, use the provided or designated connection cables, power cables and AC adaptors. Using any other cables and adaptors could cause a malfunction or a fire. Electrical Appliance and Material Safety Law prohibits the use of UL or CSA -certified cables (that have UL/CSA shown on the cord) for any other electrical devices than products designated by Supermicro only.

電源コードとACアダプター

製品を設置する場合、提供または指定および購入された接続ケーブル、電源コードとACアダプターを、該当する地域の条例や安全基準に適合するコードサイズやプラグと共に使用下さい。他のケーブルやアダプタを使用すると故障や火災の原因になることがあります。

電気用品安全法は、ULまたはCSA認定のケーブル(UL/CSAマークがコードに表記)を Supermicro が指定する製品以外に使用することを禁止しています。

警告

安装此产品时,请使用本身提供的或指定的或采购的连接线,电源线和电源适配器。包含遵照当地法规和安全要求的合规的电源线尺寸和插头。使用其它线材或适配器可能会引起故障或火灾。除了Supermicro所指定的产品,电气用品和材料安全法律规定禁止使用未经UL或CSA认证的线材。(线材上会显示UL/CSA符号)。

警告

安裝此產品時,請使用本身提供的或指定的或採購的連接線,電源線和電源適配器。包含遵照當地法規和安全要求的合規的電源線尺寸和插頭。使用其它線材或適配器可能會引起故障或火災。除了Supermicro所指定的產品,電氣用品和材料安全法律規定禁止使用未經UL或CSA認證的線材。(線材上會顯示UL/CSA符號)。

Warnung

Nutzen Sie beim Installieren des Produkts ausschließlich die von uns zur Verfügung gestellten Verbindungskabeln, Stromkabeln und/oder Adapter, die Ihre örtlichen Sicherheitsstandards einhalten. Der Gebrauch von anderen Kabeln und Adapter können Fehlfunktionen oder Feuer verursachen. Die Richtlinien untersagen das Nutzen von UL oder CAS zertifizierten Kabeln (mit UL/CSA gekennzeichnet), an Geräten oder Produkten die nicht mit Supermicro gekennzeichnet sind.

¡Advertencia!

Cuando instale el producto, utilice la conexión provista o designada o procure cables, Cables de alimentación y adaptadores de CA que cumplan con los códigos locales y los requisitos de seguridad, incluyendo el tamaño adecuado del cable y el enchufe. El uso de otros cables y adaptadores podría causar un mal funcionamiento o un incendio. La Ley de Seguridad de Aparatos Eléctricos y de Materiales prohíbe El uso de cables certificados por UL o CSA (que tienen el certificado UL / CSA en el código) para cualquier otros dispositivos eléctricos que los productos designados únicamente por Supermicro.

Attention

Lors de l'installation du produit, utilisez les cables de connection fournis ou désigné ou achetez des cables, cables de puissance et adaptateurs respectant les normes locales et les conditions de securite y compris les tailles de cables et les prises electriques appropriées. L'utilisation d'autres cables et adaptateurs peut provoquer un dysfonctionnement ou un incendie. Appareils électroménagers et la Loi sur la Sécurité Matériel interdit l'utilisation de câbles certifiés- UL ou CSA (qui ont UL ou CSA indiqué sur le code) pour tous les autres appareils électriques sauf les produits désignés par Supermicro seulement.

AC ימאתמו מילמשח מילבכ

!הרהזא

ךרוצל ומאתוה וא ושכרנ רשא AC מימאתמו מיקפס, מילבכב שמתשהל שי, רצומה תא מיניקתמ רשאכ לכב שומיש. עקתהו לבכה לש הנוכח הדימ ללוכ, תוימוקמה תוחיטבה תושירדל ומאתוה רשאו, הנקתהה למשחה ירישכמב שומישה יקוחל מאתהב. ילמשח רצק וא הלוקתל מורגל לולע, רחא גוסמ מאתמ וא לבכ לש דוק מהילע עיפומ רשאכ) UL-ב או CSA-ב -ב מיכמסומה מילבכב שמתשהל רוסיא מייק, תוחיטבה יקוחו דבלב Supermicro י"ע מאתוה רשא רצומב קר אלא, רחא ילמשח רצומ לכ רובע (UL/CSA)

תאלבאלא אארשב מק וא ענדחמל וא ערפוטמל תאליסוולא מודחטסאב מק, גתנמל בייקרת דנע כלז יפ אמב עילחמל עמאלסל תאבלטתמו נינאווקב מאזתלאל עמ דדרתמל ראיטל תאלוחמו עיזאברמלל קיירח וא לטע יפ בבסטטי דק ירזא תאלוחמו תאלבאלא יא מודחטסא. מילסל סבאלאו לטוולא מרח. UL ו CSA לביק נמ ענדחמל תאלבאלא מודחטסא תאדעמל או עיזאברמלל עזגאלל עמאלסל נונאק רזחי Supermicro לביק נמ ענדחמל או עינעמל תאגתנמל ריג ירזא תאדעמ יא עמ (UL/CSA) עמאלע למחת יטל או

전원 케이블 및 AC 어댑터

경고! 제품을 설치할 때 현지 코드 및 적절한 굵기의 코드와 플러그를 포함한 안전 요구 사항을 준수하여 제공되거나 지정된 연결 혹은 구매 케이블, 전원 케이블 및 AC 어댑터를 사용하십시오.

다른 케이블이나 어댑터를 사용하면 오작동이나 화재가 발생할 수 있습니다. 전기 용품 안전법은 UL 또는 CSA 인증 케이블 (코드에 UL / CSA가 표시된 케이블)을 Supermicro가 지정한 제품 이외의 전기 장치에 사용하는 것을 금지합니다.

Stroomkabel en AC-Adapter

Waarschuwing! Bij het aansluiten van het Product uitsluitend gebruik maken van de geleverde Kabels of een andere geschikte aan te schaffen Aansluitmethode, deze moet altijd voldoen aan de lokale voorschriften en veiligheidsnormen, inclusief de juiste kabeldikte en stekker. Het gebruik van niet geschikte Kabels en/of Adapters kan een storing of brand veroorzaken. Wetgeving voor Elektrische apparatuur en Materiaalveiligheid verbied het gebruik van UL of CSA -gecertificeerde Kabels (met UL/CSA in de code) voor elke andere toepassing dan de door Supermicro hiervoor beoogde Producten.

Appendix B

System Specifications

Processors

Dual Intel Xeon Scalable Family 3rd Gen/4th Gen Series Processors (in Socket P+) with a thermal design power (TDP) of up to 270W, three UltraPath Interconnects (UPI), and Root of Trust (RoT)

Note: Refer to the motherboard specifications pages on our website for updates to supported processors.

Chipset

Intel PCH C621A (LBG-R)

BIOS

256Mb SPI AMI BIOS®

ACPI 6.0 or later, SMBIOS 3.0 or later, Riser Card auto detection support

Memory

Supports up to 4TB 3DS LRDIMM/LRDIMM/3DS RDIMM/RDIMM DDR4 (288-pin) ECC memory with speeds of 3200/2933/2666 MHz in 16 memory slots and up to 4TB Intel Optane PMem 200 Series with speeds of up to 3200 MHz

Storage Drives

Ten front hot-swap drive bays (six 2.5" SATA/SAS and four 2.5" U.2 NVMe/SATA/SAS)

PCI Expansion Slots

Six PCIe x16 Gen4 GPU slots

One PCIe x16 Gen4 LP slot

One AIOM networking slot

Input/Output

One VGA

One dedicated 10G BASE-T BMC LAN

One front USB 3.0

Two rear USB 3.0

Motherboard

X12DPG-AR (WxL) 10 x 12 in (254 x 304.8 mm)

Chassis

CSE-218GH2TS-R0NDBP; 2U Rackmount, (WxHxD) 17.3 x 3.5 x 30.1 in. (440.7 x 88.0 x 766.8mm)

System Cooling

Five 4 cm counter-rotating fans, two CPU heatsinks, one air shroud to direct air flow

Power Supply

Model: PWS-2K63A-1R

AC Input Voltages: 200-240 VAC

Rated Input Current: 200-240Vac: 12.5max

Rated Input Frequency: 50-60 Hz

Rated Output Power: 2600W

Rated Output Voltages: +12V(216A); +12Vsb(3.5A)

Operating Environment

Operating Temperature: 10° to 35° C (50° to 95° F)

Non-operating Temperature: -40° to 70° C (-40° to 158° F)

Operating Relative Humidity: 8% to 90% (non-condensing)

Non-operating Relative Humidity: 5% to 95% (non-condensing)

Regulatory Compliance

FCC, ICES, CE, VCCI, RCM, UKCA, NRTL, CB, BSMI

Applied Directives, Standards

EMC/EMI: 2014/30/EU (EMC Directive)

FCC Part 15 Subpart B

ICES-003

VCCI-CISPR 32

AS/NZS CISPR 32

EN/BS 55032

EN/BS 55035

EN/BS 61000-3-2

EN/BS 61000-3-3

EN/BS 61000-4-2

EN/BS 61000-4-3

EN/BS 61000-4-4

EN/BS 61000-4-5

EN/BS 61000-4-6

EN/BS 61000-4-11

Electromagnetic Compatibility Regulations 2016

Green Environment:

2011/65/EU (RoHS Directive)

EC 1907/2006 (REACH)

2012/19/EU (WEEE Directive)

Product Safety: 2014/35/EU (LVD Directive)

UL/CSA 62368-1 (USA and Canada)

Electrical Equipment (Safety) Regulations 2016

IEC/EN 62368-1

Perchlorate Warning

California Best Management Practices Regulations for Perchlorate Materials: This Perchlorate warning applies only to products containing CR (Manganese Dioxide) Lithium coin cells. "Perchlorate Material-special handling may apply. See www.dtsc.ca.gov/hazardouswaste/perchlorate"

この装置は、クラスA機器です。この装置を住宅環境で使用すると電波妨害を引き起こすことがあります。この場合には使用者が適切な対策を講ずるよう要求されることがあります。

VCCI — A

BSMI/RHoS

限用物質含有情況標示聲明書

Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱：伺服器/ Server Equipment name Type designation (Type) 型號 (型式)：218G-R26X12 (系列型號: 218G-26, 218G-X12, 218G- GPU, SYS-220GP-TNR)						
單元 Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr ⁺⁶)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
機殼 (Chassis)	○	○	○	○	○	○
機殼風扇 (Chassis Fan)	-	○	○	○	○	○
線材 (Cable)	○	○	○	○	○	○
主機板 (Motherboard)	-	○	○	○	○	○
電源供應器 (Power Supply)	-	○	○	○	○	○
硬碟 (SSD)	-	○	○	○	○	○
電源背板 (PDB)	-	○	○	○	○	○
附加卡 (Add-on card)	-	○	○	○	○	○
備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。 Note 1 : “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition. 備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。 Note 2 : “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence. Note 3 : The “-” indicates that the restricted substance corresponds to the exemption. 備考3. “-” 係指該項限用物質為排除項目。						

警告:為避免電磁干擾, 本產品不應安裝或使用於住宅環境。

輸入額定:

200-240 Vac~,60-50 Hz,15-12.5 A (X2)

*使用者不能任意拆除或替換內部配備

*報驗義務人之姓名或名稱：美超微電腦股份有限公司

*報驗義務人之地址：新北市中和區建一路 150 號 3 樓



經濟部標準檢驗局

BUREAU OF STANDARDS, METROLOGY AND INSPECTION,
MINISTRY OF ECONOMIC AFFAIRS

商品驗證登錄證書

CERTIFICATE OF THE REGISTRATION OF PRODUCT CERTIFICATION



證書號碼： CI361061992720 號 00

Certificate No.

茲據 美超微電腦股份有限公司

申請驗證登錄，經審查結果符合規

定，准予登錄並使用商品安全標章及識別號碼：

R36199

。其登錄事項如下：

The application made by

for Registration of Product

Certification has been reviewed and found to be in compliance with related regulations. Therefore, registration is granted with the

Product Safety Mark and the Identification No.

R36199

. Details of the registration are follows :

申請人：美超微電腦股份有限公司

統一編號：12729477

Applicant

Uniform No.

地址：新北市中和區建一路150號3樓

Address

生產廠場：詳如附表

Factory

廠址：詳如附表

Factory Address

商品種類名稱：

Type/name of product

商品分類號列：8471.49.00.00.7

C.C.C Code

中文名稱：伺服器

Chinese name

英文名稱：Server

English name

型式：218G-R26X12

Type

系列型式：218G- GPU, 218G-26, 218G-X12, SYS-220GP-TNR(以下空白)

Series of the type

依據標準：CNS15598-1 (109年06月)、CNS15936 (105年09月)、符合CNS 15663第5節「

Standards 含有標示」規定 102年7月

標準檢驗局發證(發證地址：100臺北市中正區濟南路1段4號)

This certificate is issued by the BSMI. (No.4, Sec. 1, Jinan Rd., Zhongzheng Dist., Taipei City 100, Taiwan)

本證書以電子文件行之，所載內容若有不符之處，以標準檢驗局系統登錄資料為主，查詢證書

資料網址：<https://civil.bsmi.gov.tw>

登錄日期：中華民國 111 年 07 月 29 日

Registration Date 2022 (year) 07 (month) 29 (day)

本證書有效期至 114 年 07 月 28 日

Expiration Date 2025 (year) 07 (month) 28 (day)

發證日期：中華民國 111 年 07 月 29 日

Date of issue 2022 (year) 07 (month) 29 (day)

註1：持本證書進口驗證登錄商品時，進口人須與本證書名義人相同。

註2：次年度商品驗證登錄年費繳納期限為當年11月30日，逾期未繳納者，經限期繳納屆期未繳納，即依商品檢

驗法第42條第7款規定廢止驗證登錄，並自次年度1月1日起生效。

註3：本證書僅代表完成檢驗程序，不作為其他(如產地)證明。



列印序號:8306212909192277092

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經濟部標準檢驗局

BUREAU OF STANDARDS, METROLOGY AND INSPECTION,
MINISTRY OF ECONOMIC AFFAIRS

商品驗證登錄證書

CERTIFICATE OF THE REGISTRATION OF PRODUCT CERTIFICATION

證書號碼：CI361061992720 號 00

Certificate No.

生產廠場： 1. SUPER MICRO COMPUTER, INC.
Factory： 782 Ridder Park Drive, San Jose, CA95131, USA

2. Compuware Technology Inc.
3F., No. 306, Changan St., Bade District, Taoyuan City
33463, Taiwan

3. SUPER MICRO COMPUTER B. V.
Het Sterrenbeeld 12-16, 5215 ML 'S-Hertogenbosch, The
Netherlands

4. SUPER MICRO COMPUTER, INC. TAIWAN
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5. SUPER MICRO COMPUTER, INC.
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